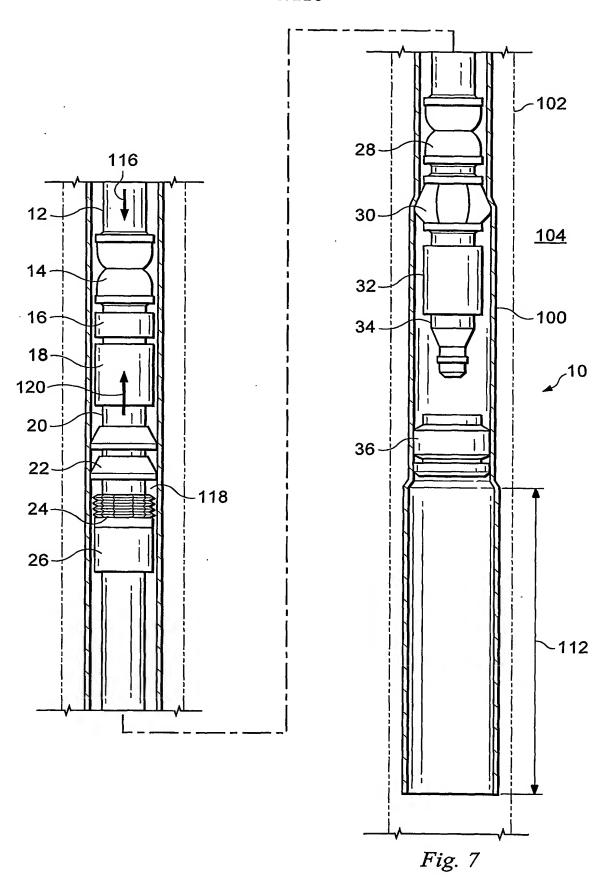
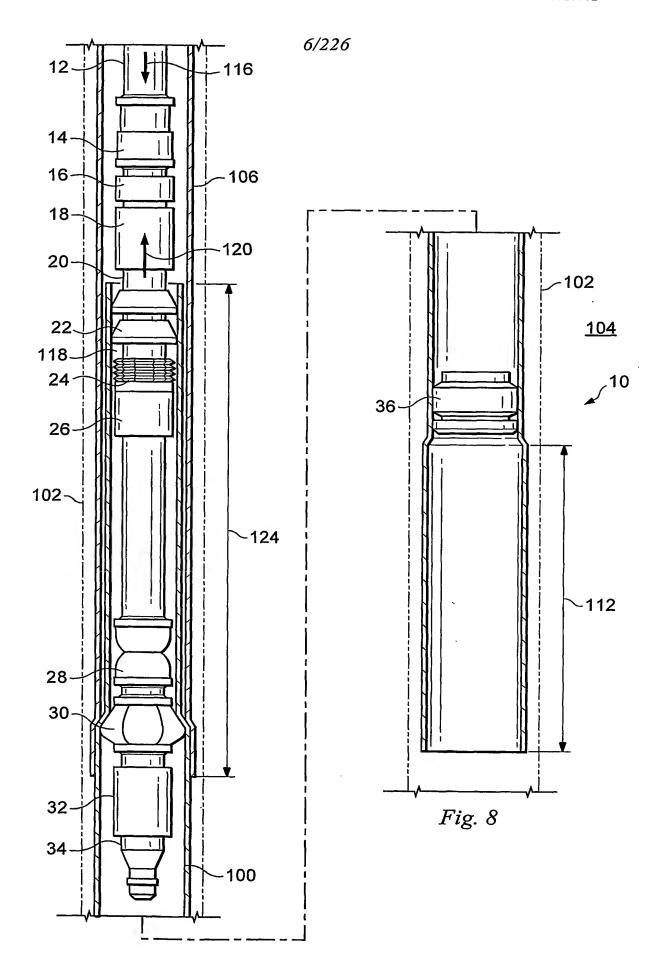
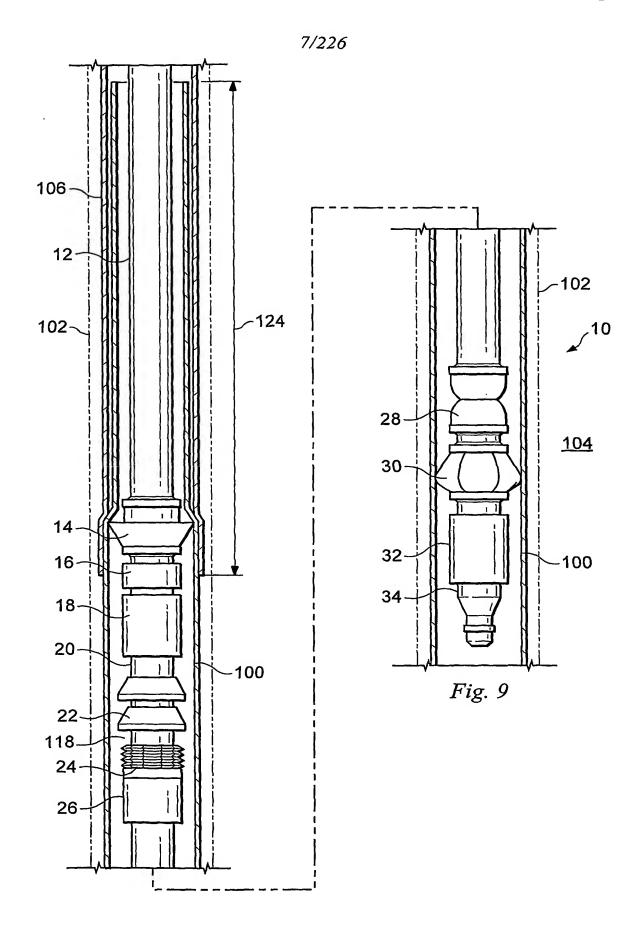
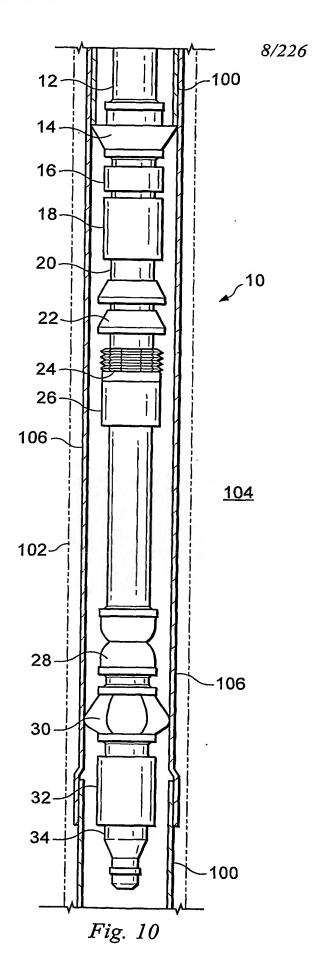


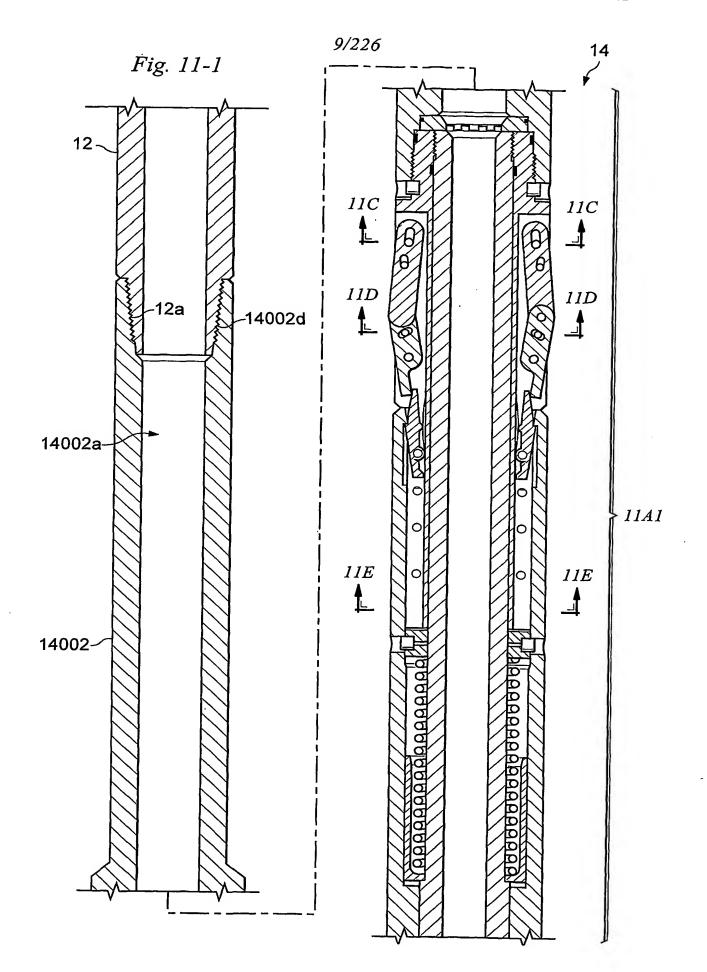
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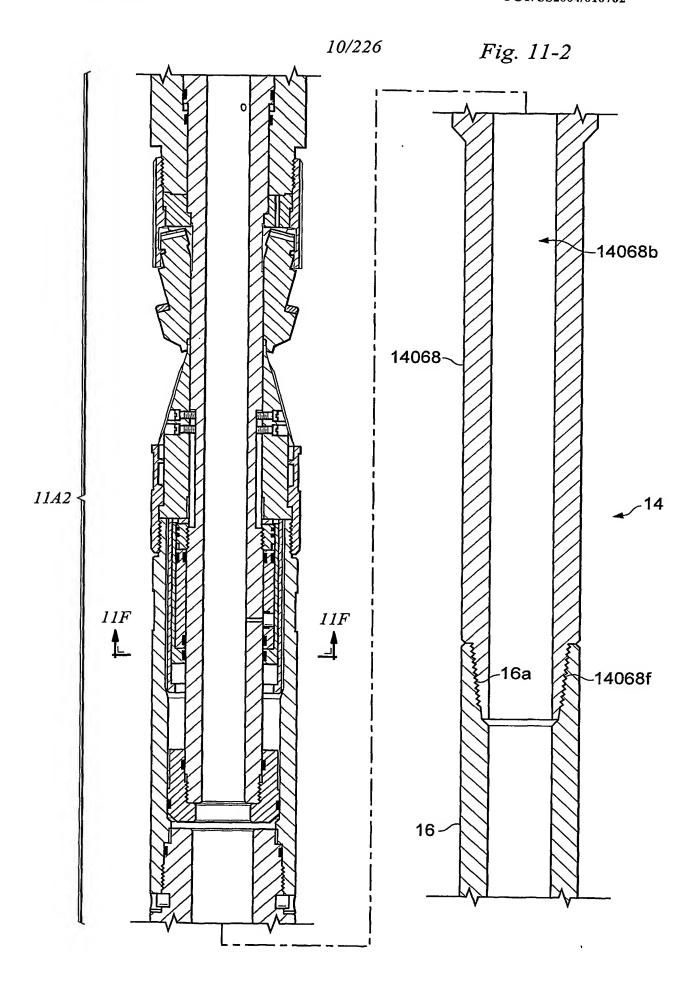


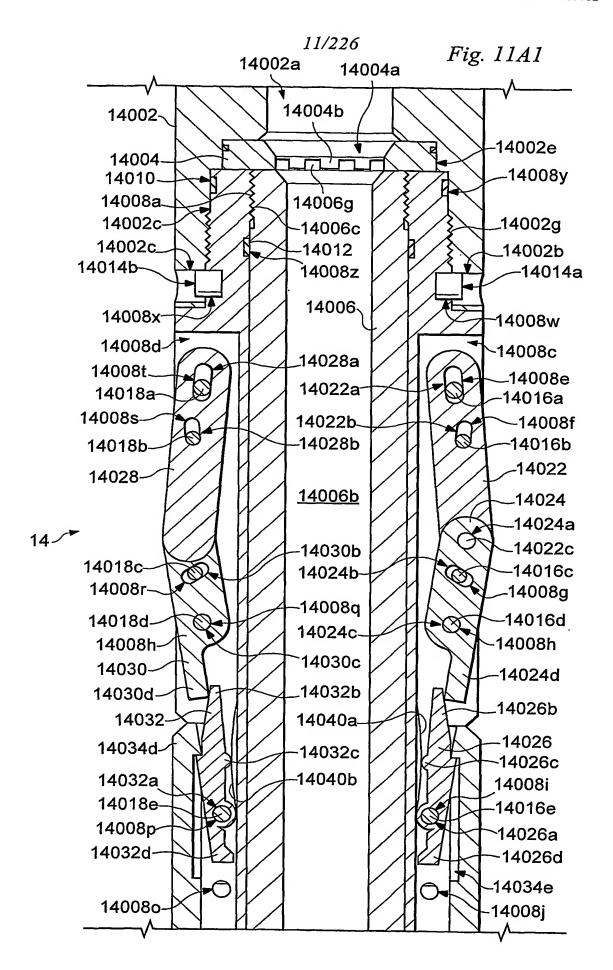




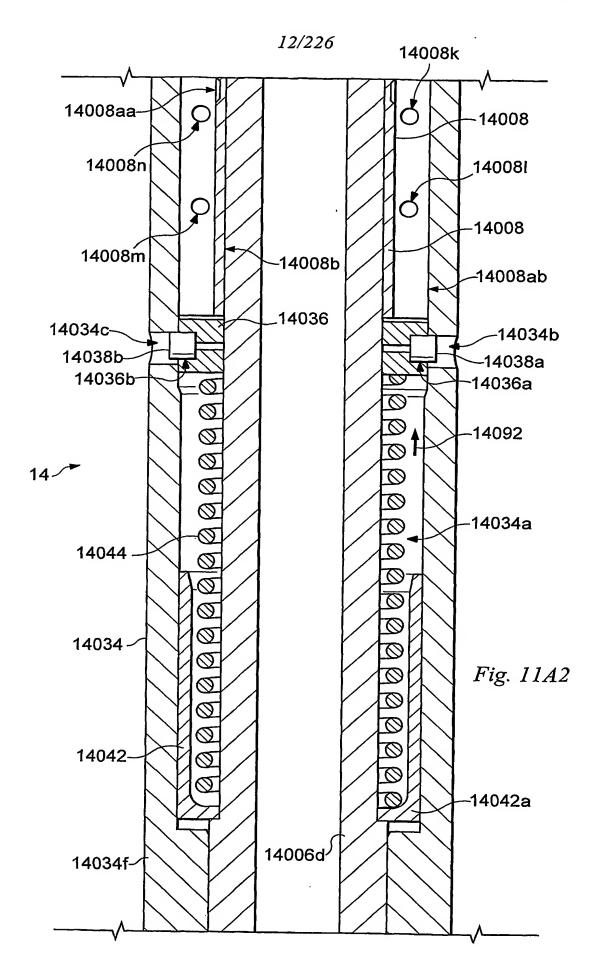


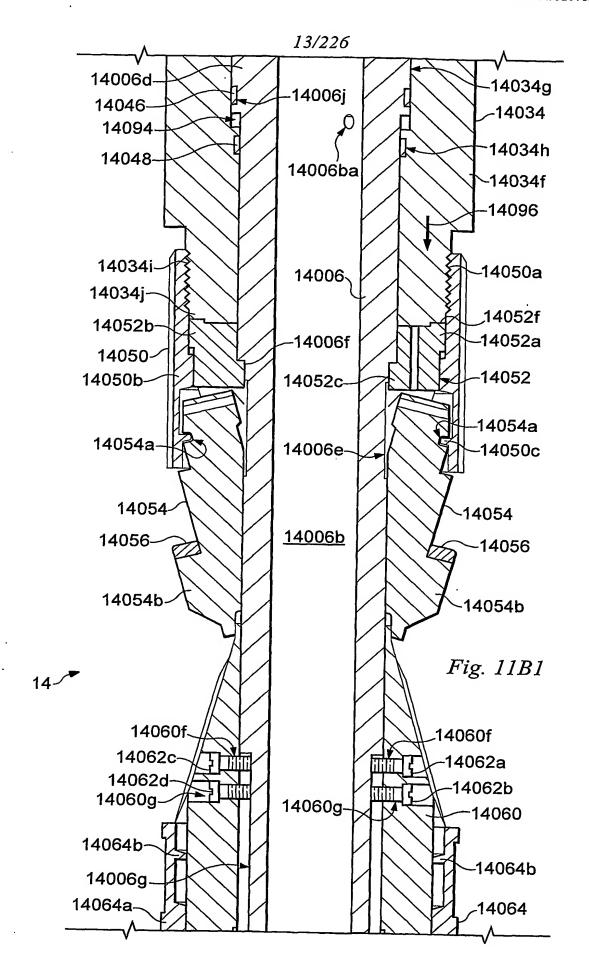


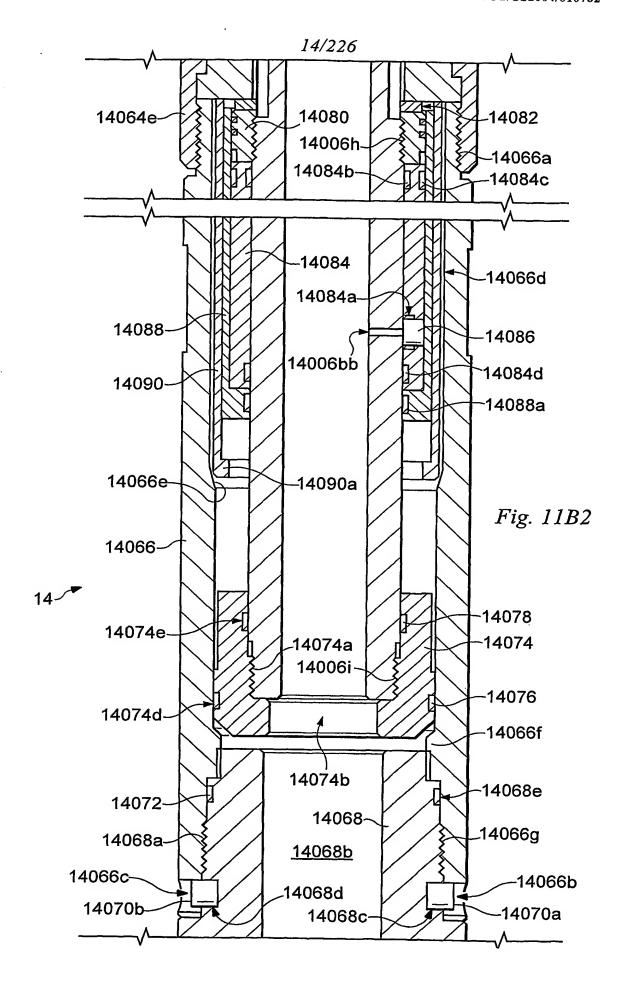




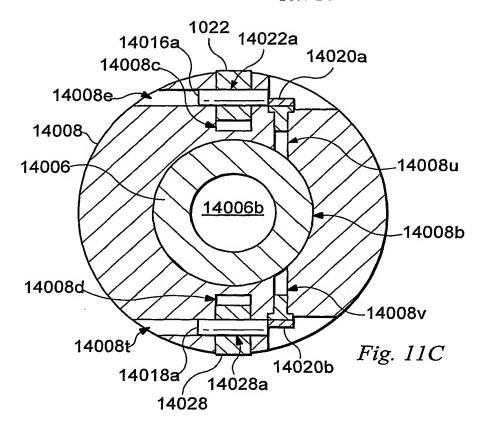
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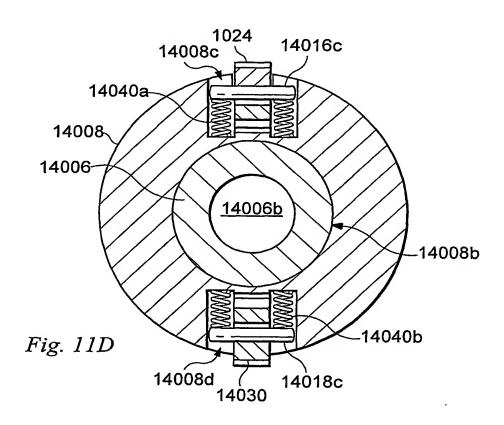






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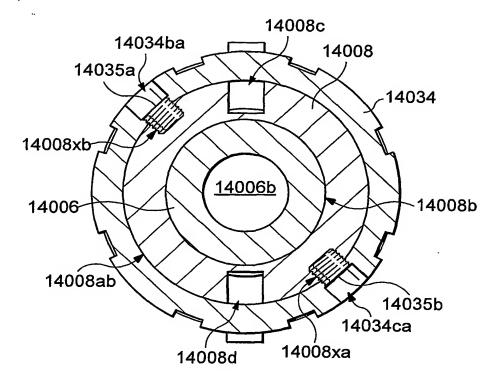


Fig. 11E

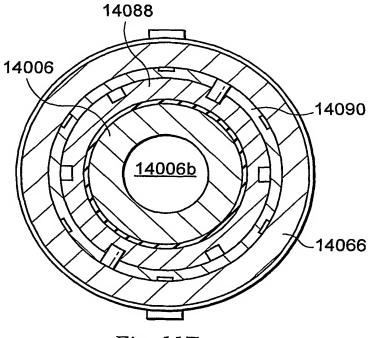
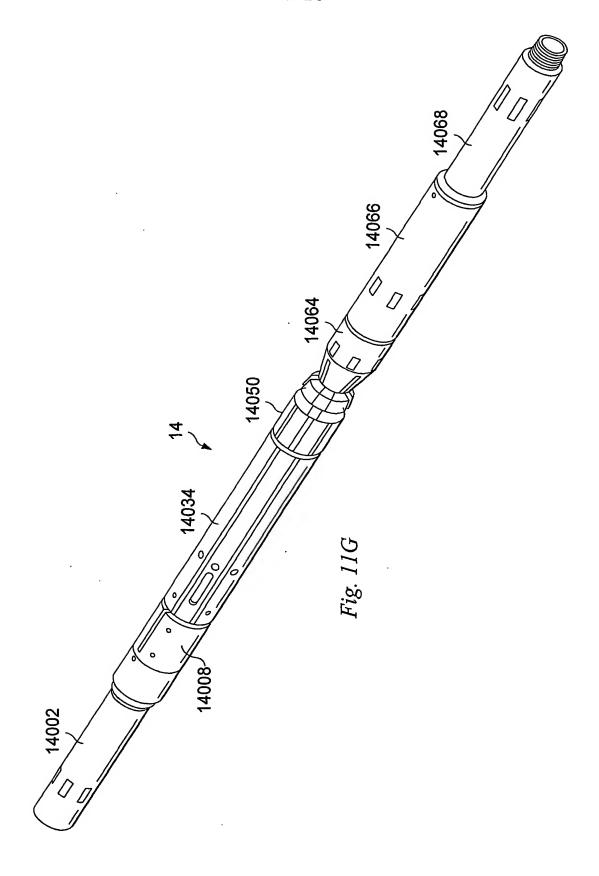


Fig. 11F

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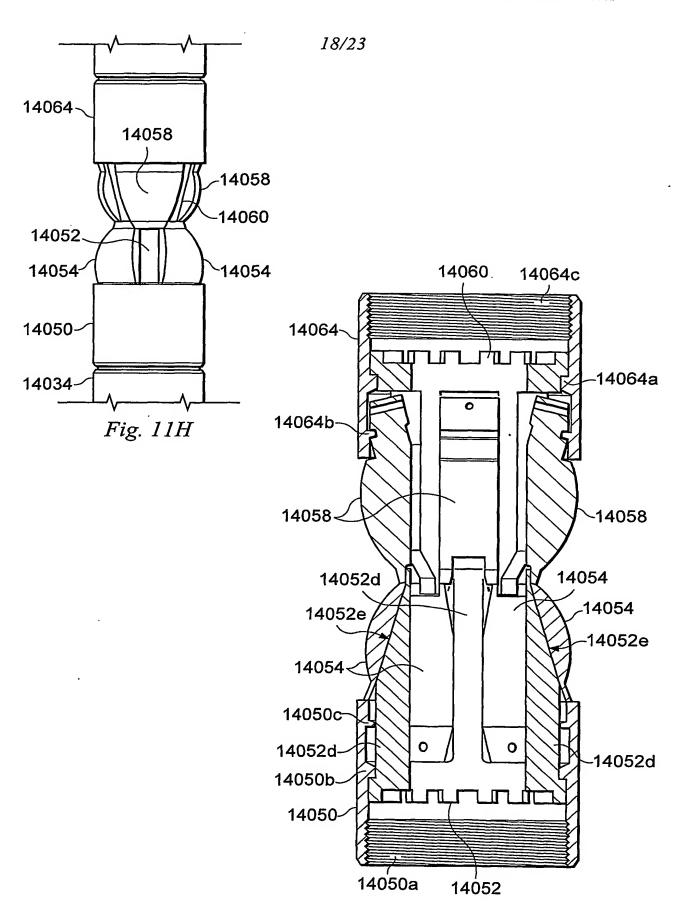
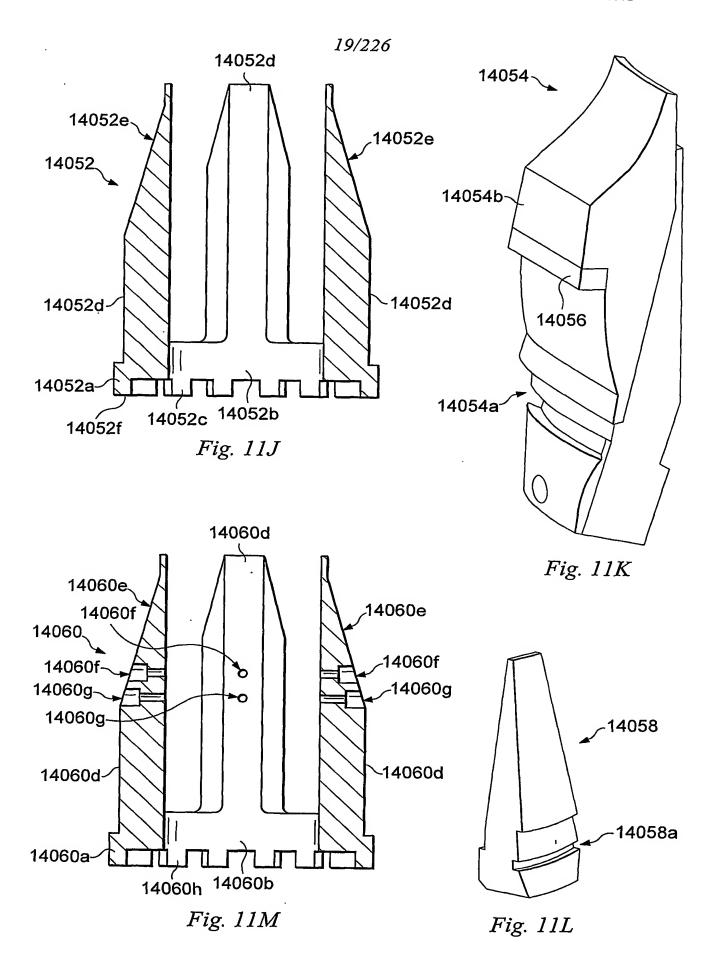
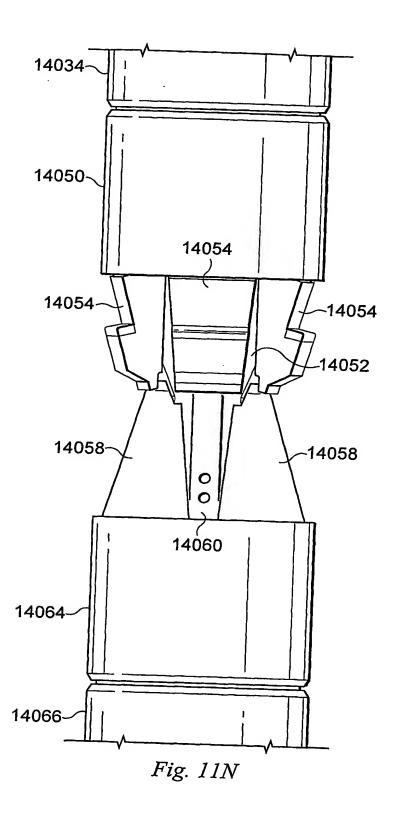


FIG. 11I





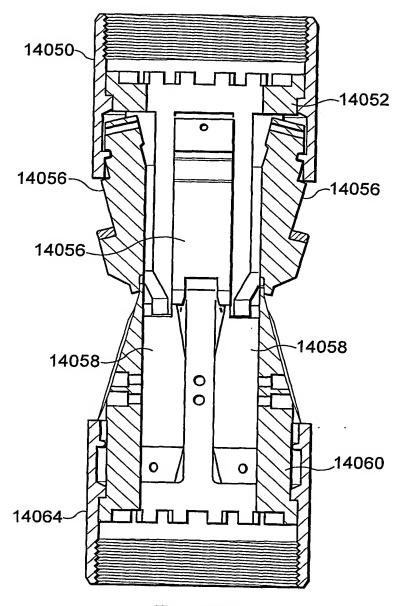
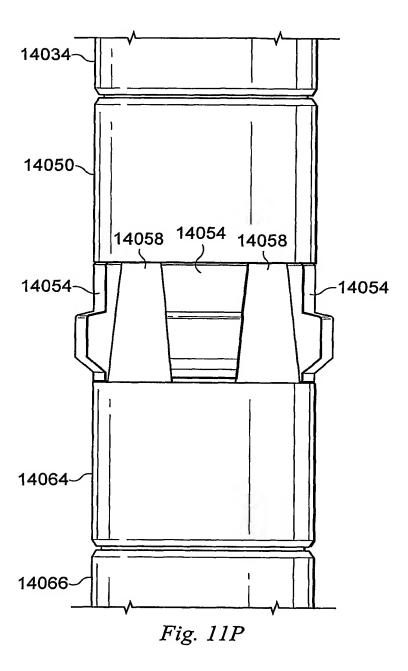


Fig. 110



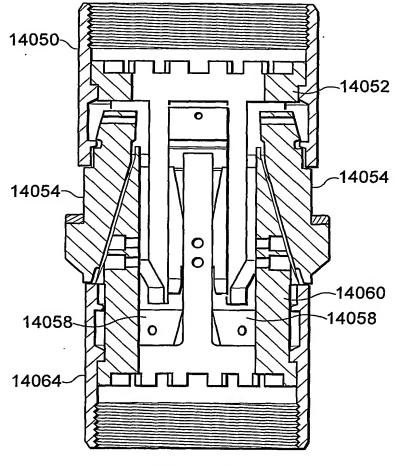
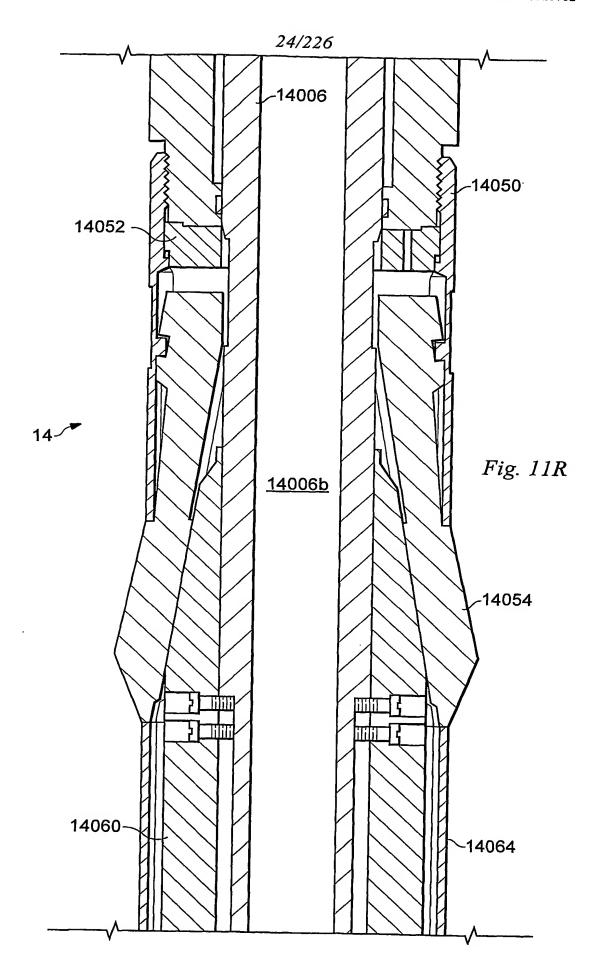


Fig. 11Q



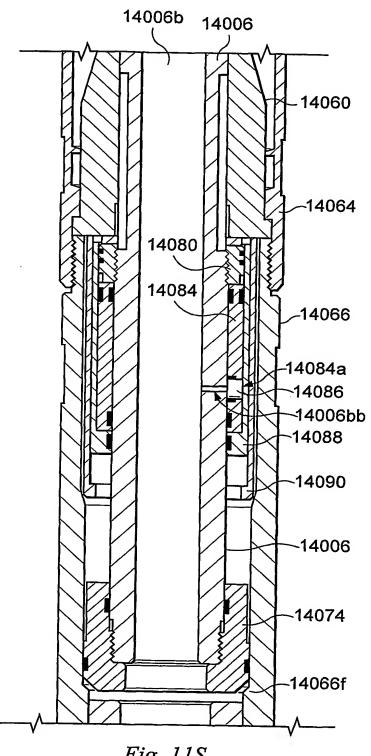


Fig. 11S

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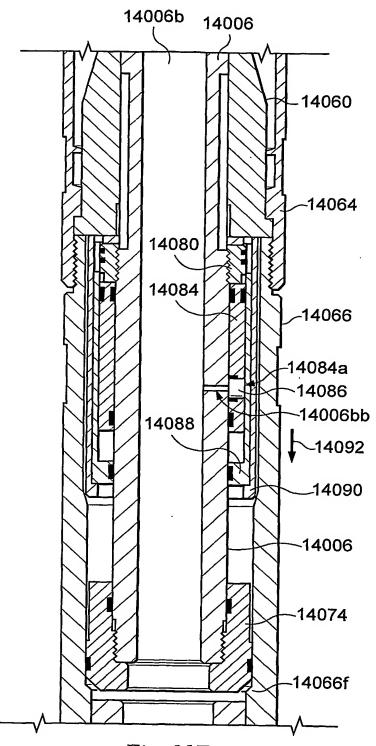


Fig. 11T

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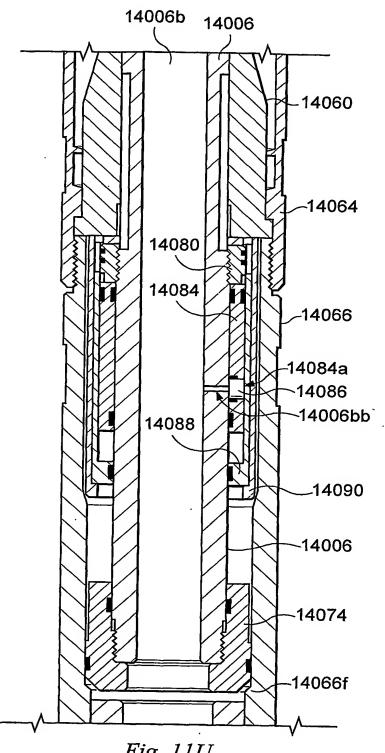


Fig. 11U

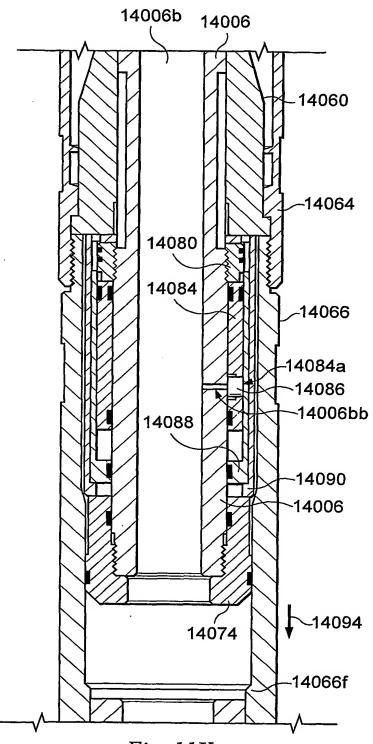
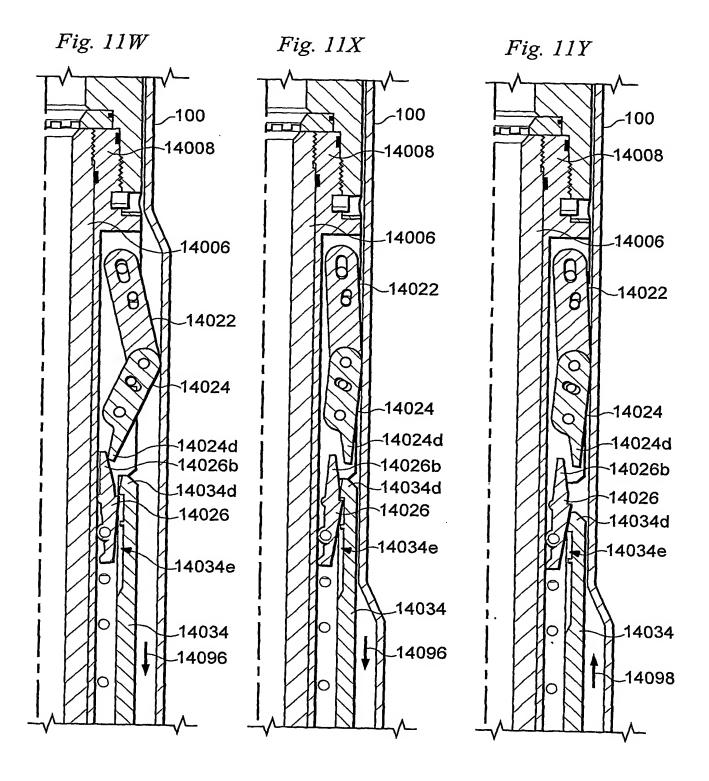
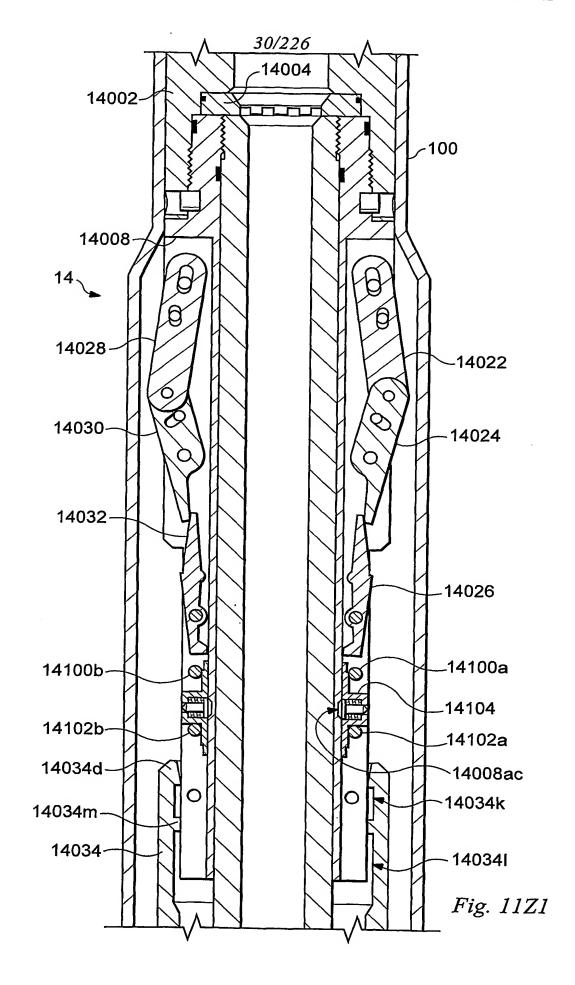


Fig. 11V





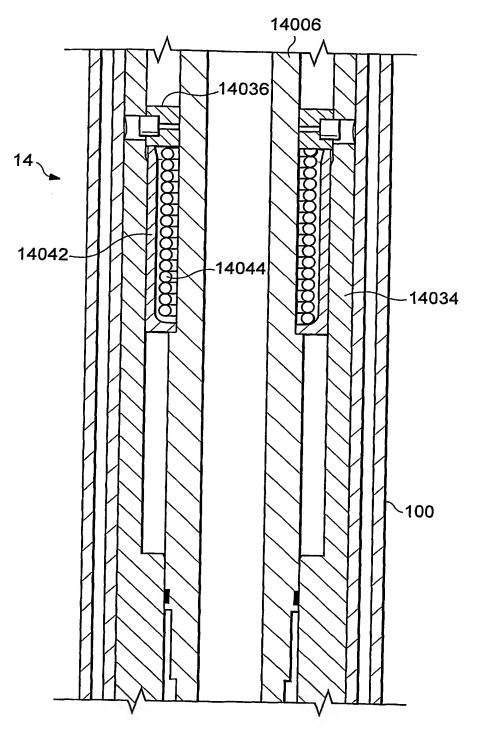


Fig. 11Z2

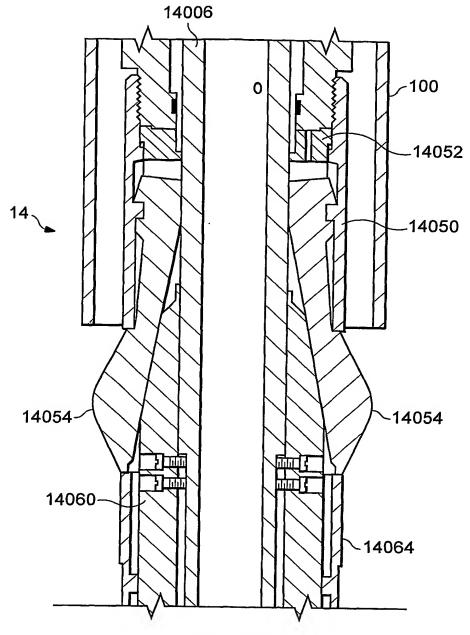


Fig. 11Z3

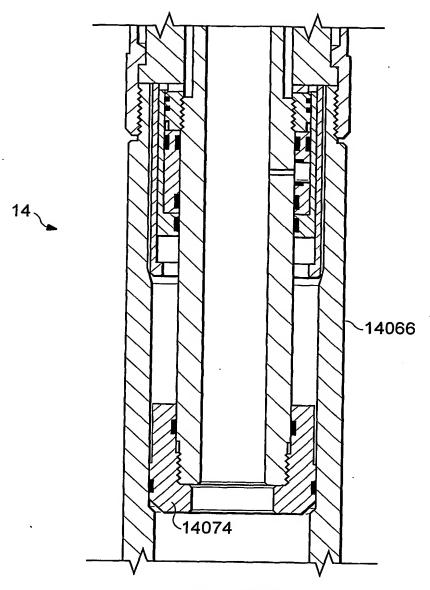


Fig. 11Z4

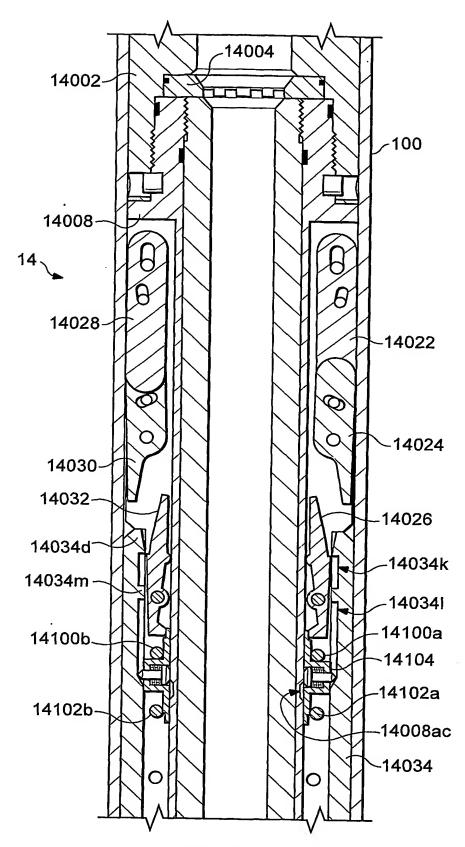


Fig. 11AA1

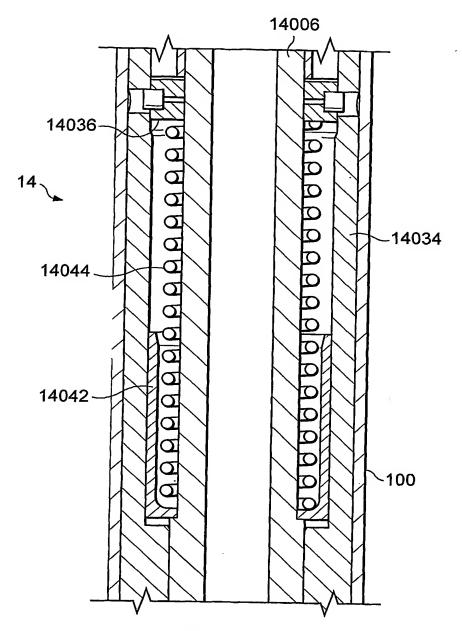


Fig. 11AA2

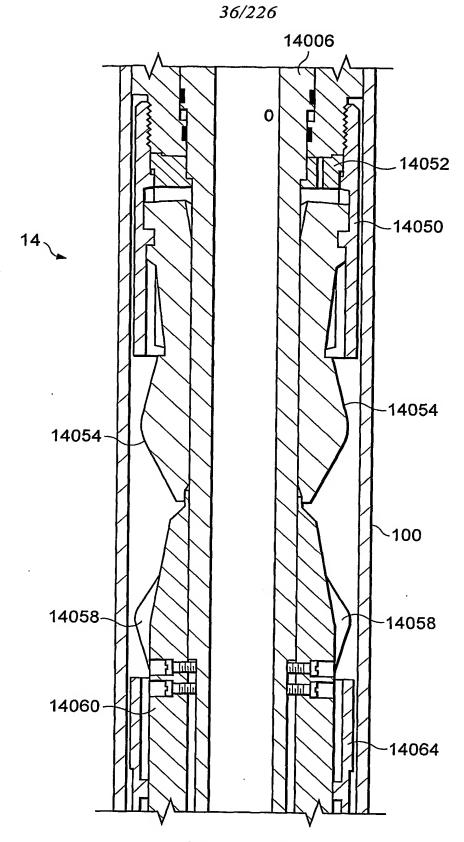


Fig. 11AA3

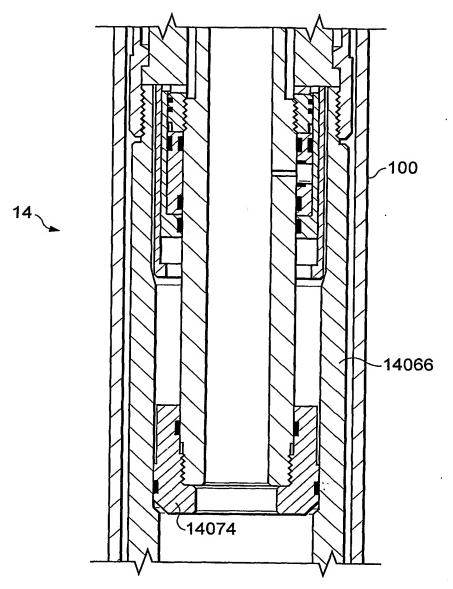


Fig. 11AA4



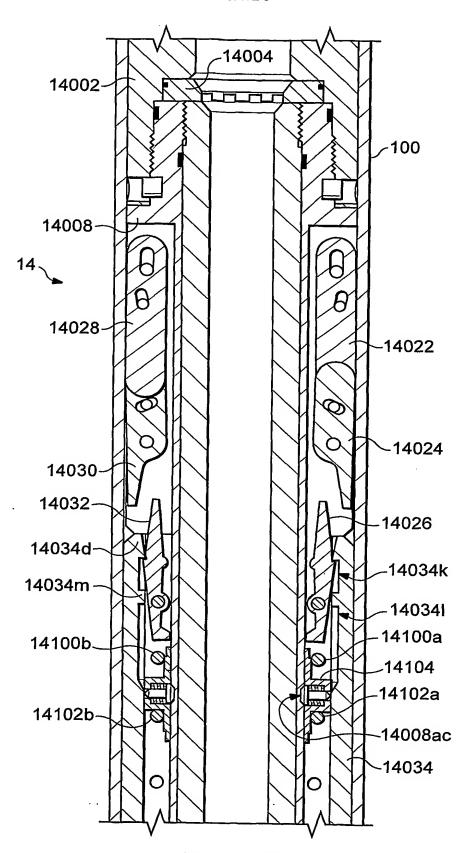


Fig. 11AB1

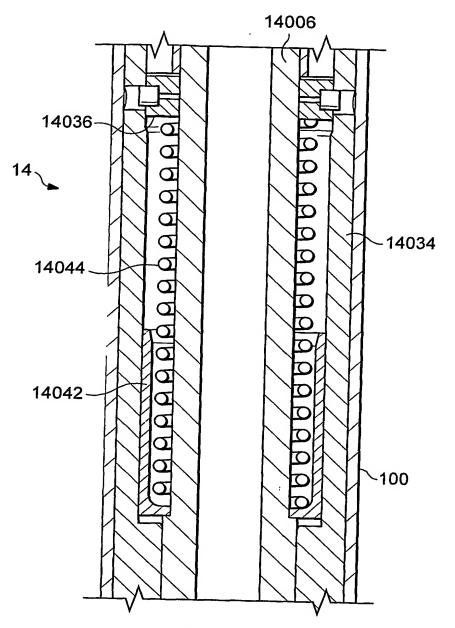


Fig. 11AB2

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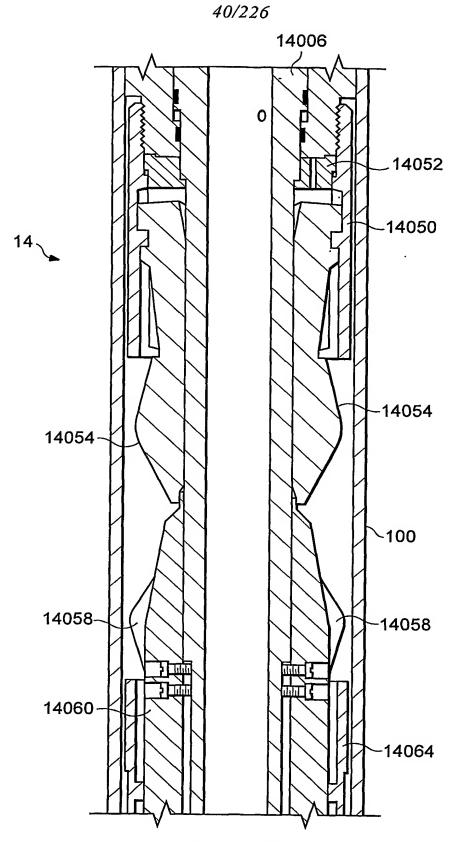


Fig. 11AB3

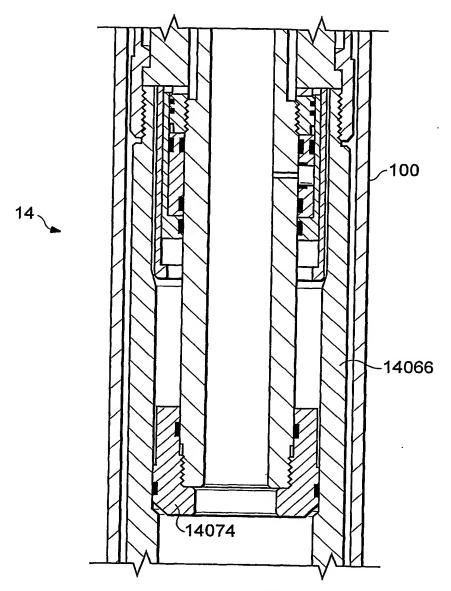
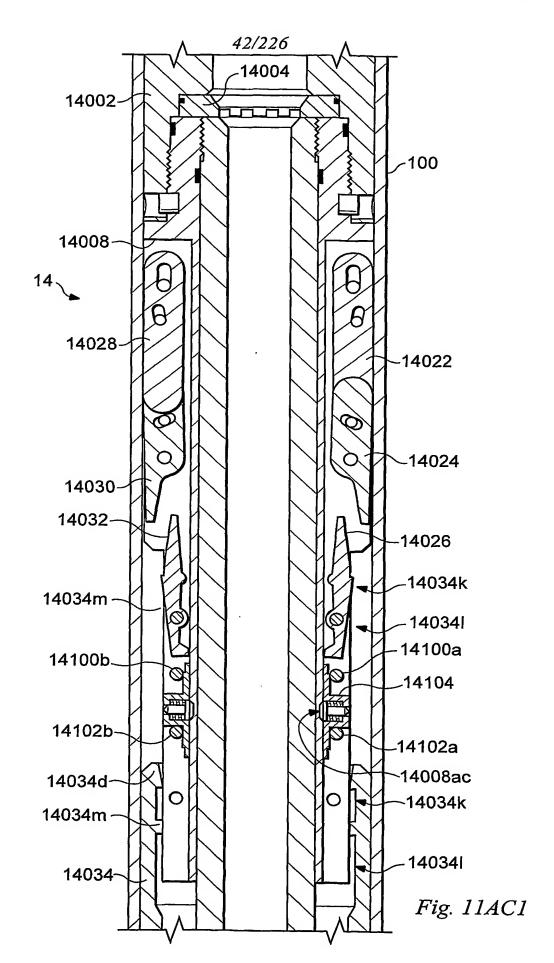


Fig. 11AB4



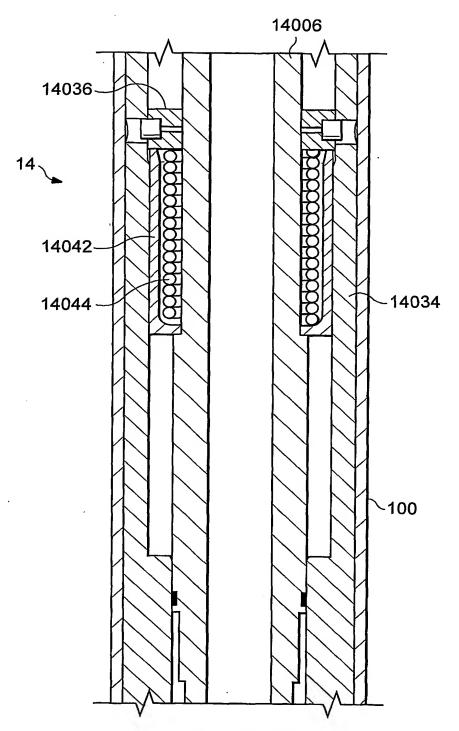


Fig. 11AC2

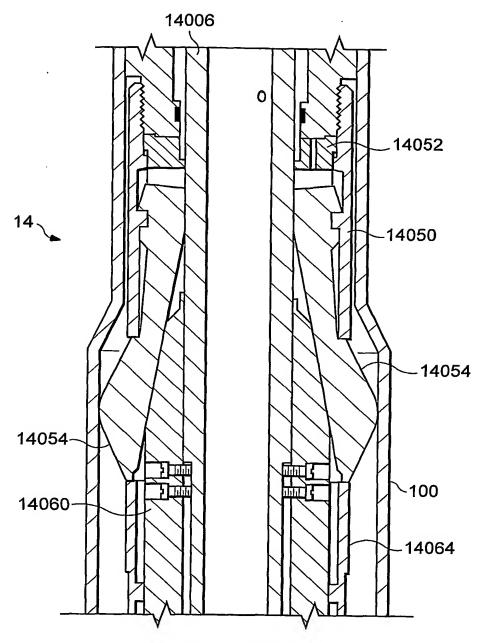


Fig. 11AC3

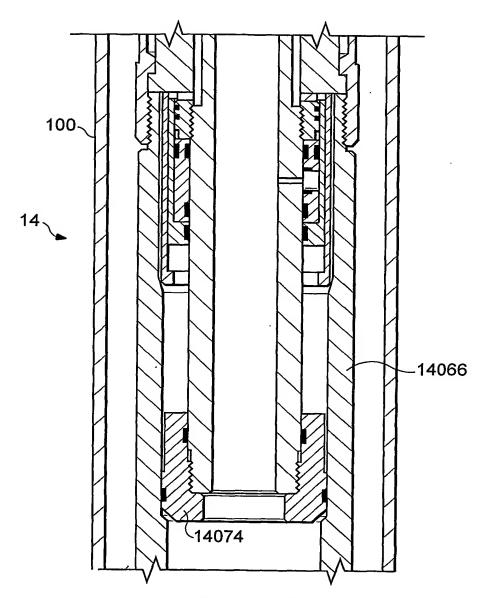


Fig. 11AC4

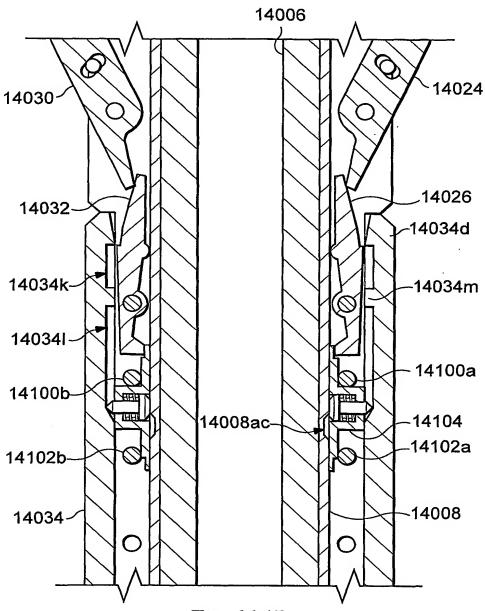


Fig. 11AD

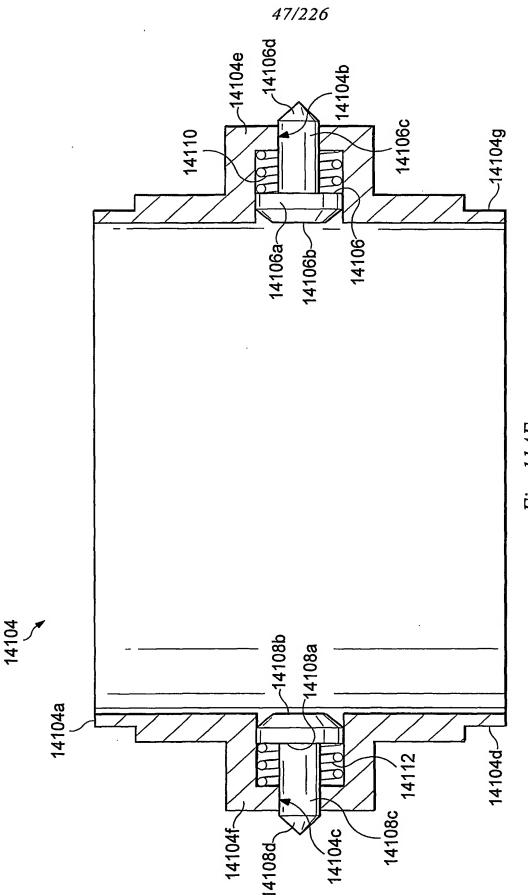


Fig. 11AE

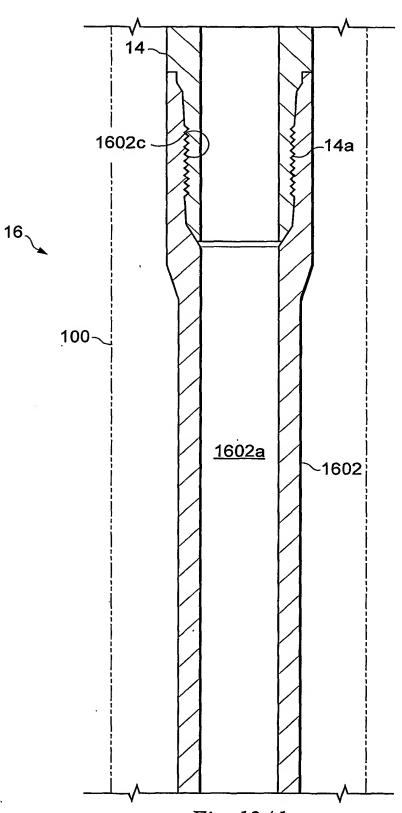


Fig. 12A1

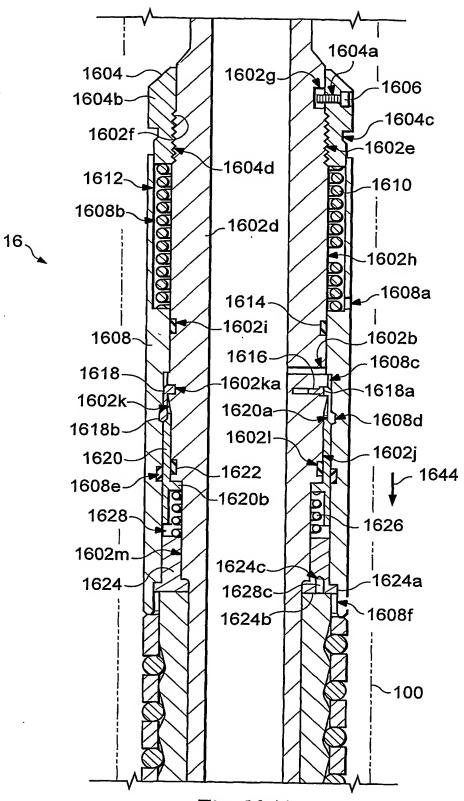


Fig. 12A2

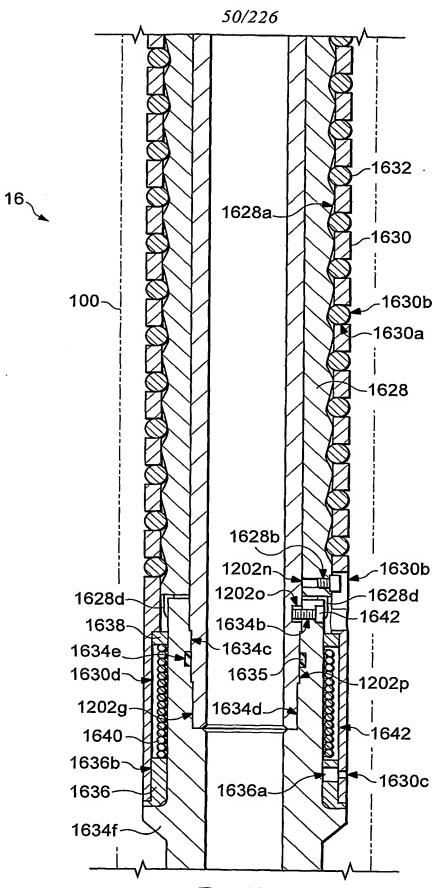


Fig. 12A3



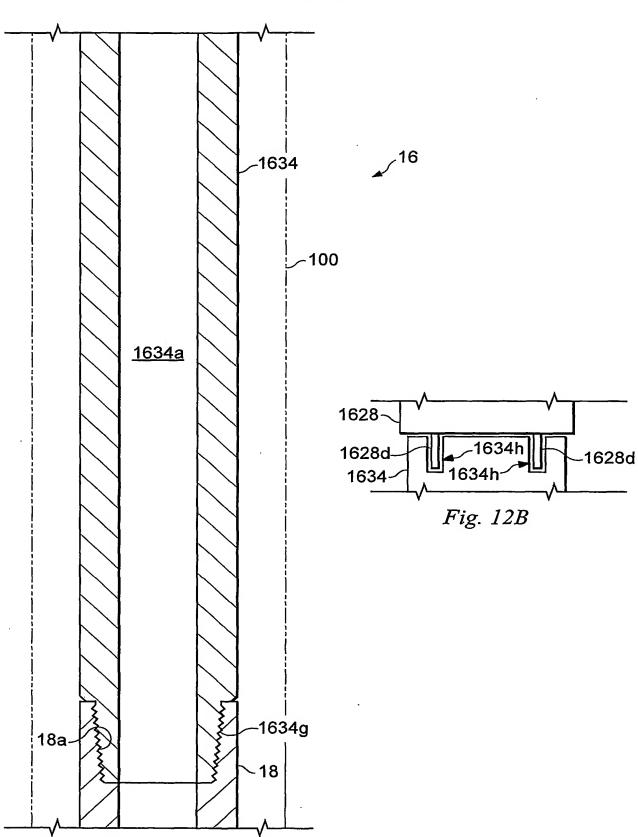


Fig. 12A4

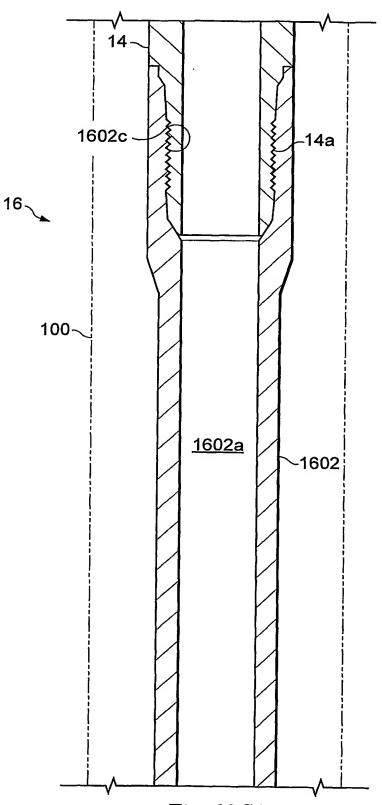


Fig. 12C1

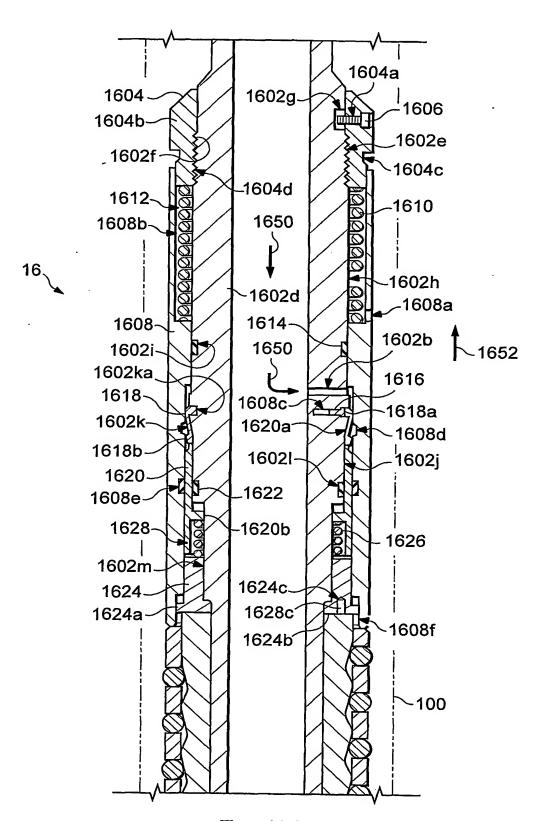


Fig. 12C2

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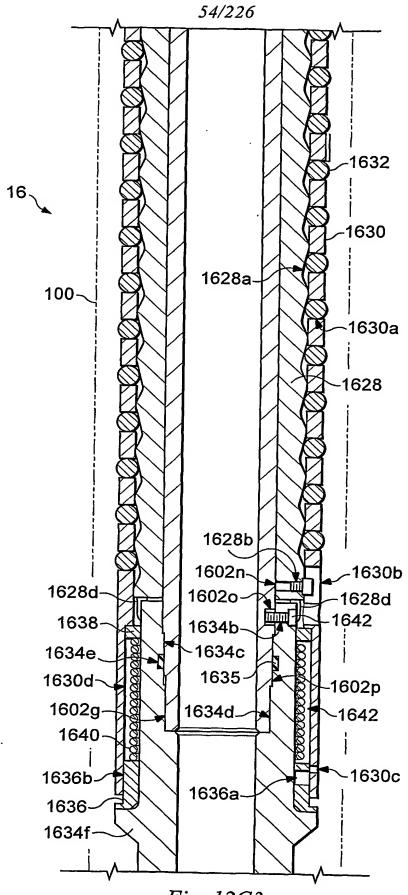
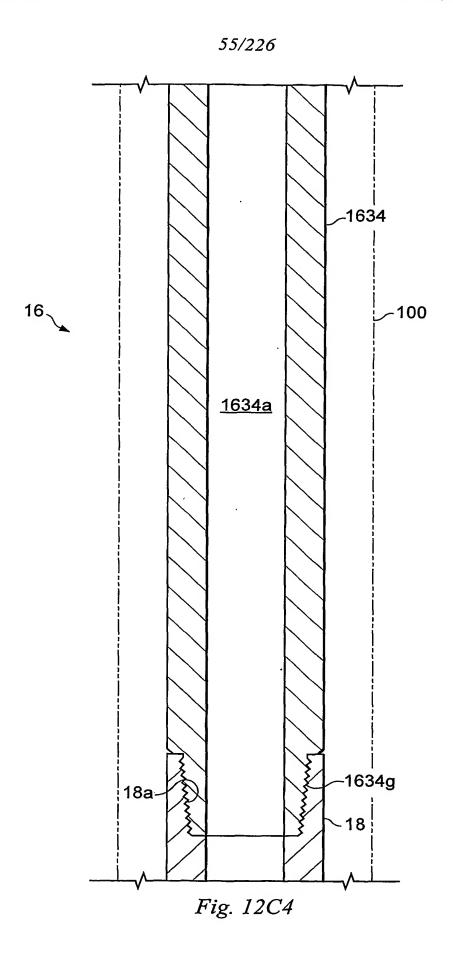


Fig. 12C3



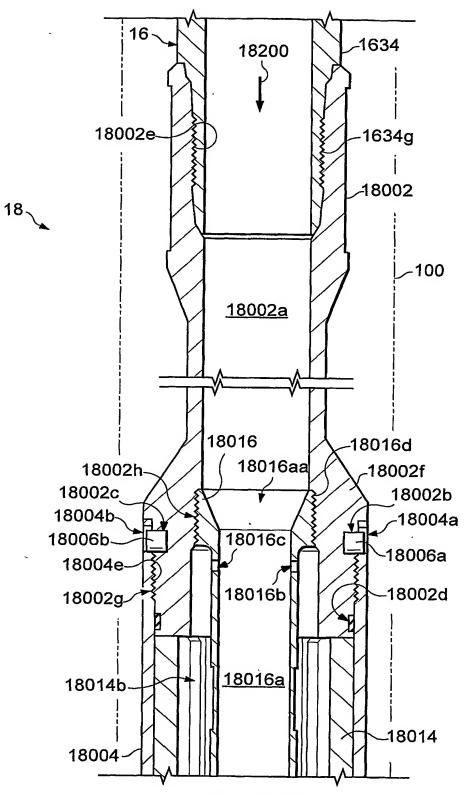
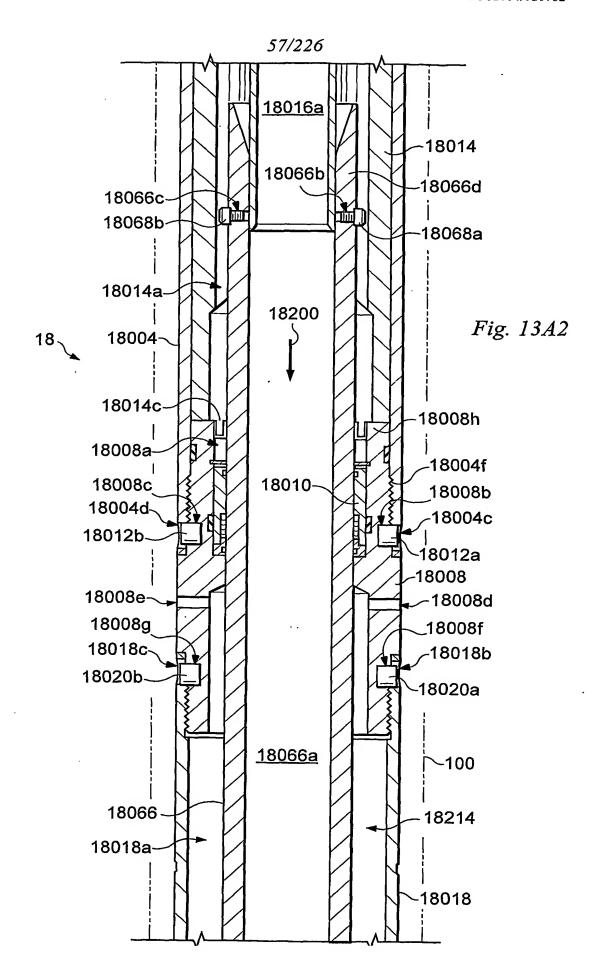


Fig. 13A1

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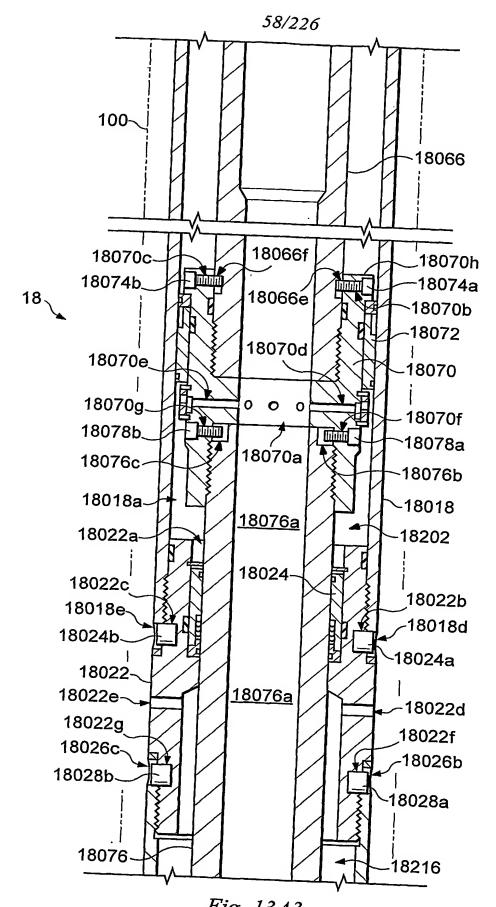


Fig. 13A3

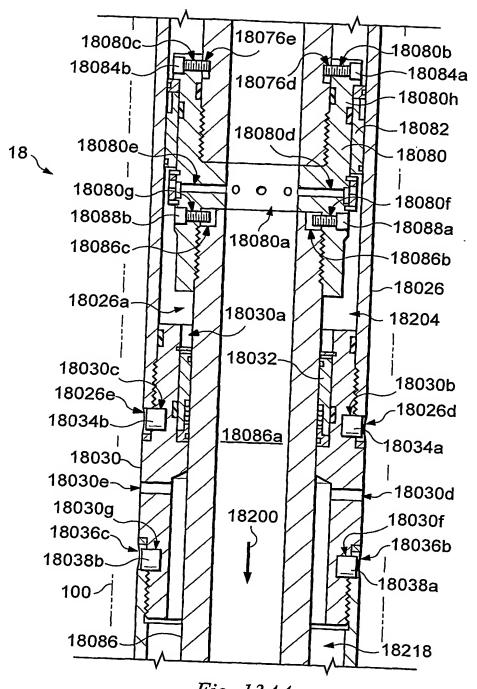


Fig. 13A4

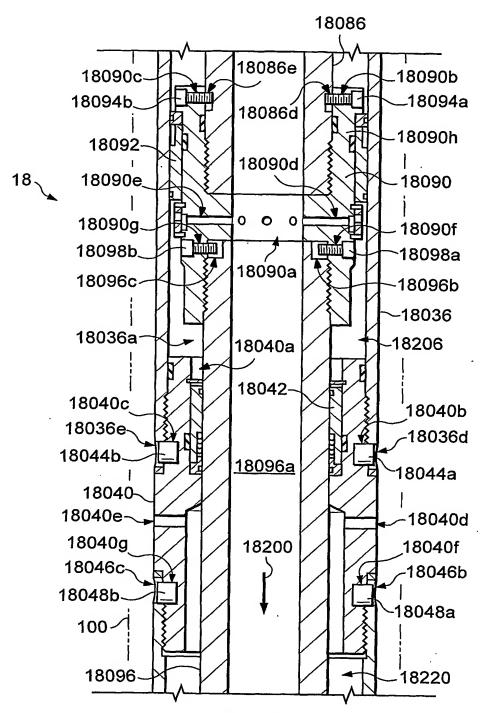
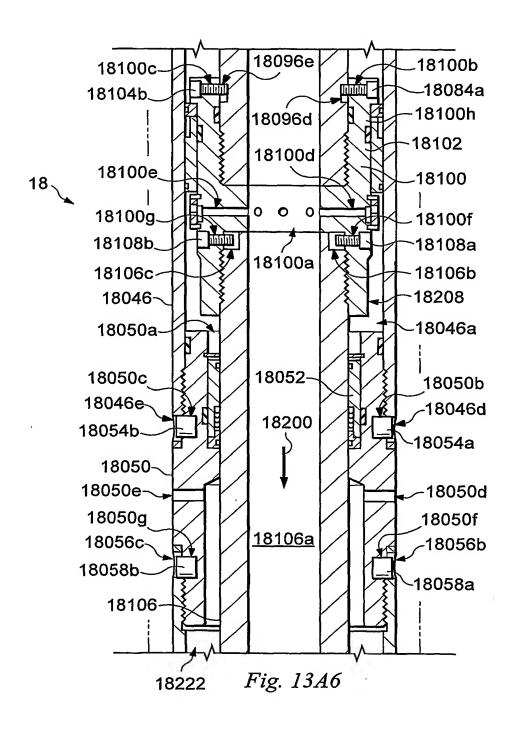
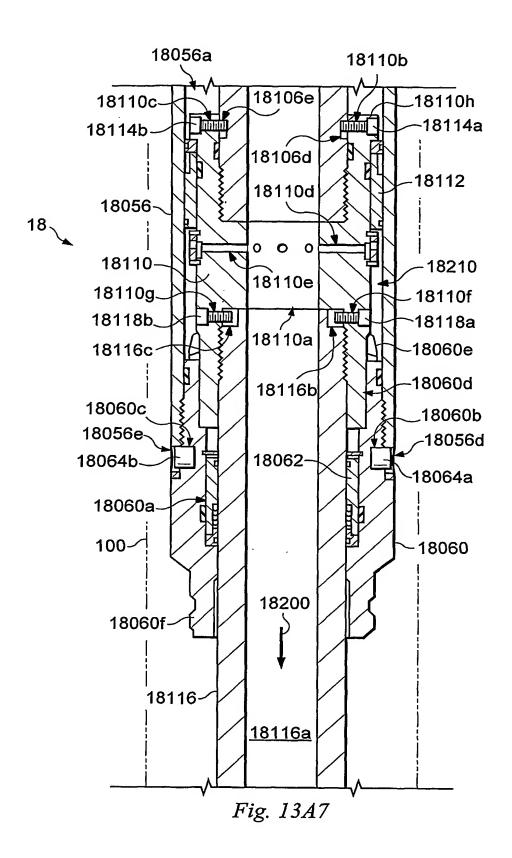
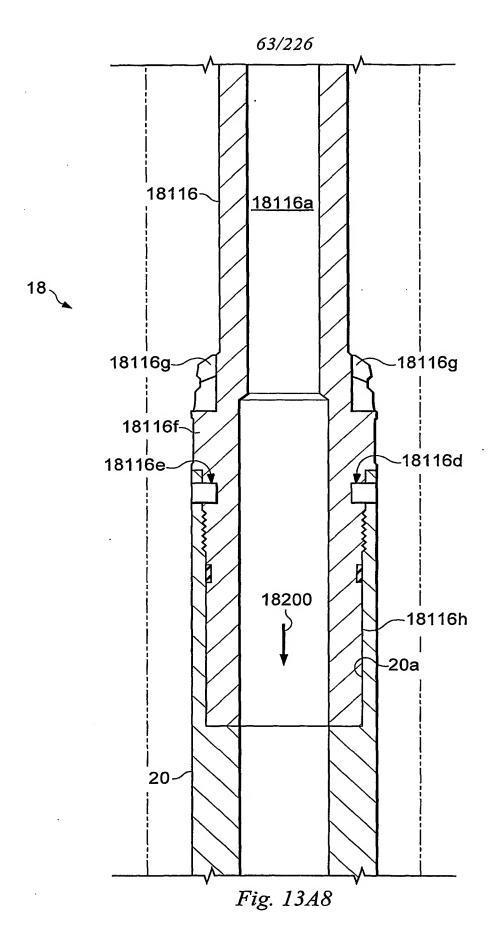


Fig. 13A5







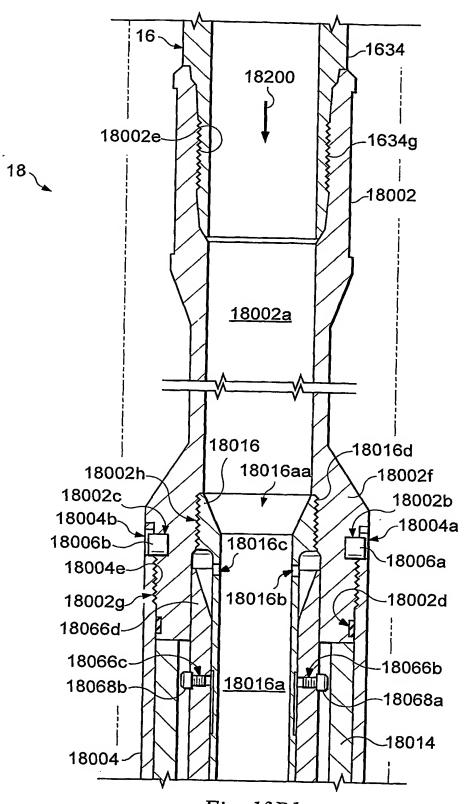
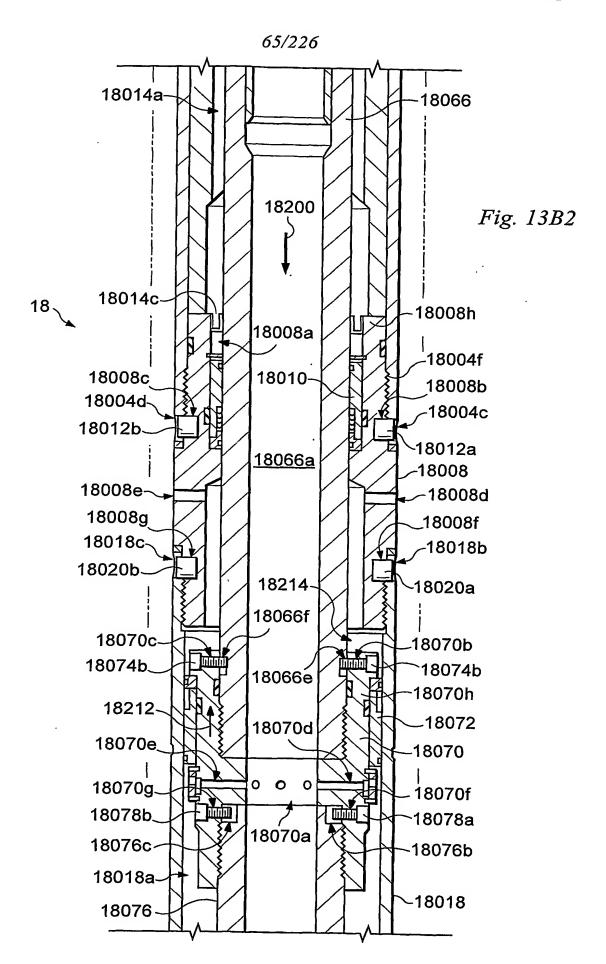


Fig. 13B1



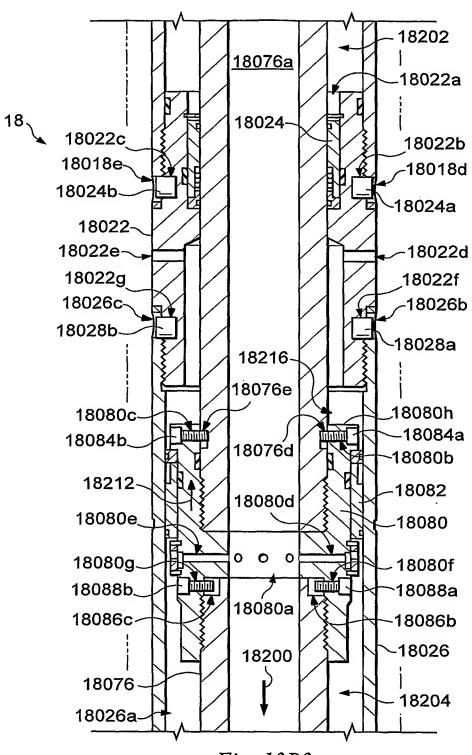


Fig. 13B3

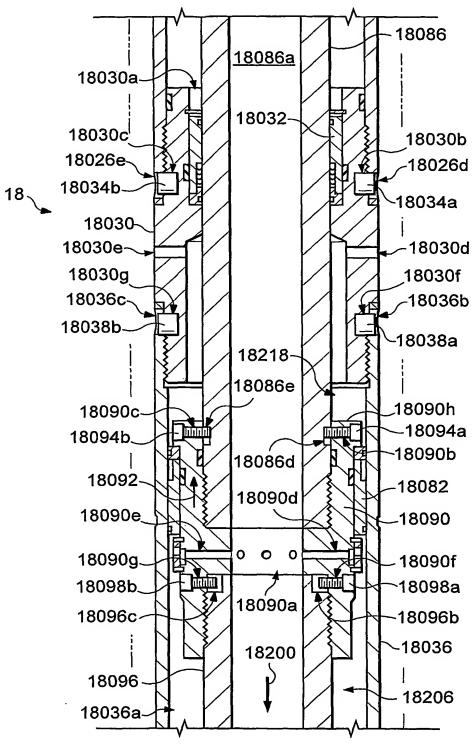


Fig. 13B4

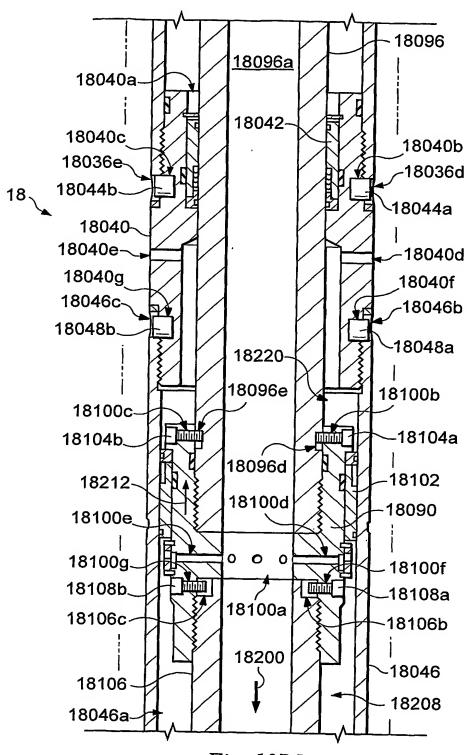
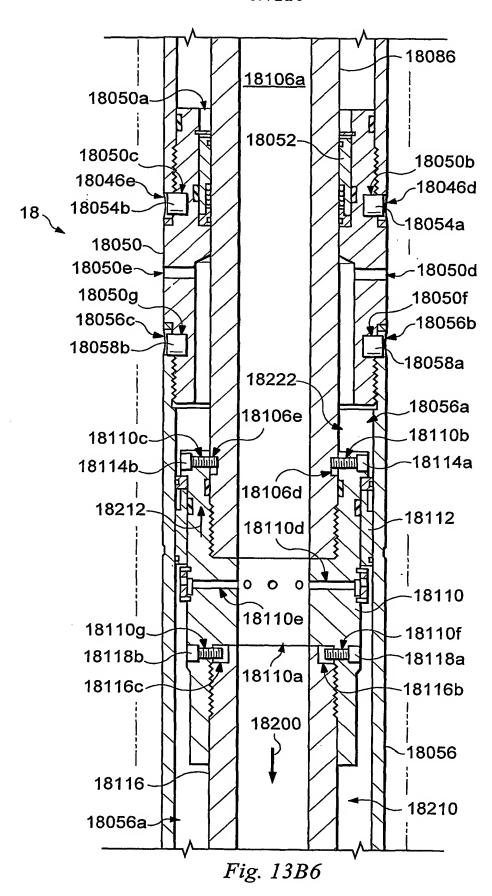
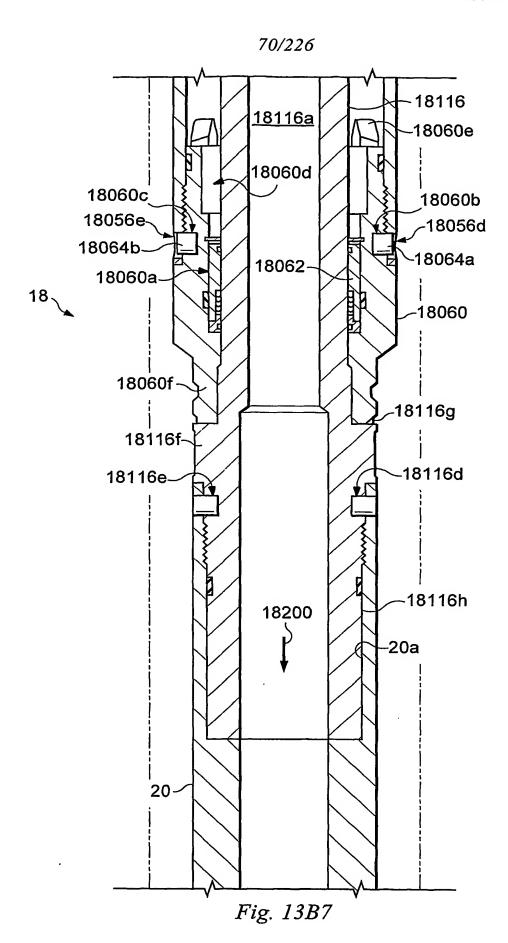
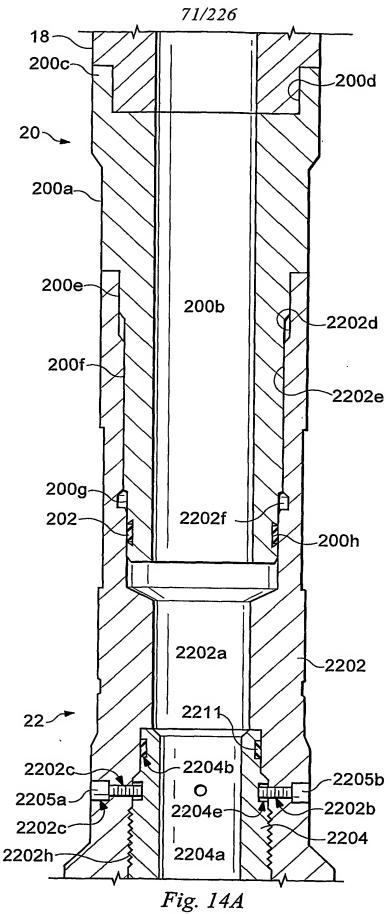


Fig. 13B5

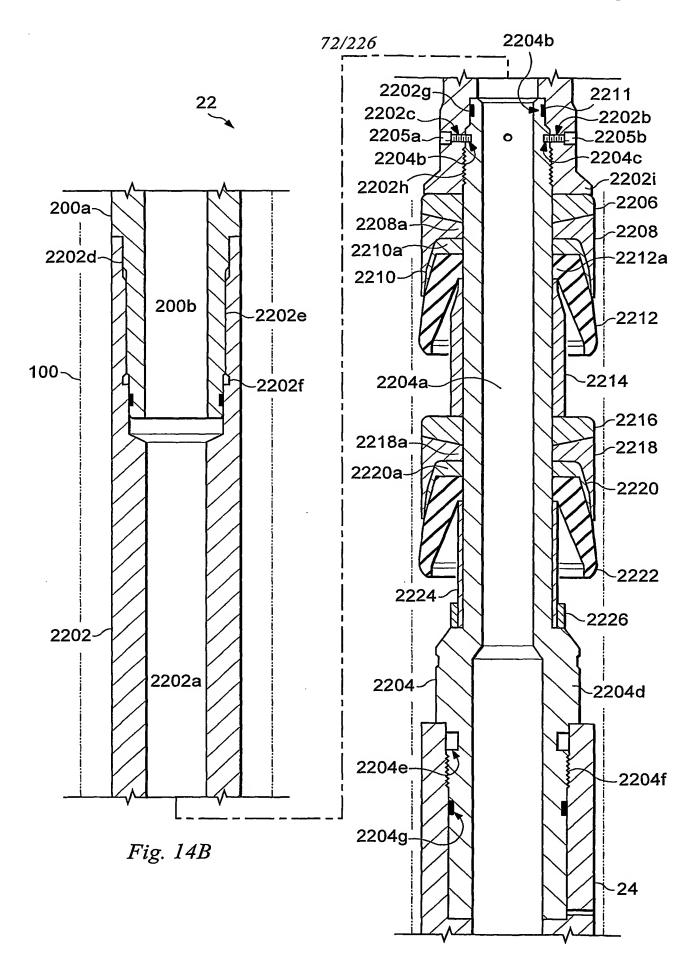
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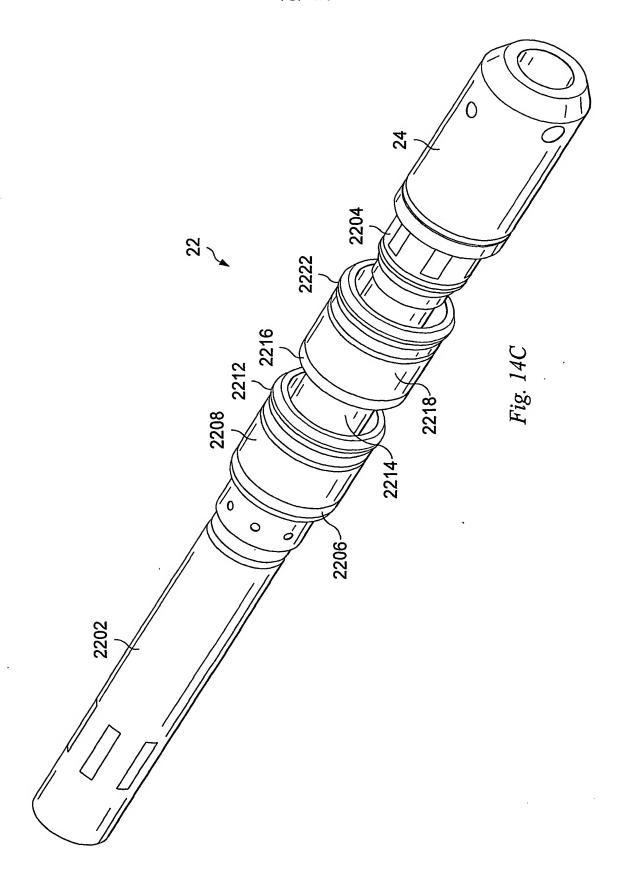


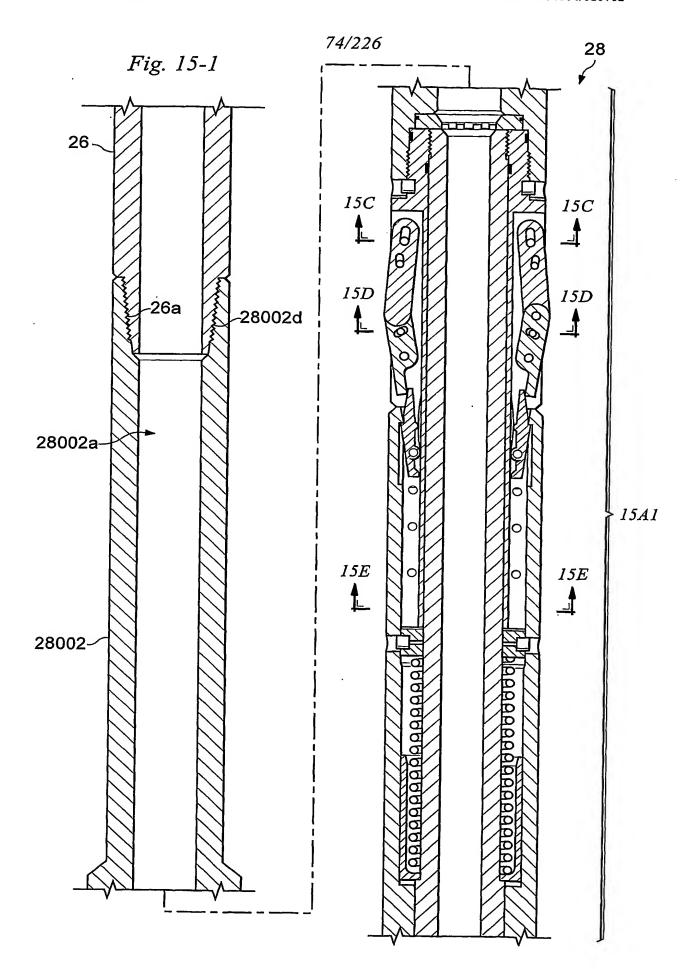


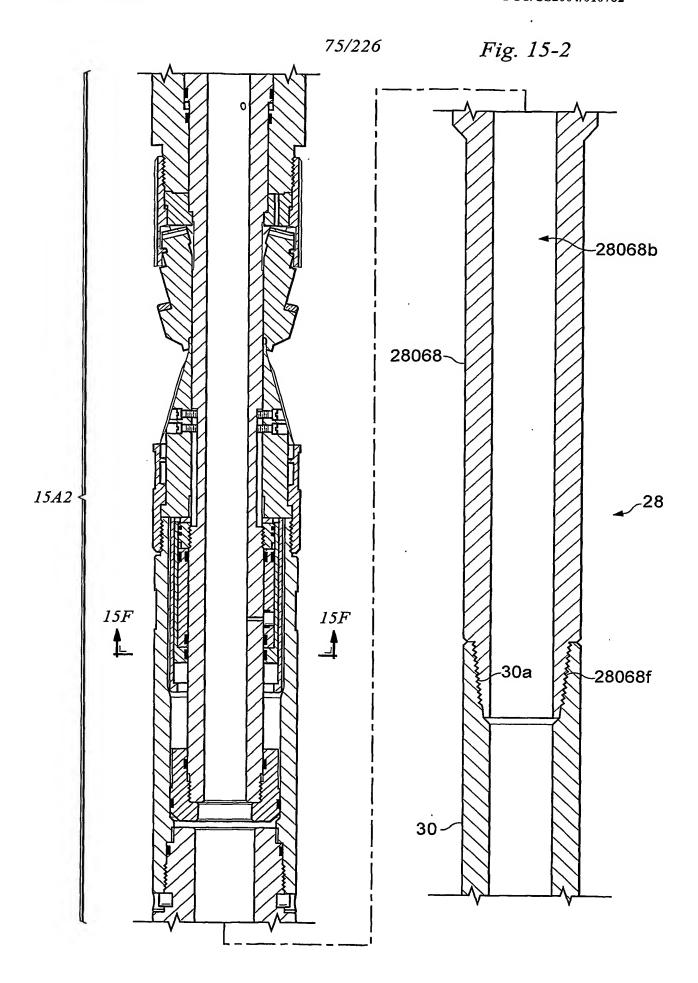
WO 2004/092528



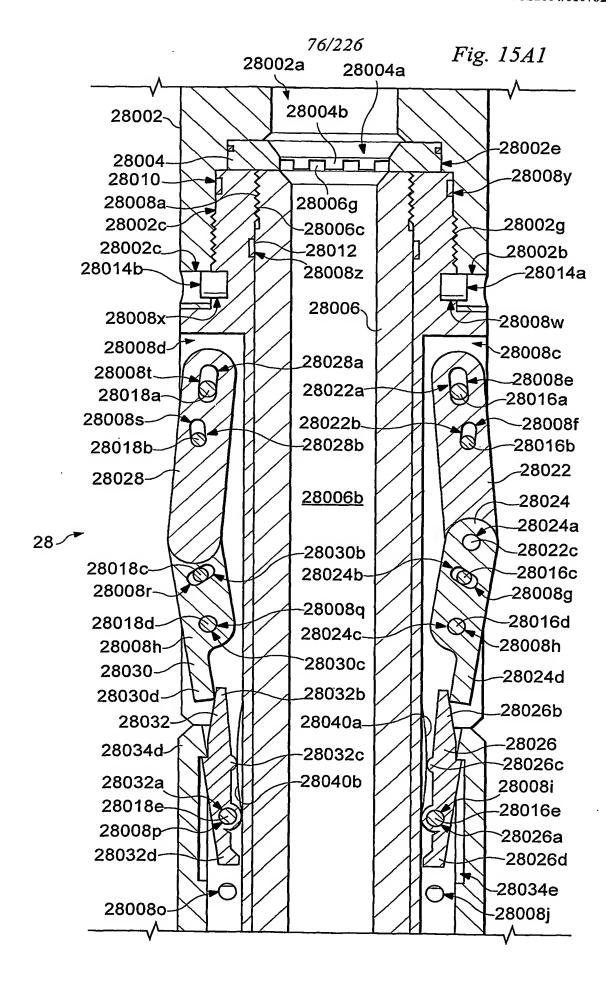
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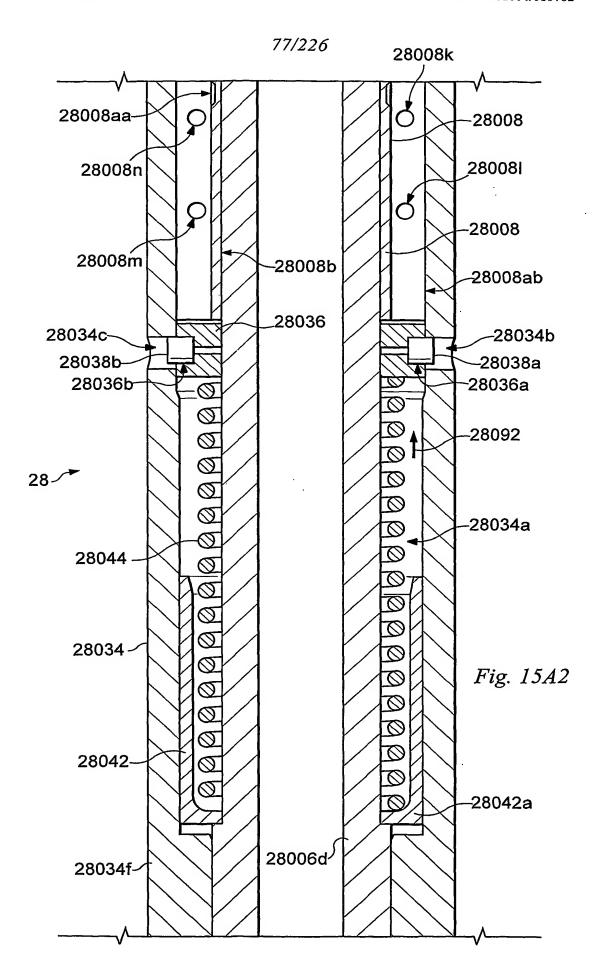


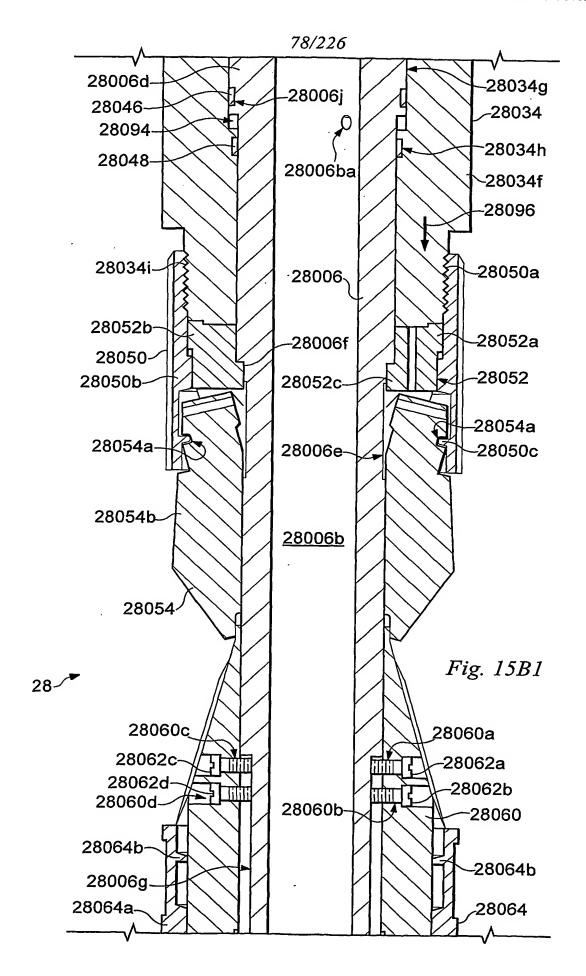




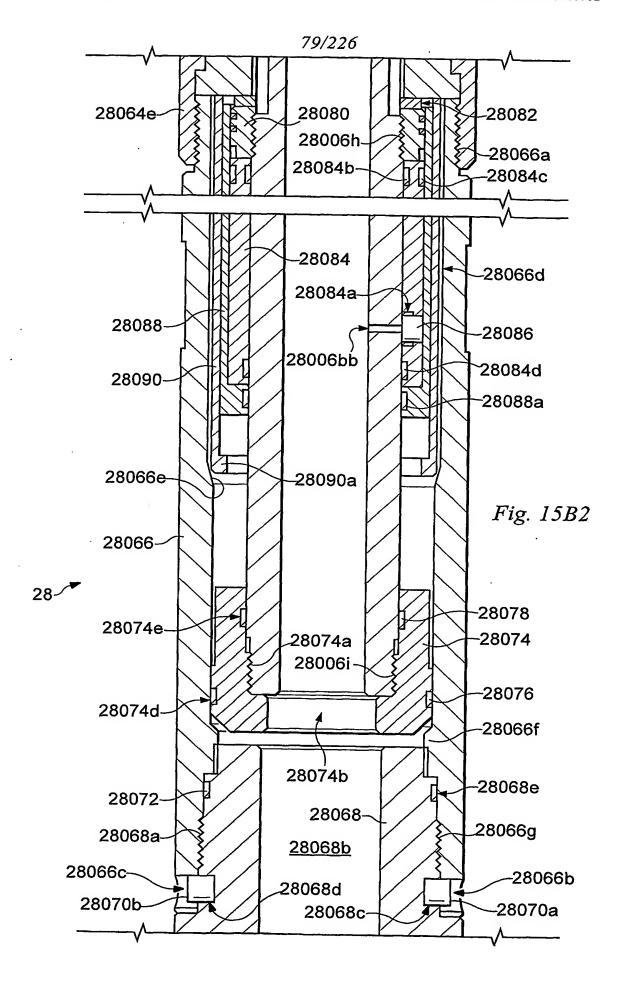
WO 2004/092528 PCT/US2004/010762



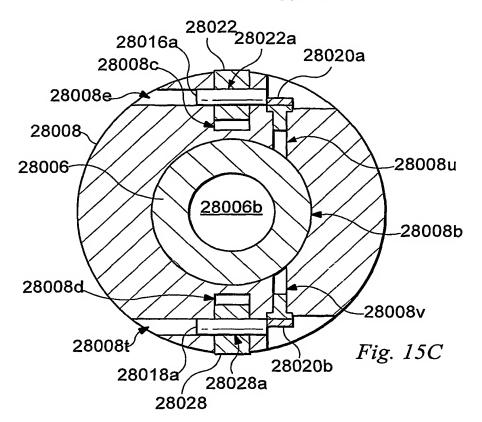


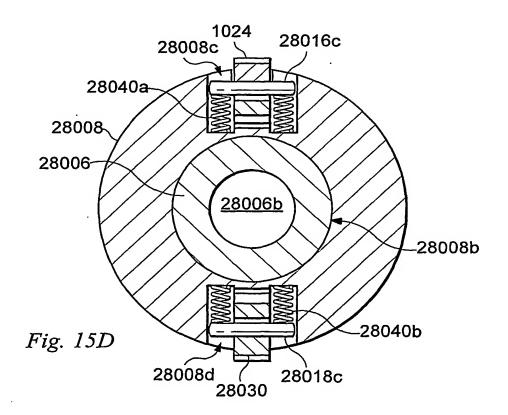


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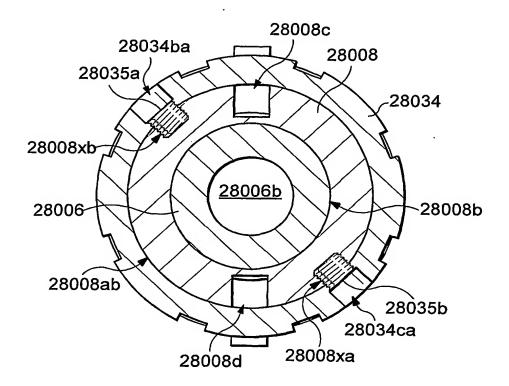


Fig. 15E

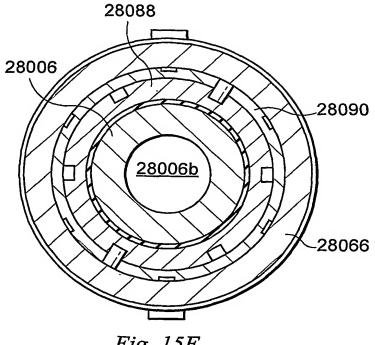
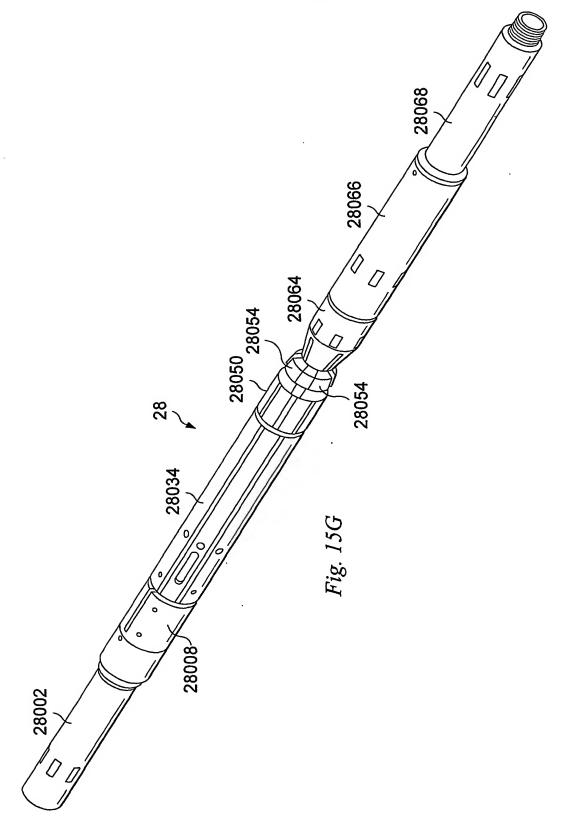


Fig. 15F





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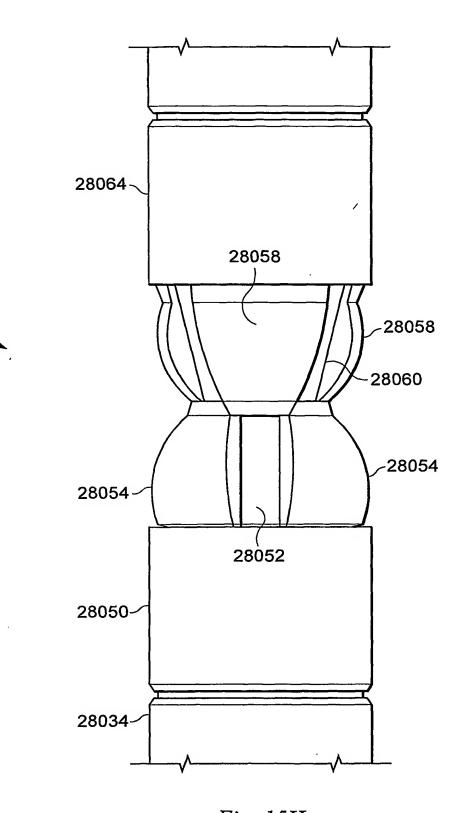


Fig. 15H

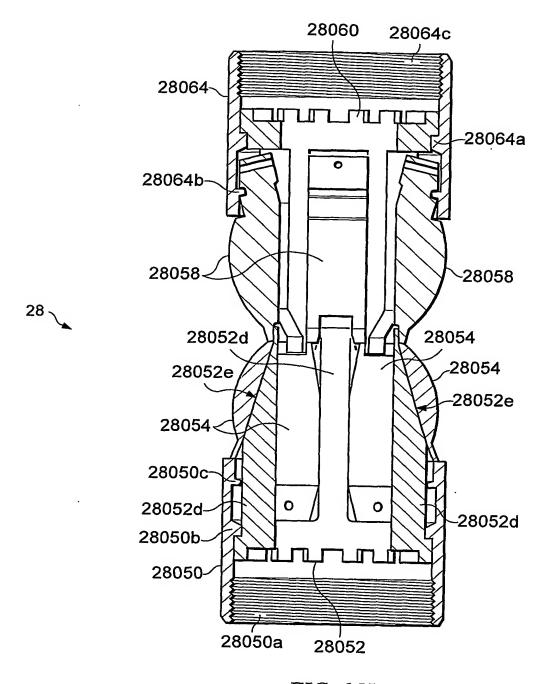
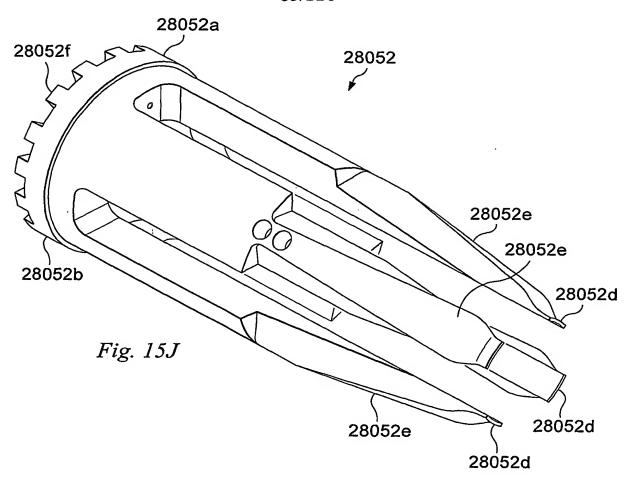
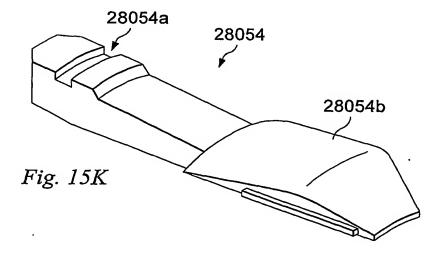
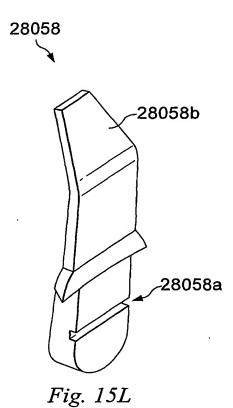


FIG. 15I









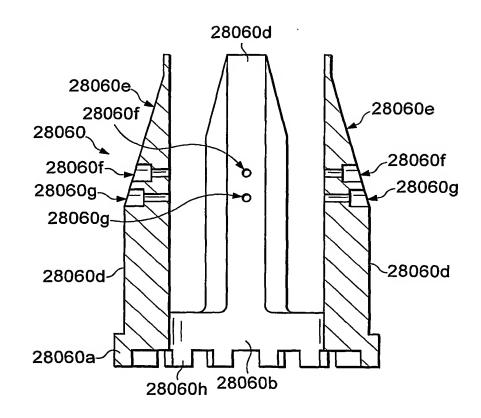
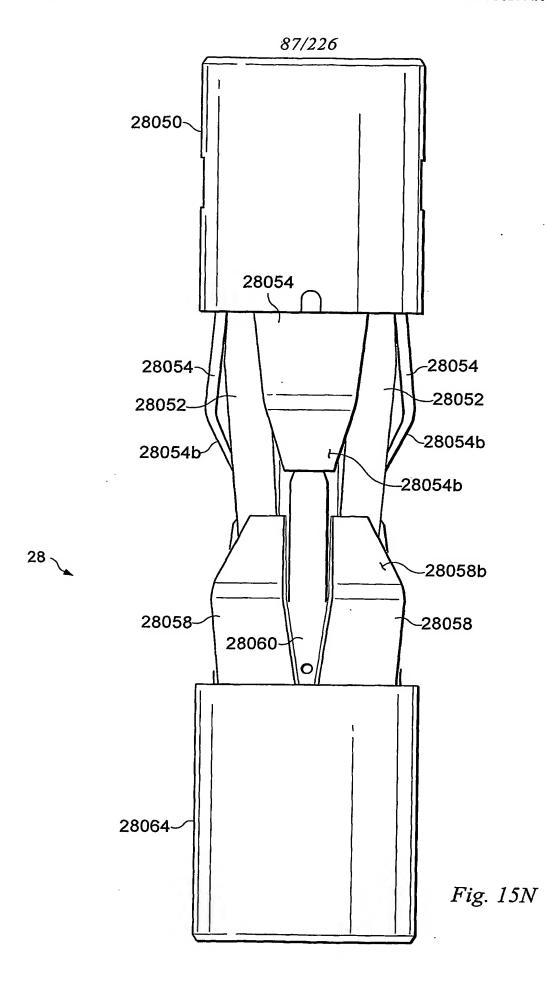


Fig. 15M



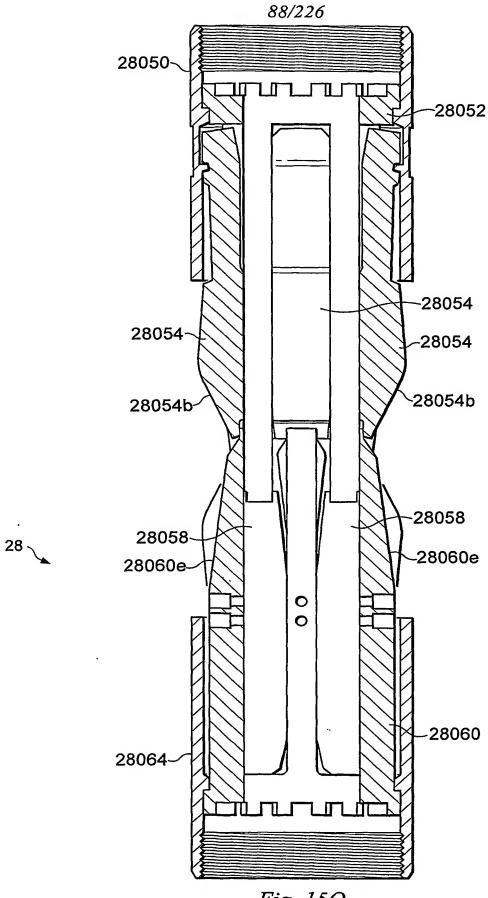
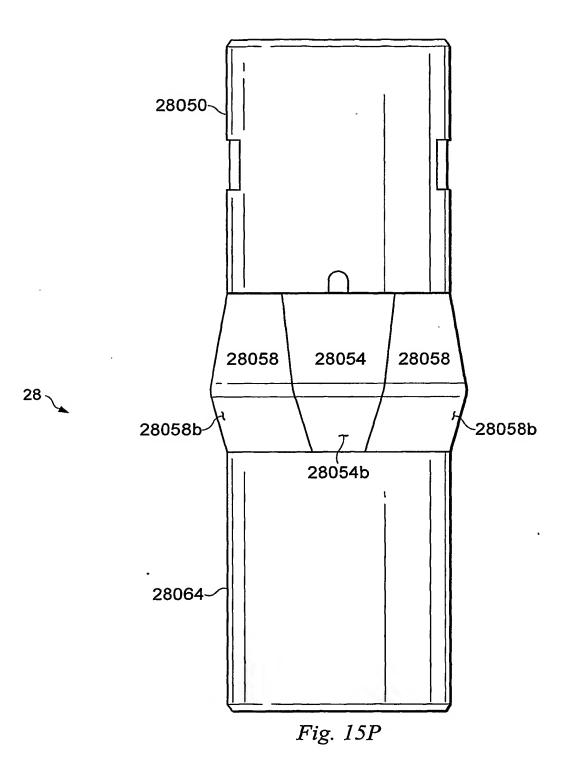
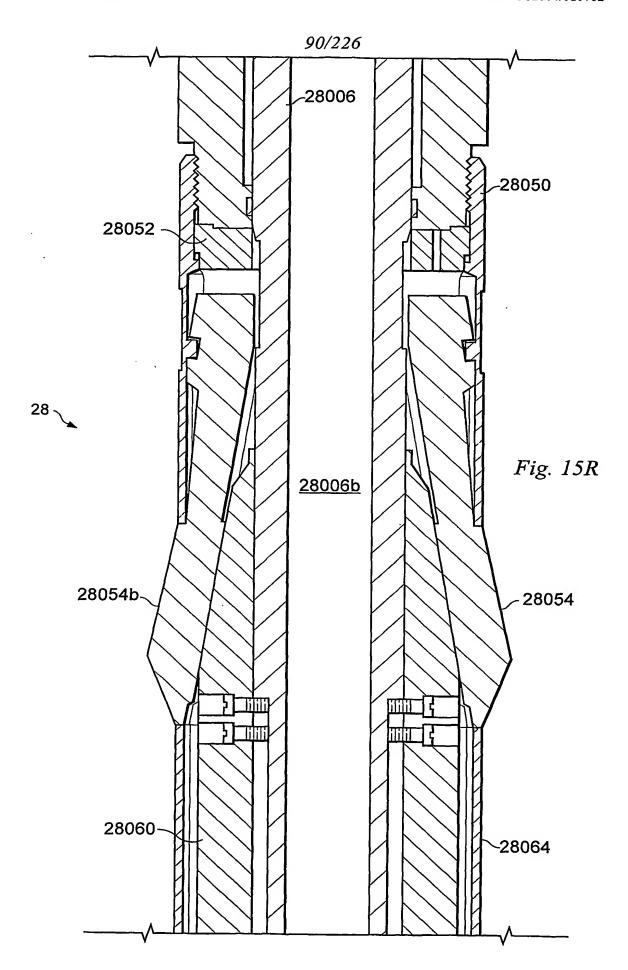


Fig. 150



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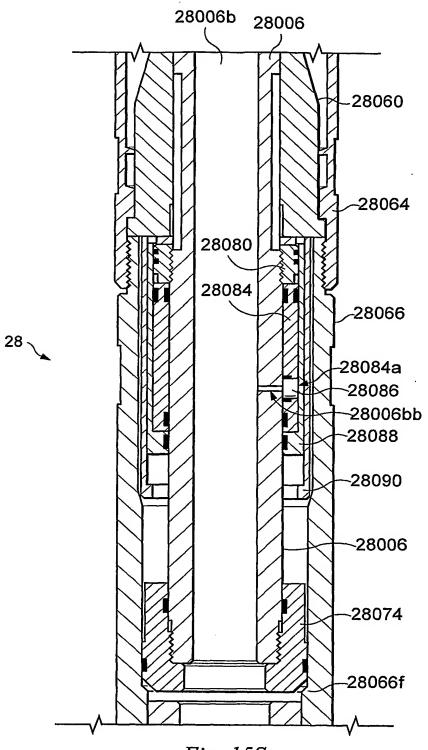


Fig. 15S

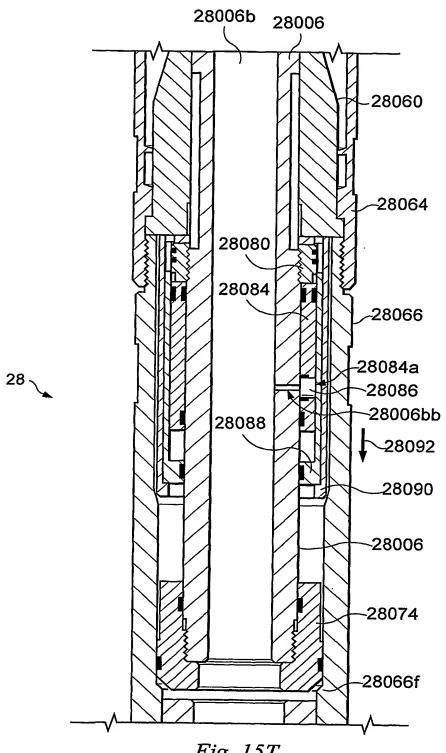
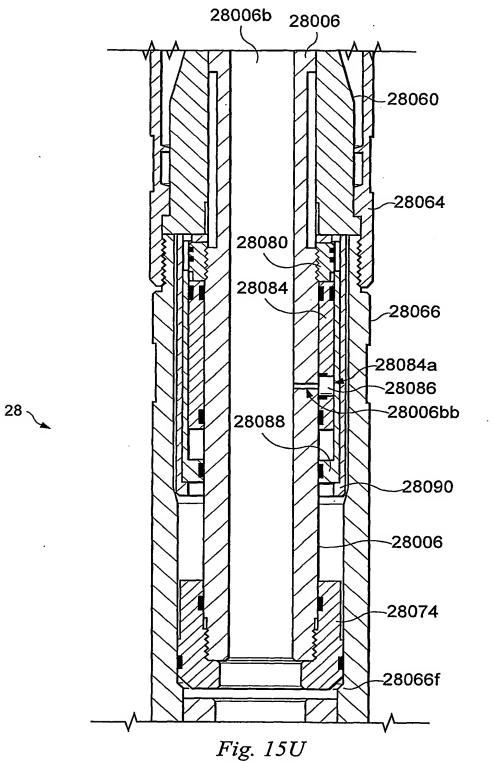
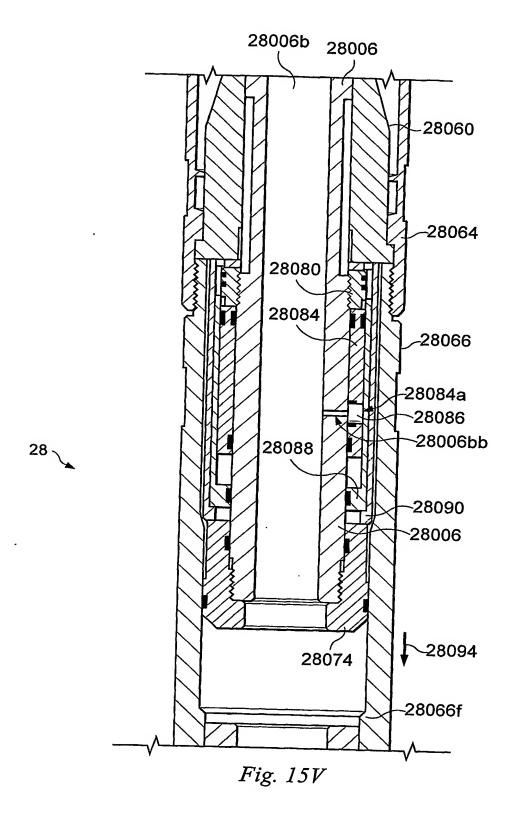
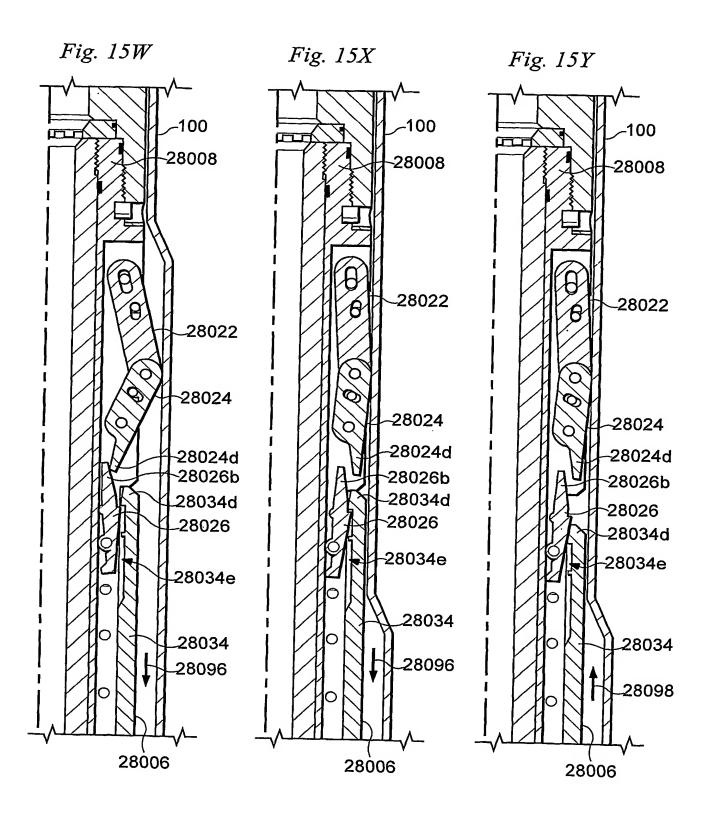
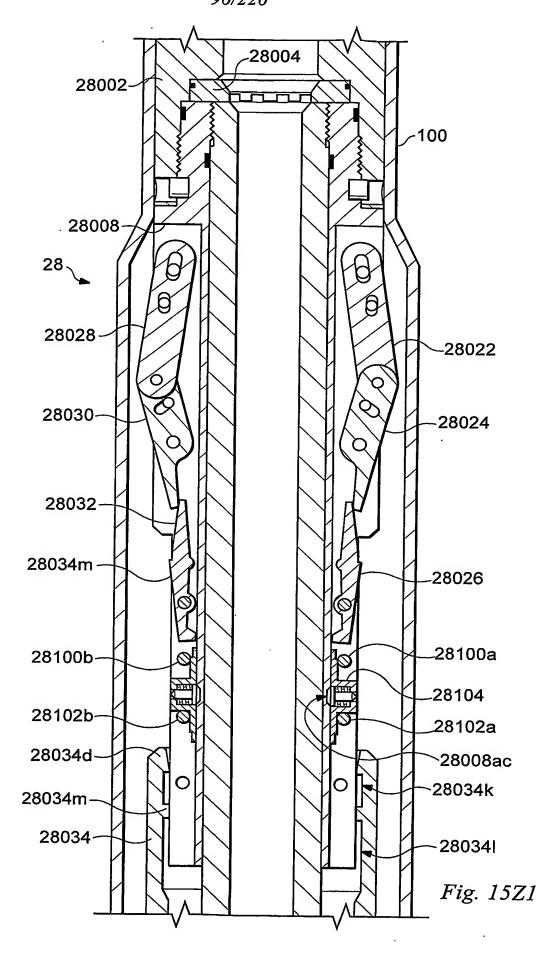


Fig. 15T









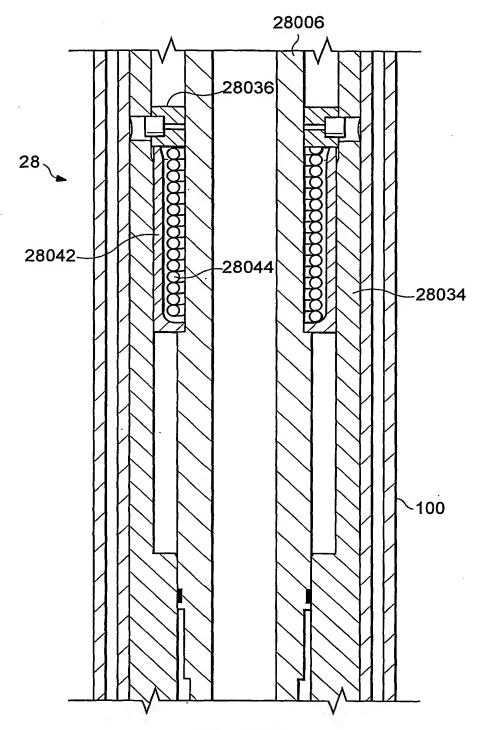


Fig. 15Z2

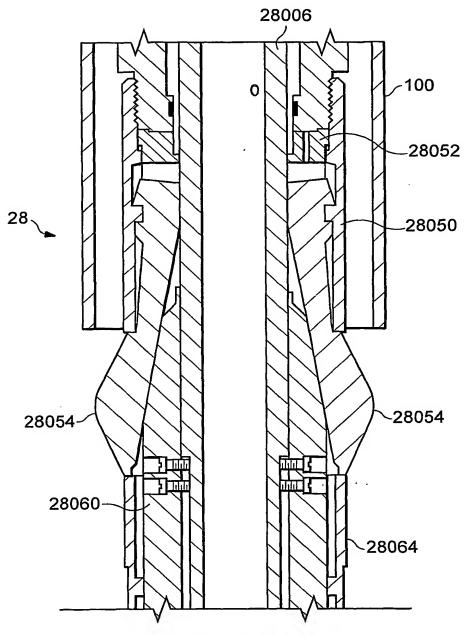


Fig. 15Z3

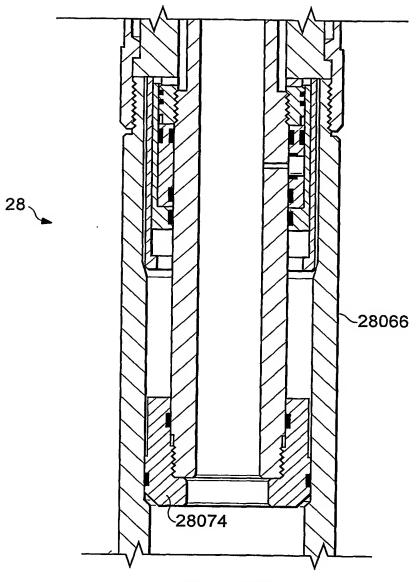


Fig. 15Z4

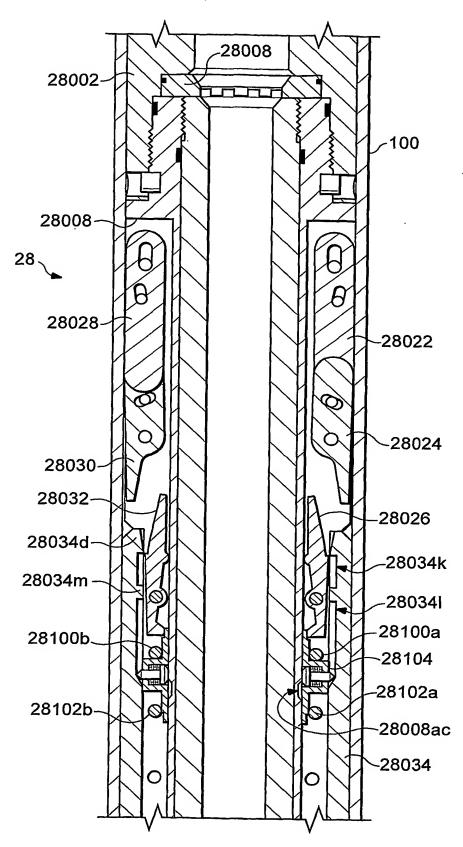


Fig. 15AA1

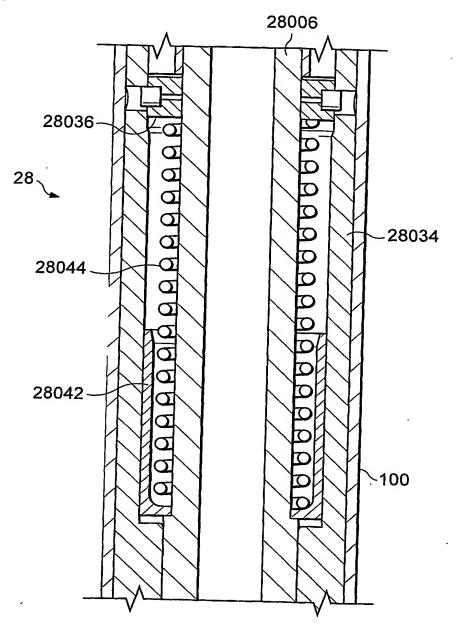


Fig. 15AA2



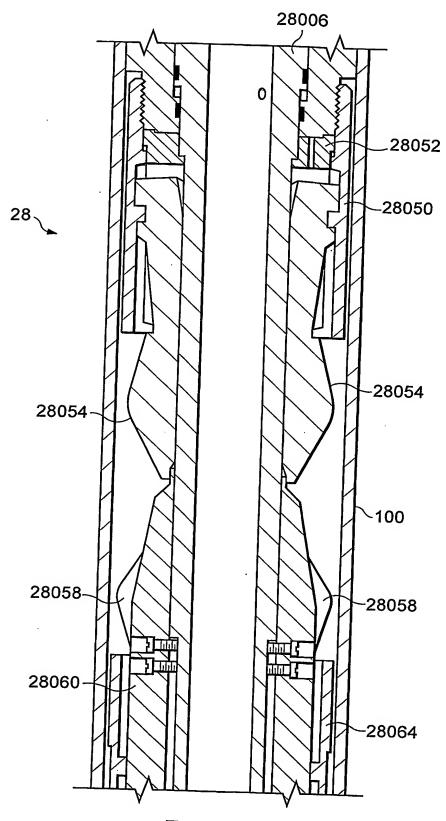


Fig. 15AA3

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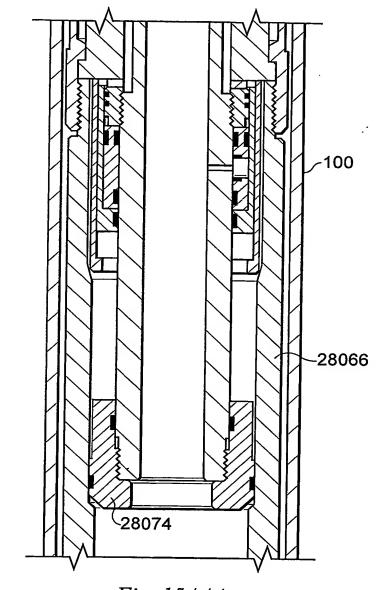


Fig. 15AA4

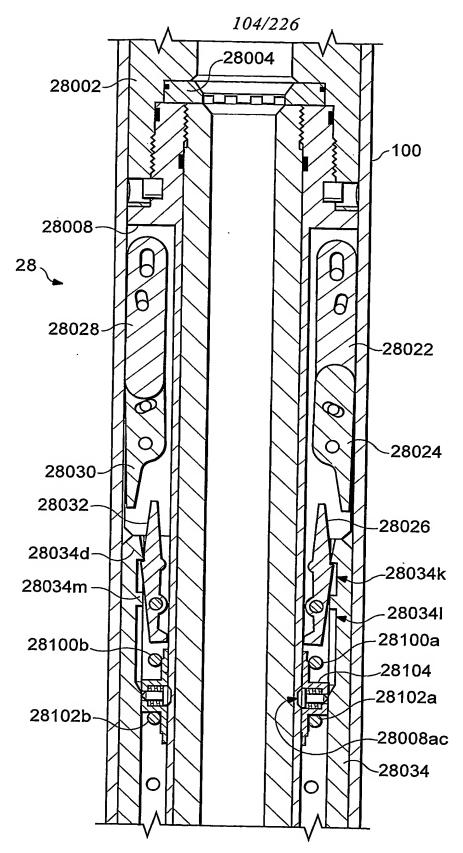


Fig. 15AB1

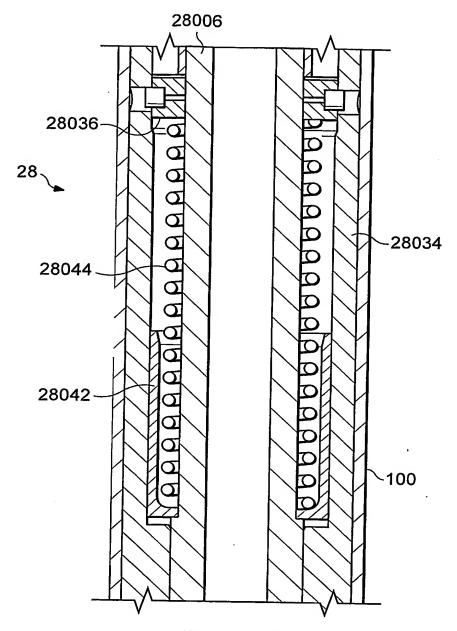


Fig. 15AB2



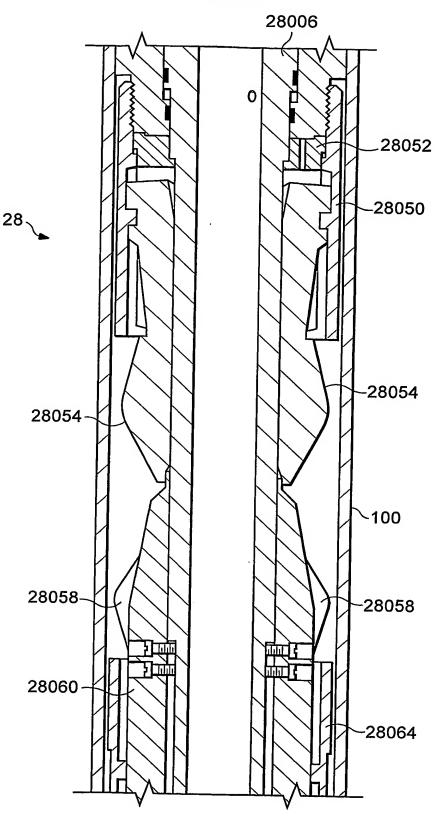


Fig. 15AB3

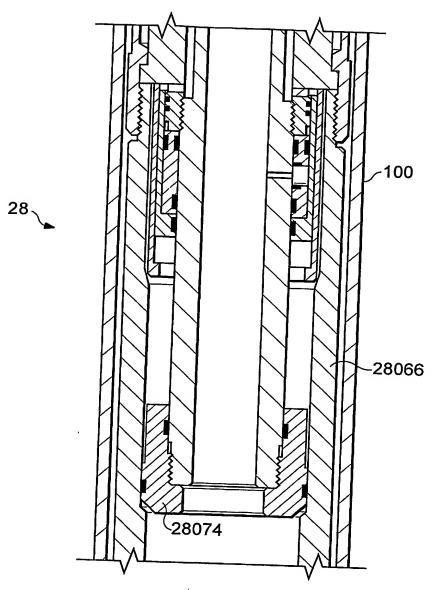
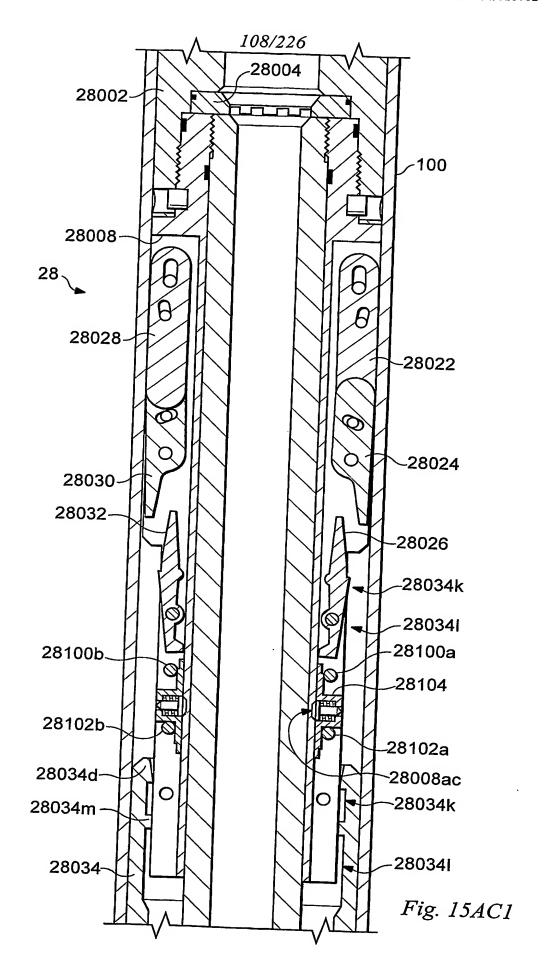


Fig. 15AB4



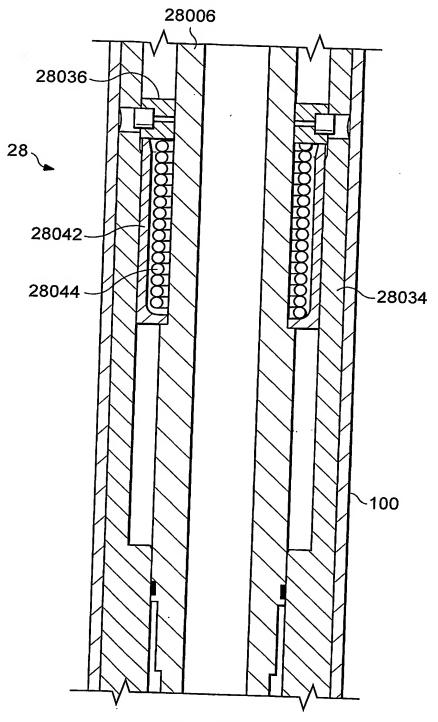


Fig. 15AC2

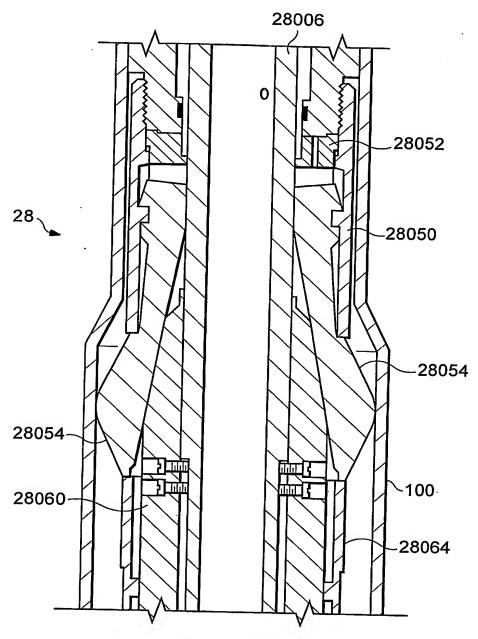


Fig. 15AC3

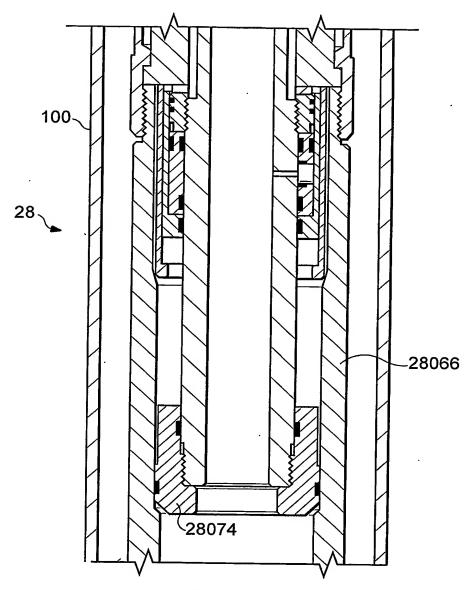


Fig. 15AC4

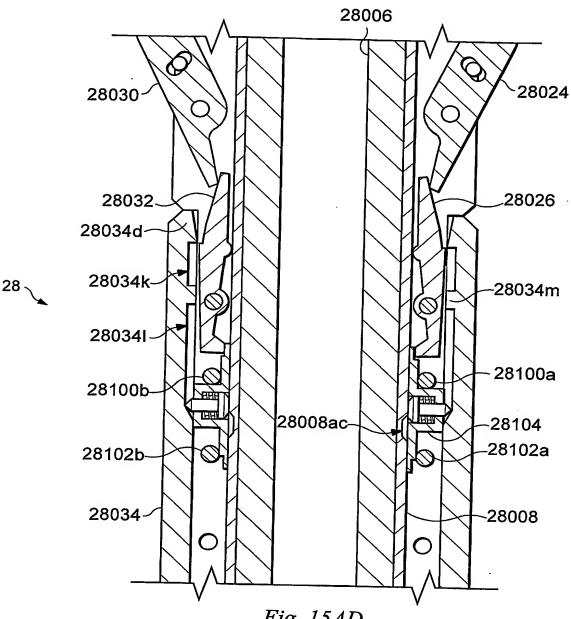
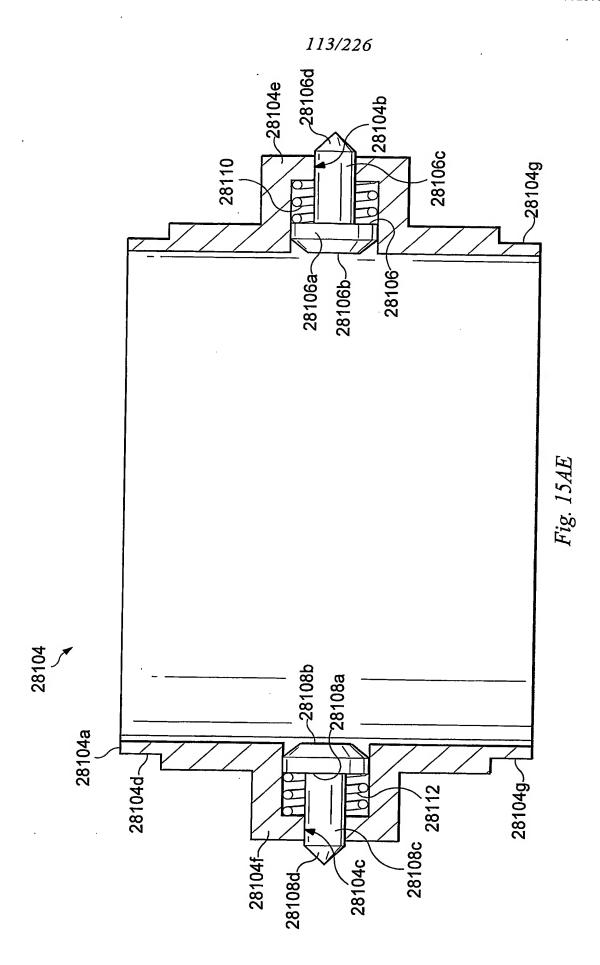
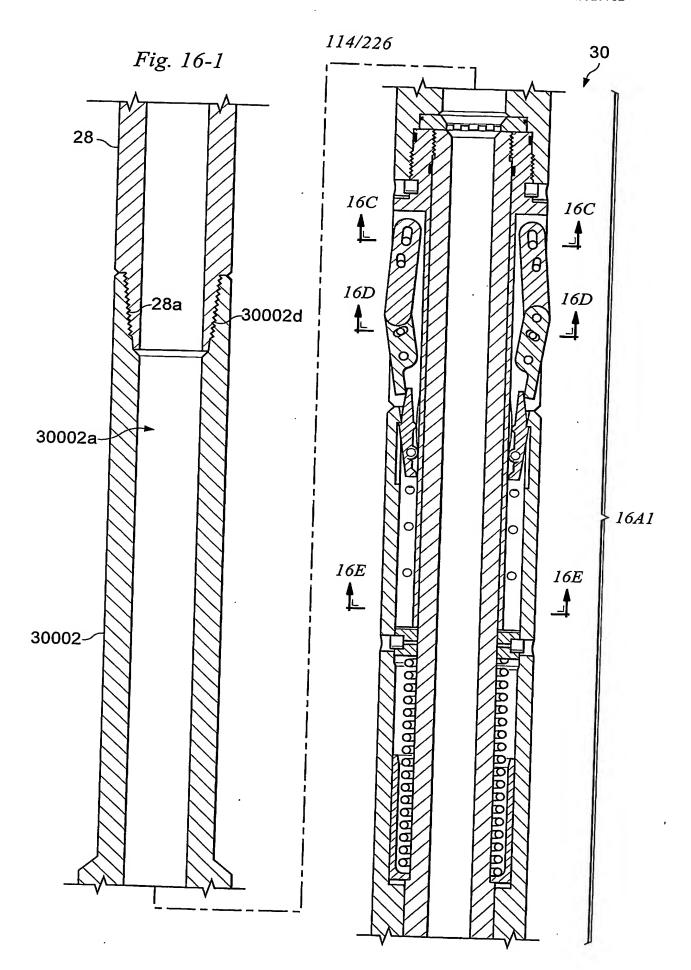
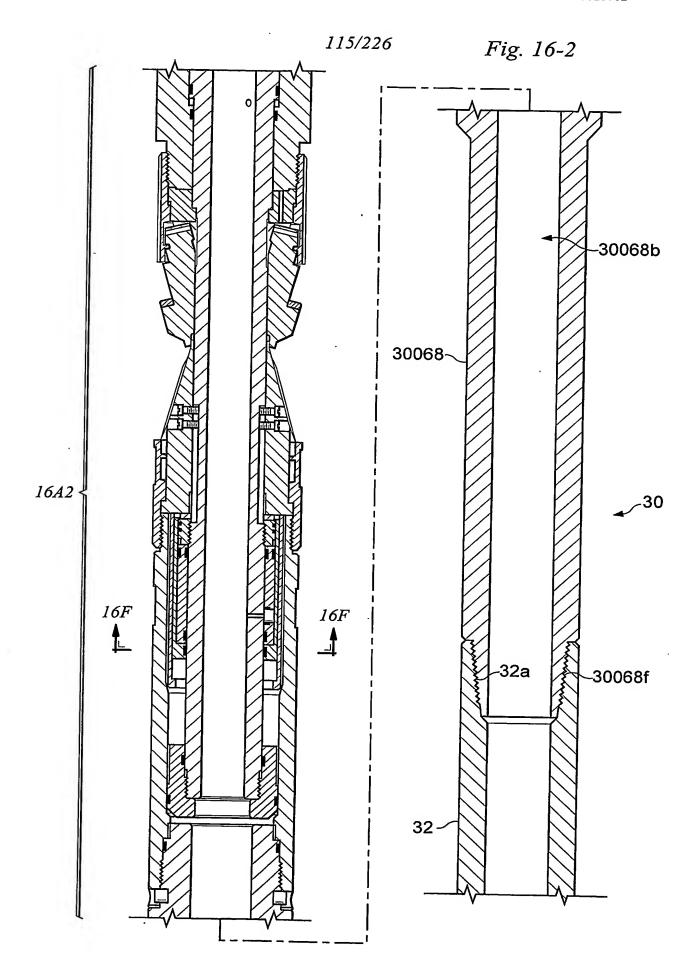
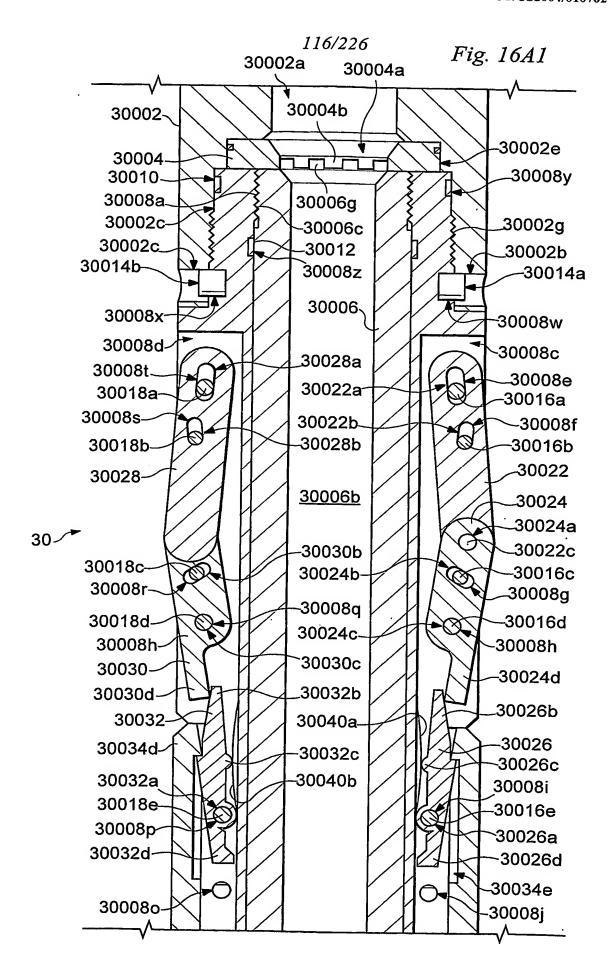


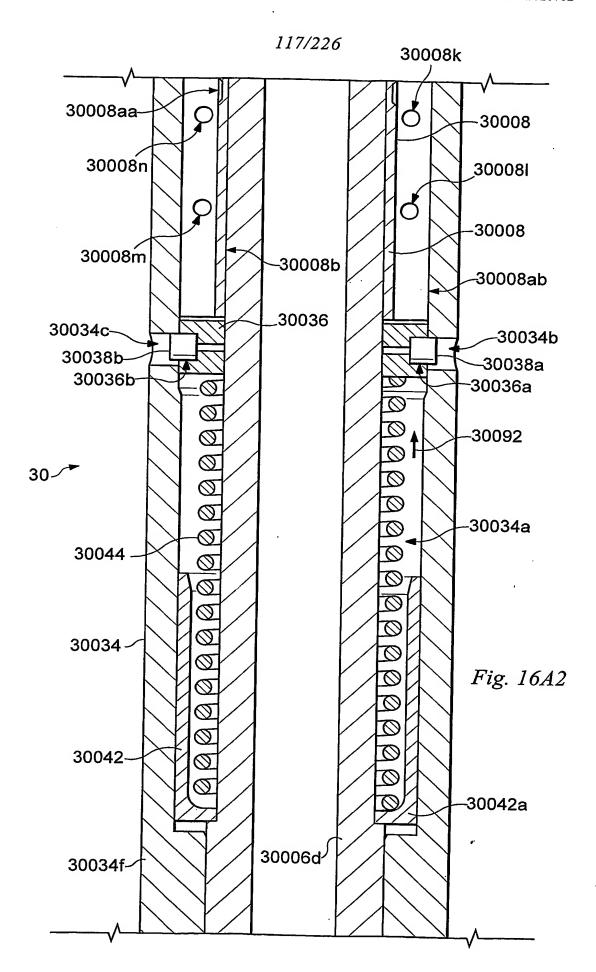
Fig. 15AD

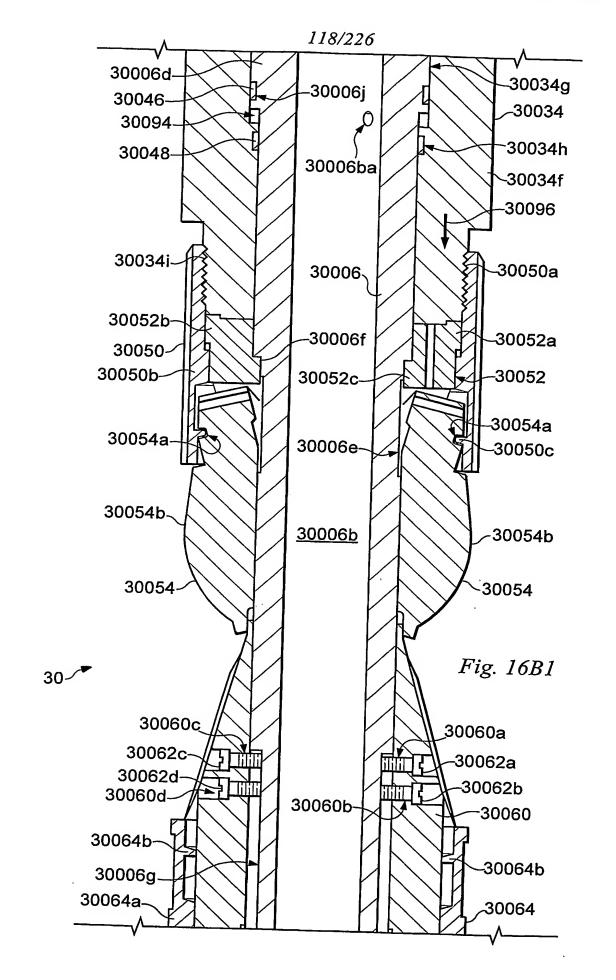


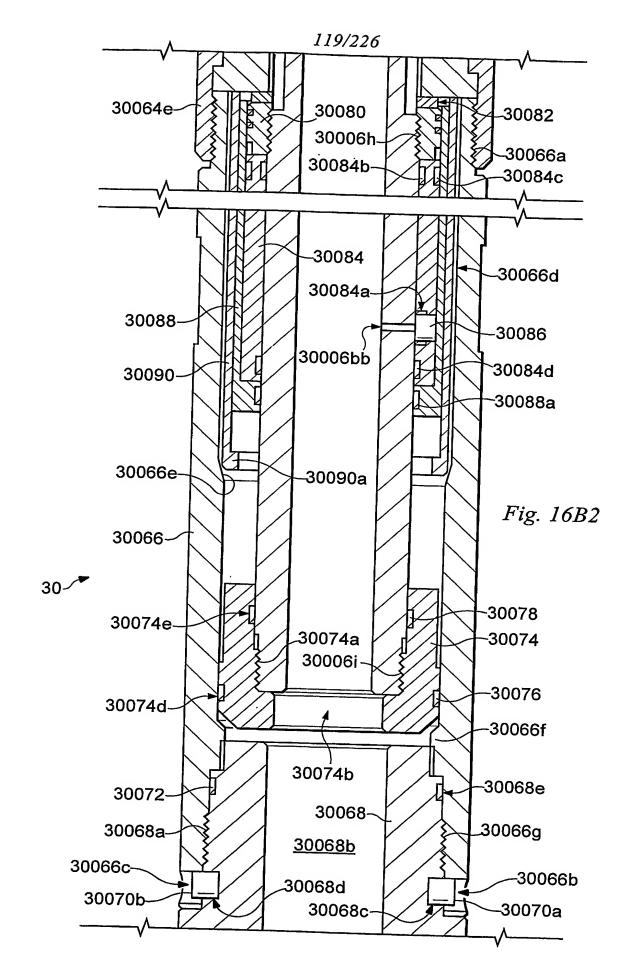


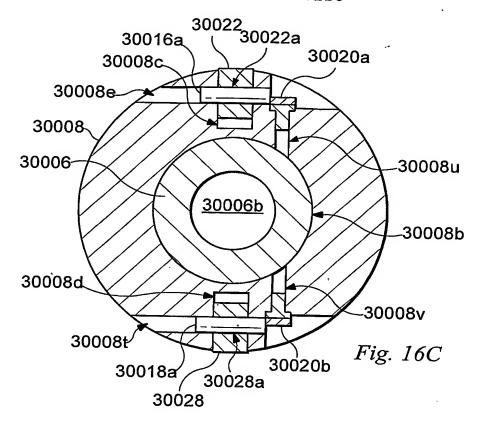


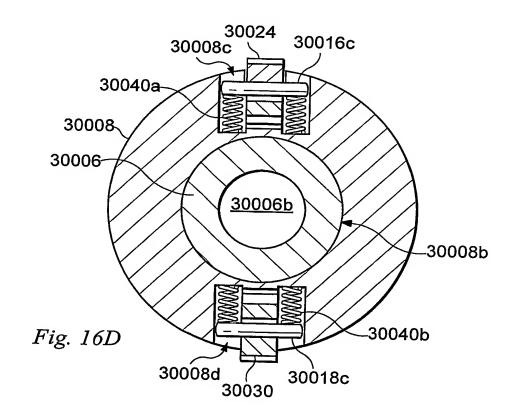












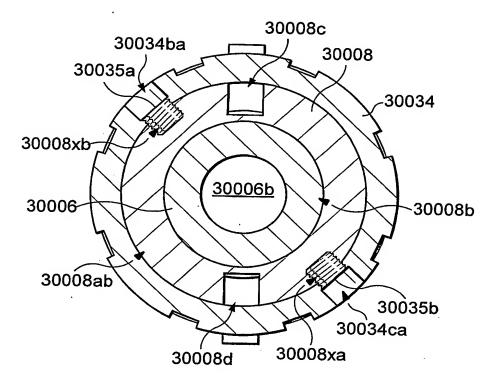


Fig. 16E

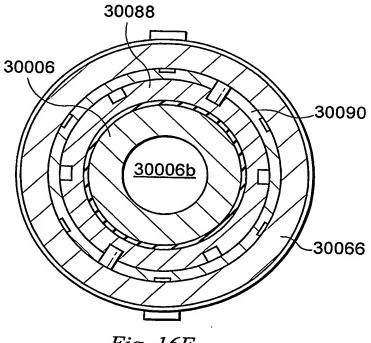
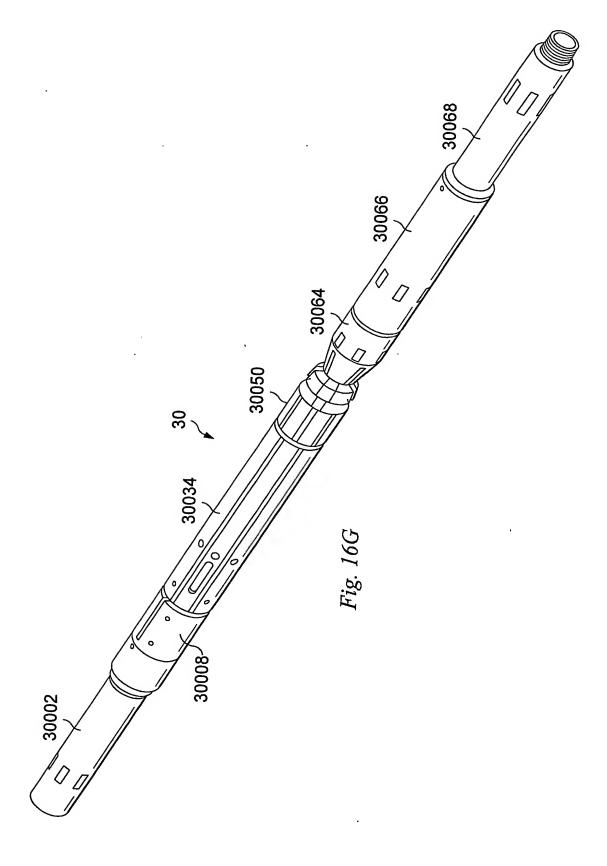


Fig. 16F



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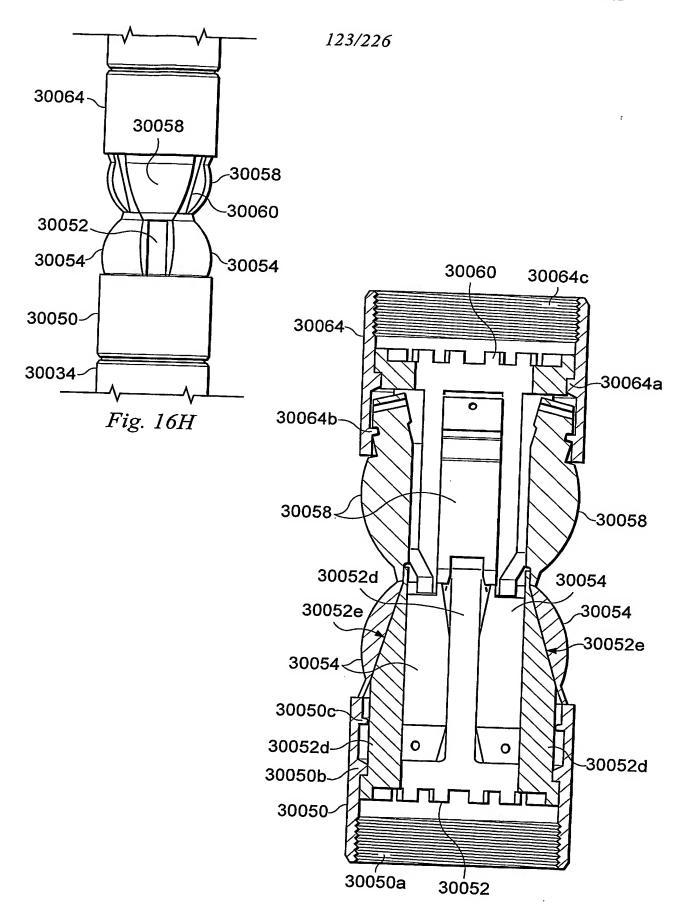
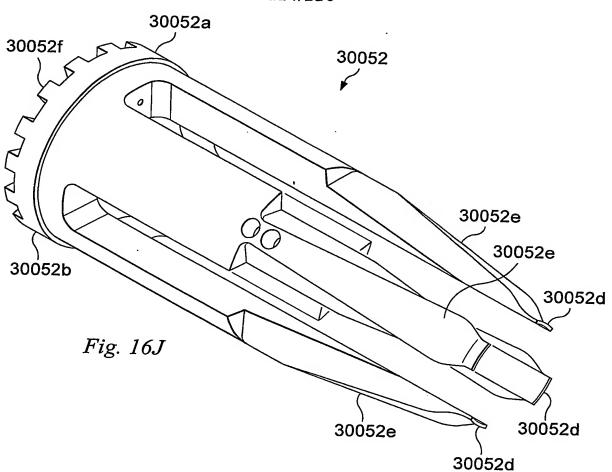
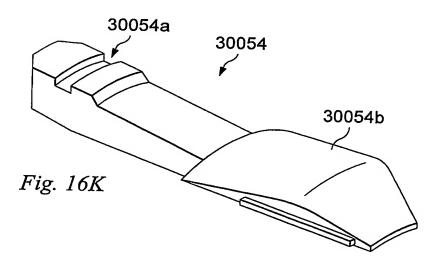


FIG. 16I





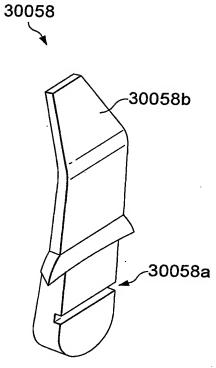


Fig. 16L

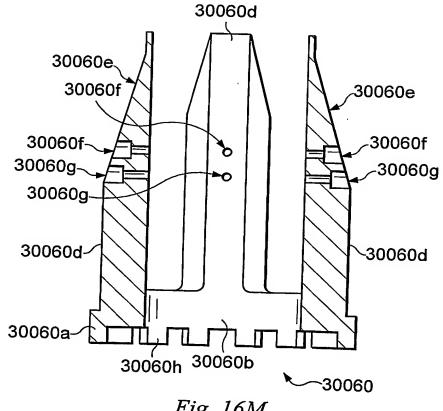
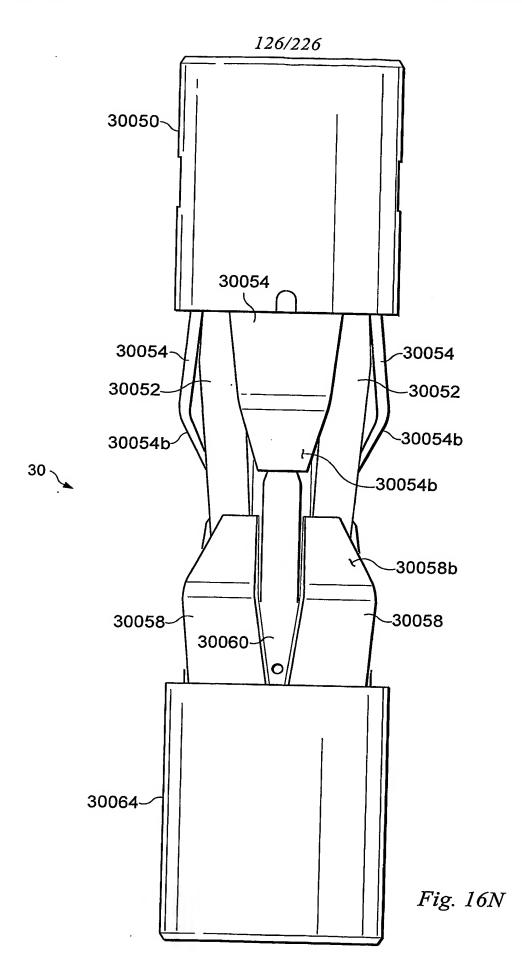


Fig. 16M



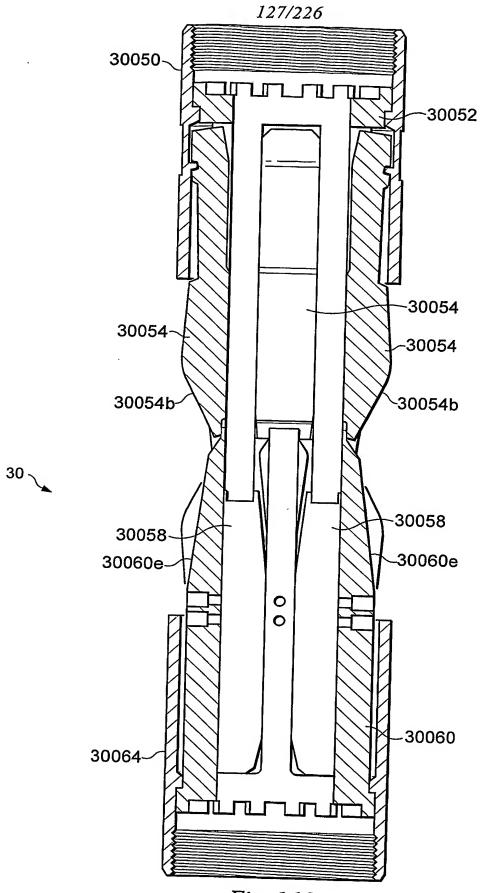
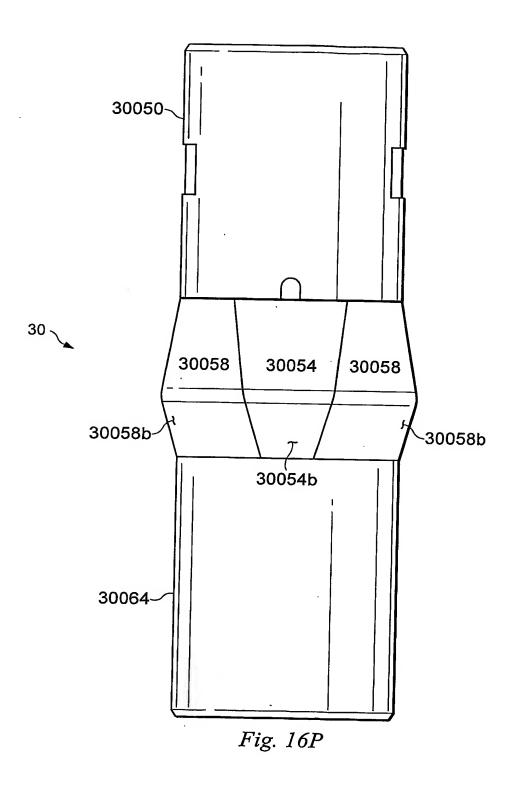
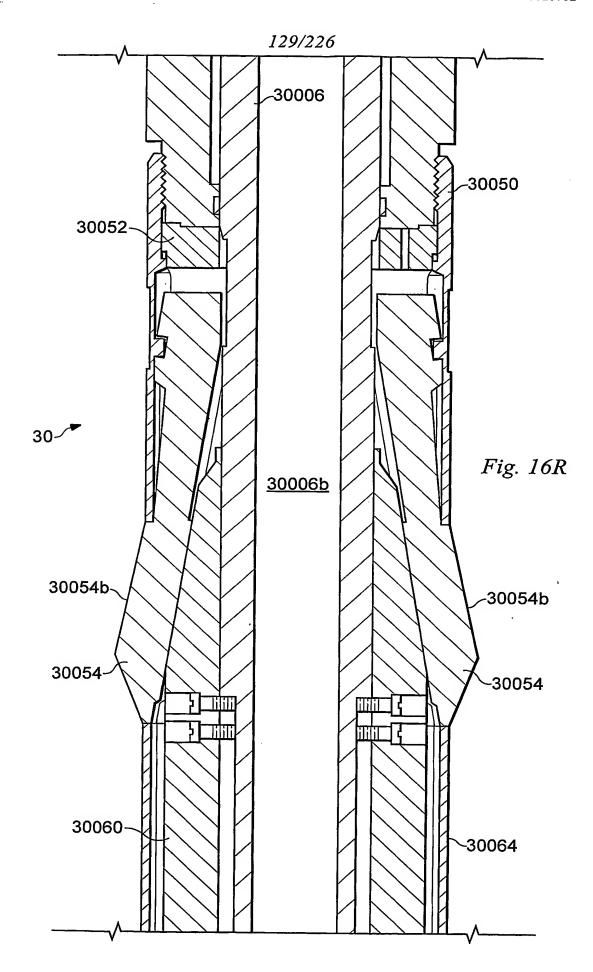


Fig. 160





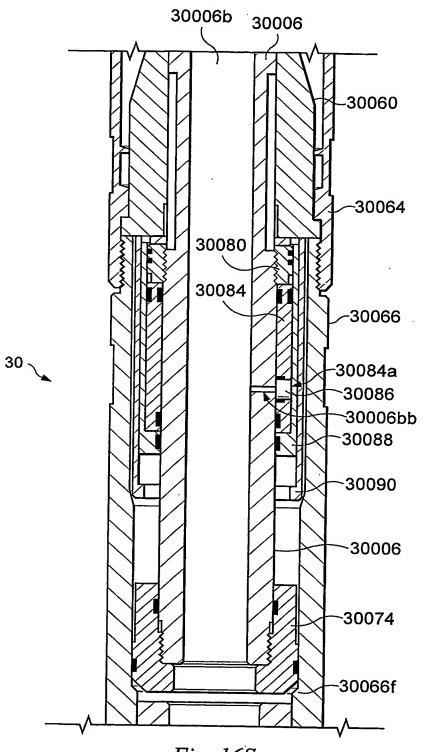


Fig. 16S

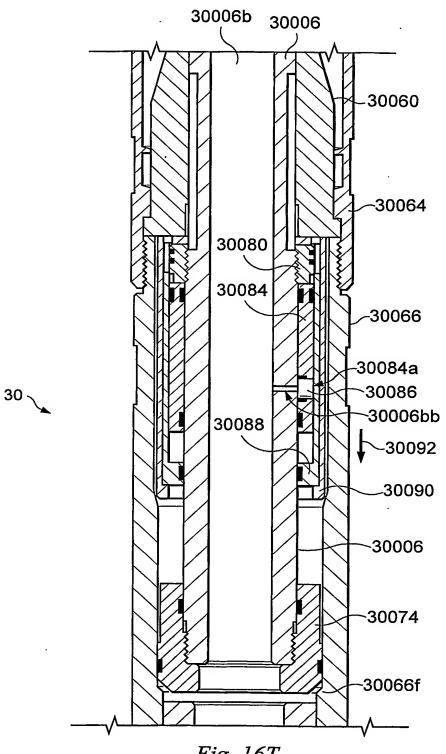


Fig. 16T

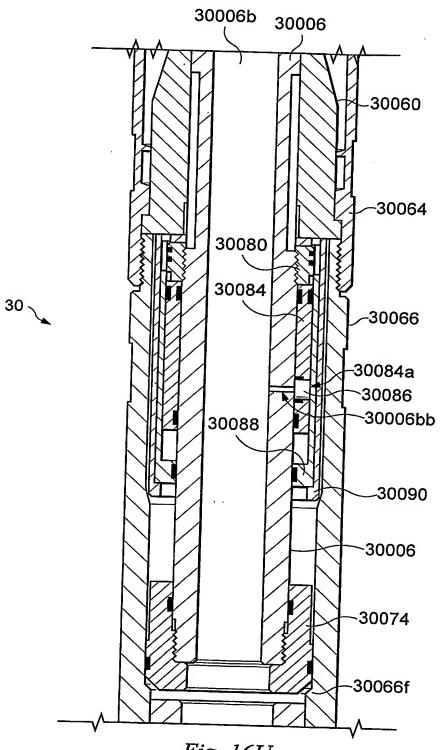
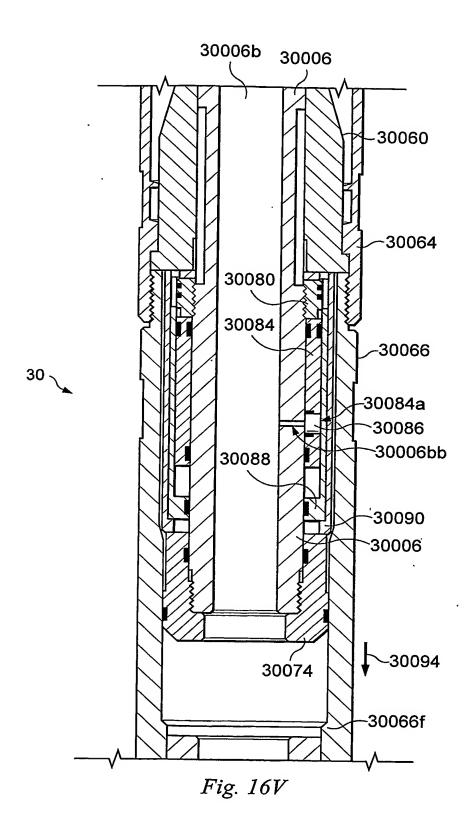
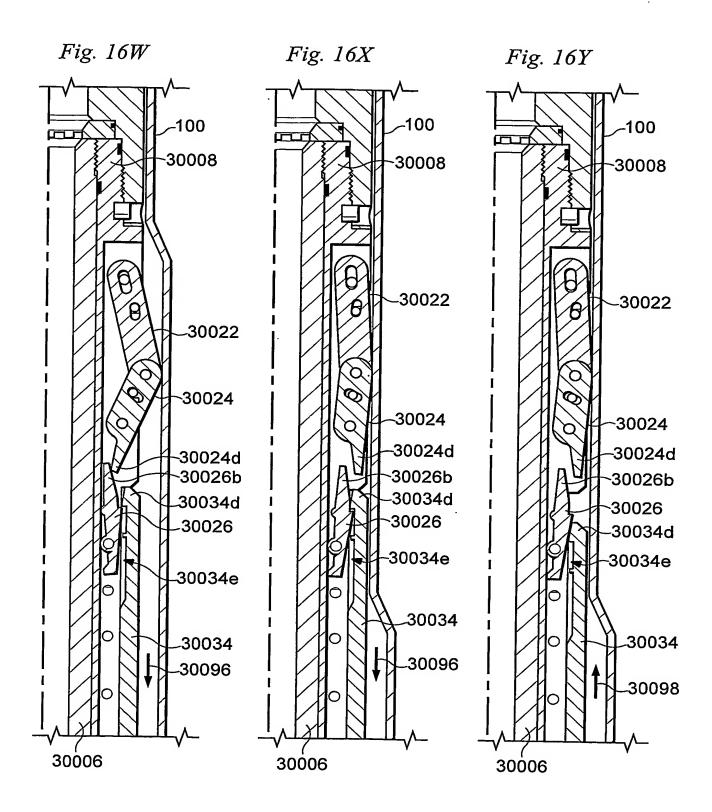
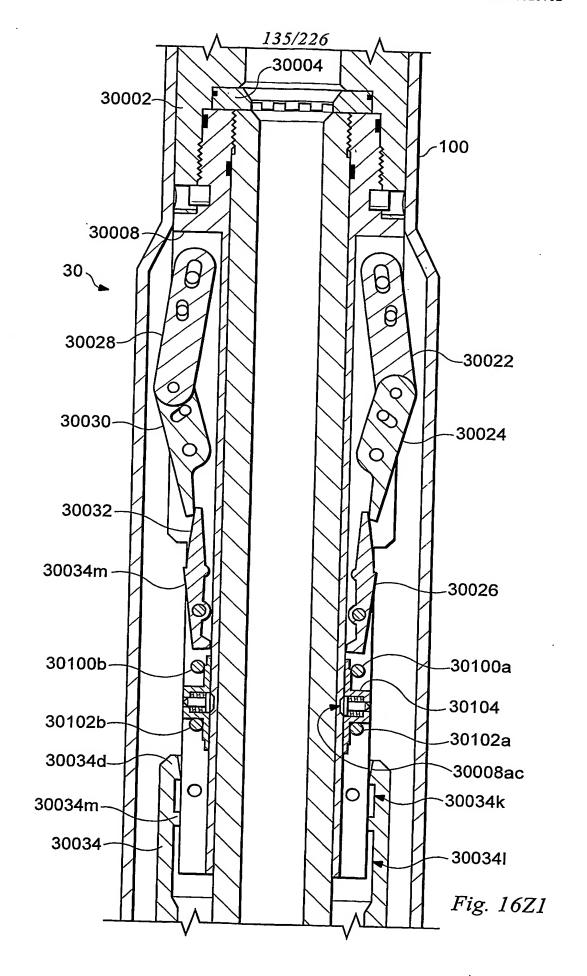


Fig. 16U





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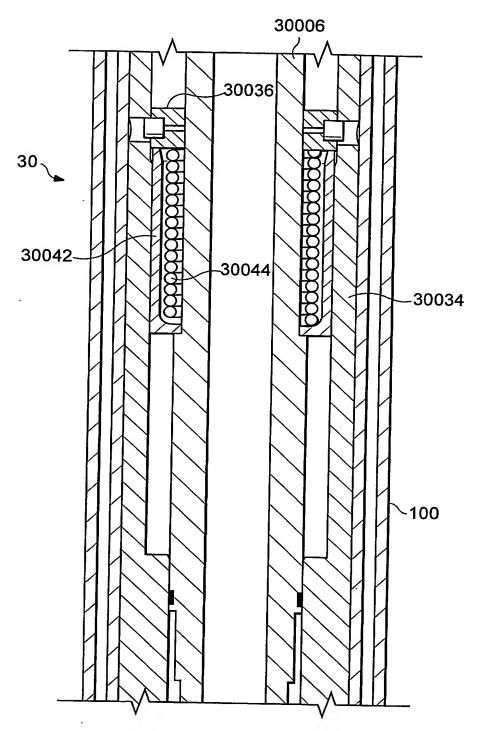


Fig. 16Z2

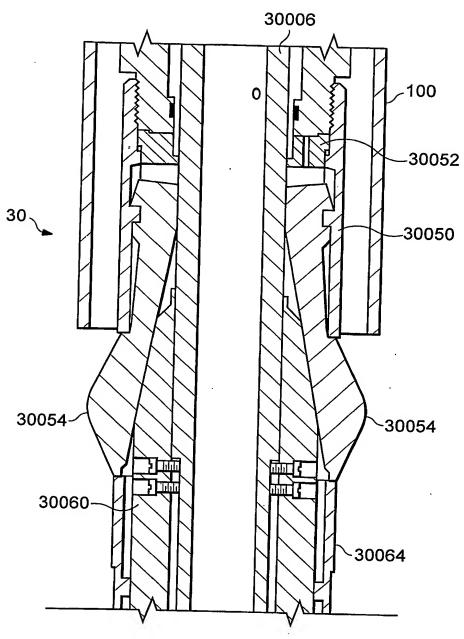


Fig. 16Z3

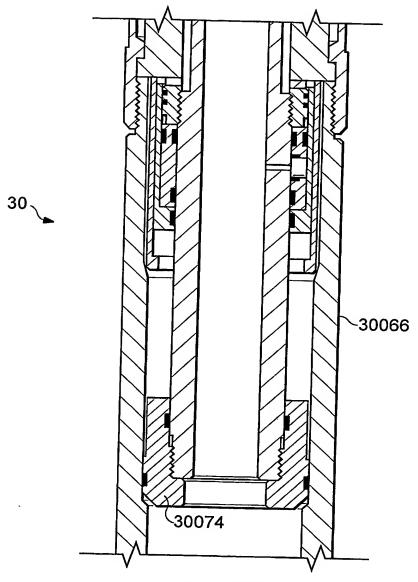


Fig. 16Z4

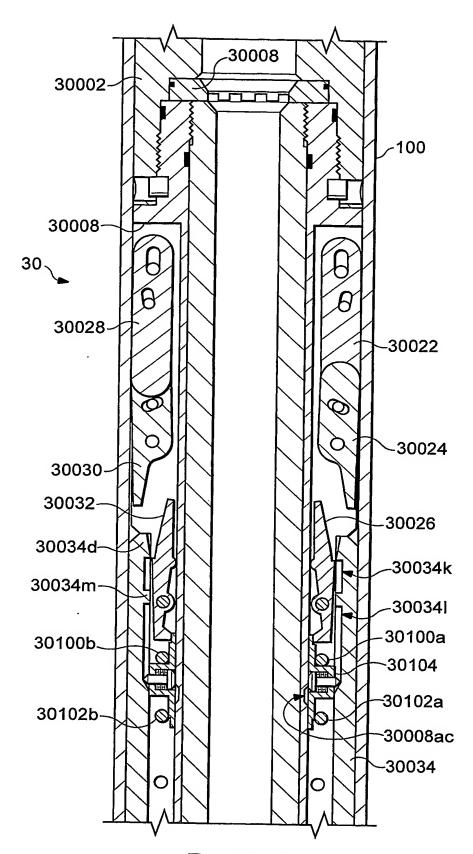


Fig. 16AA1

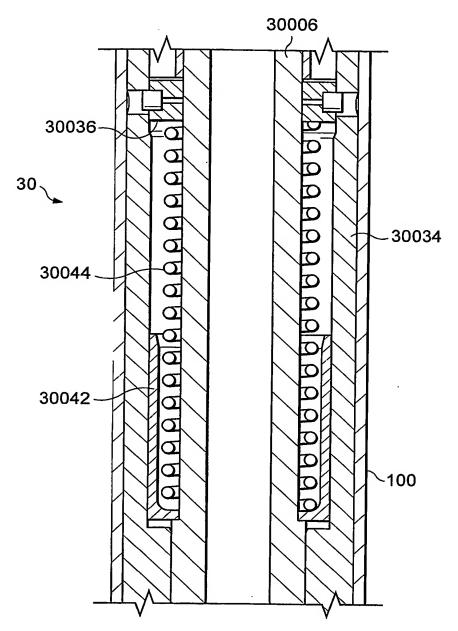


Fig. 16AA2

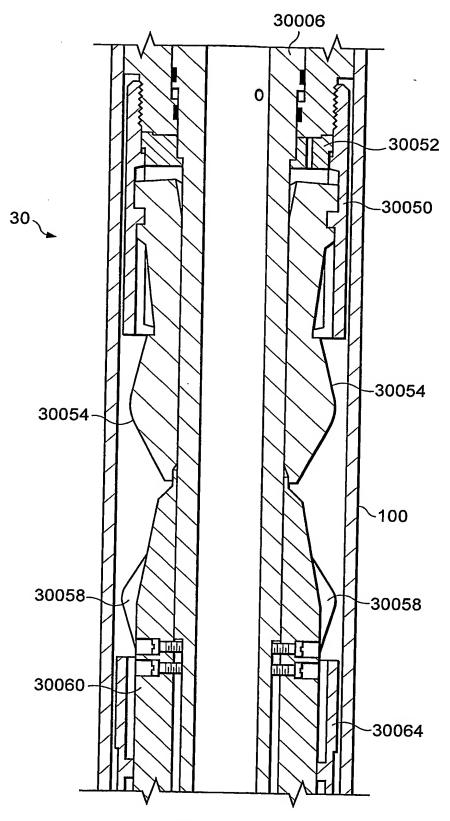


Fig. 16AA3

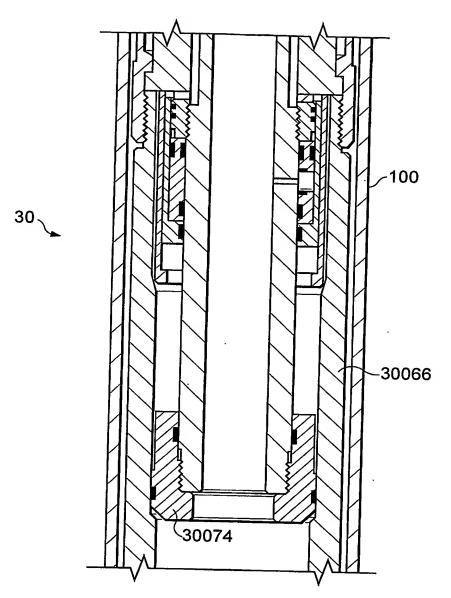


Fig. 16AA4

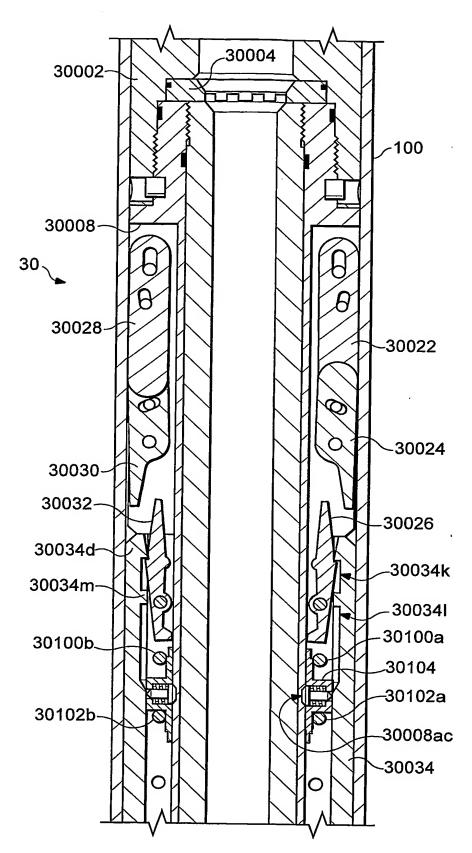


Fig. 16AB1

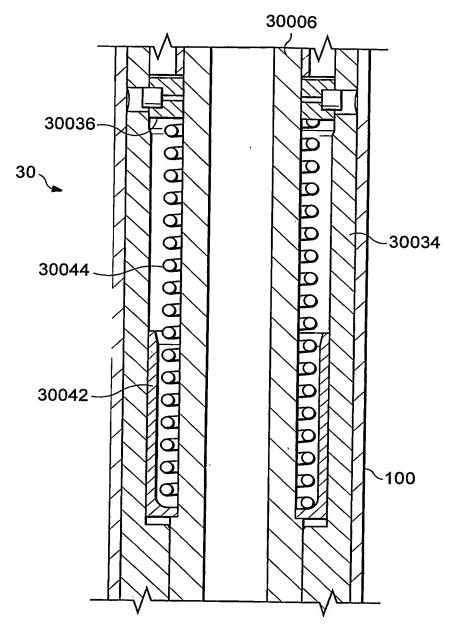


Fig. 16AB2



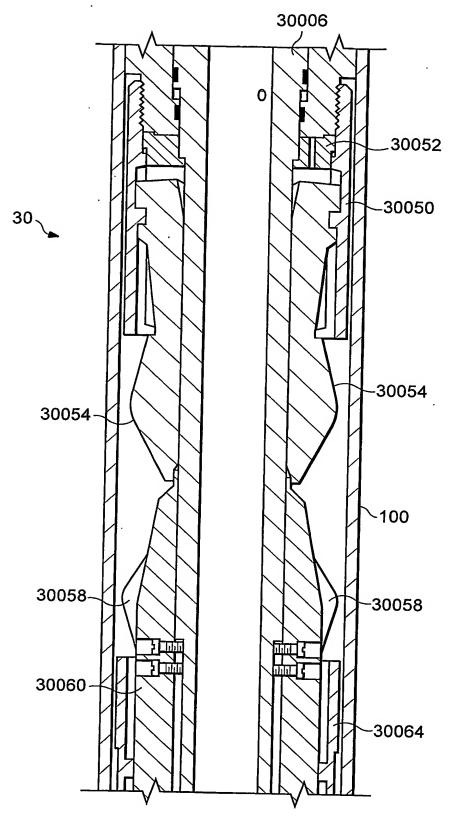


Fig. 16AB3

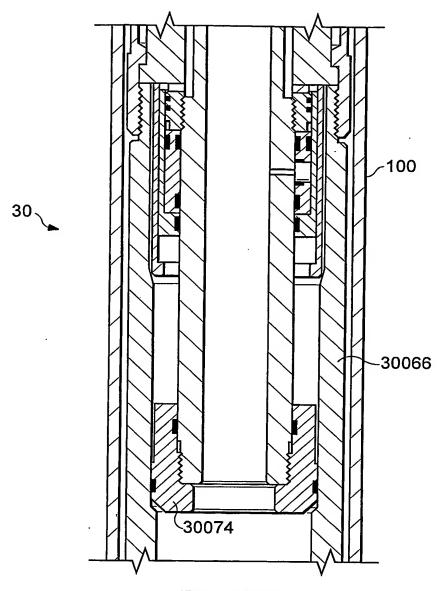
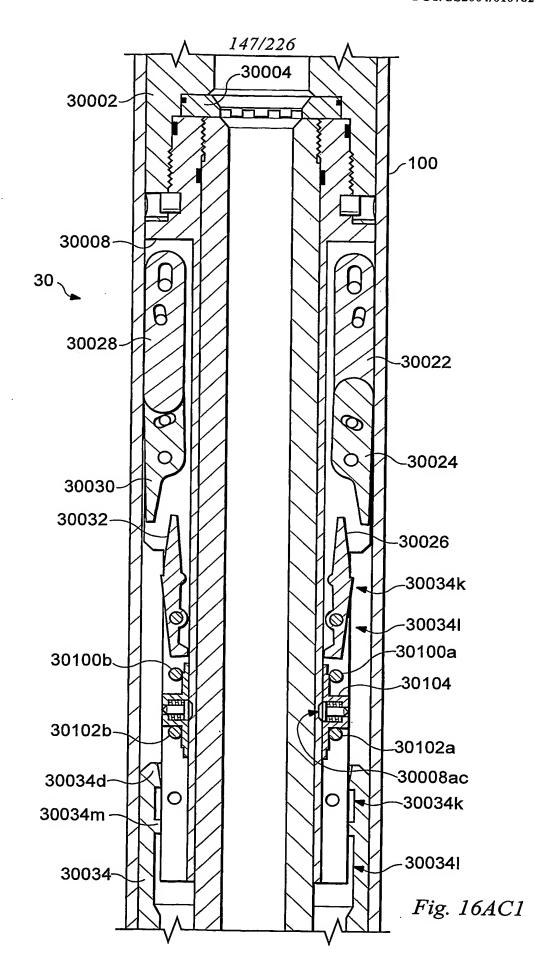


Fig. 16AB4



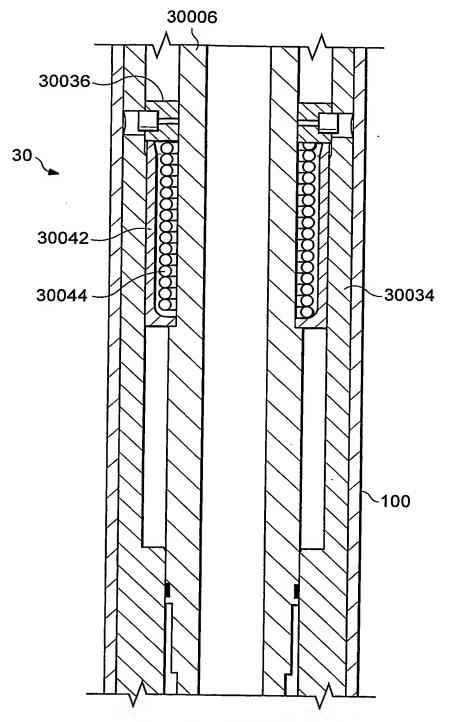


Fig. 16AC2

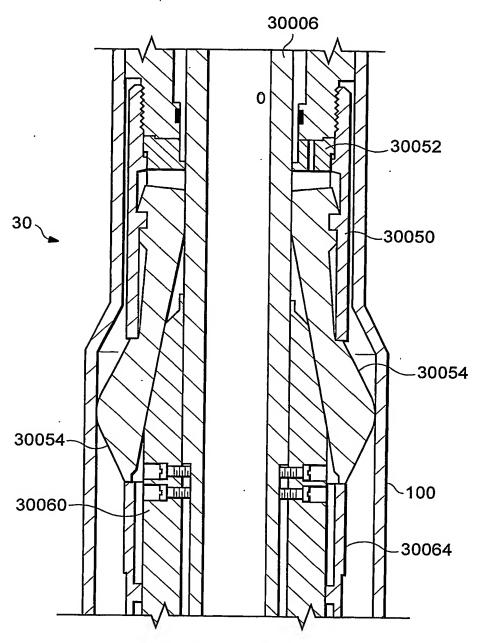


Fig. 16AC3

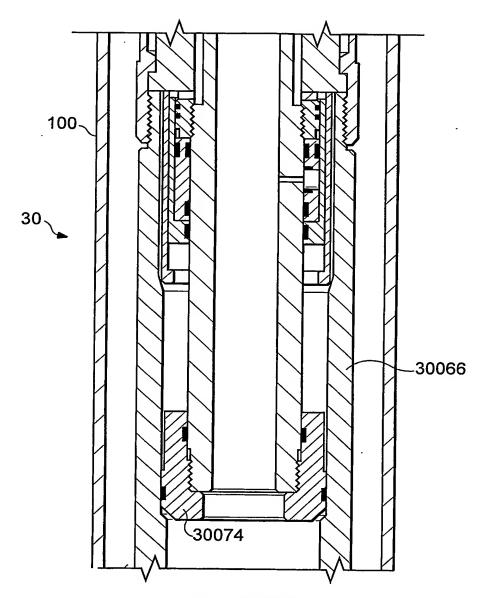


Fig. 16AC4

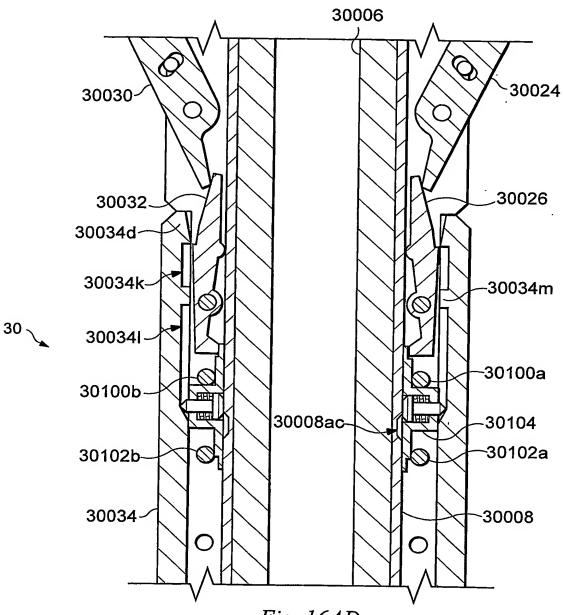
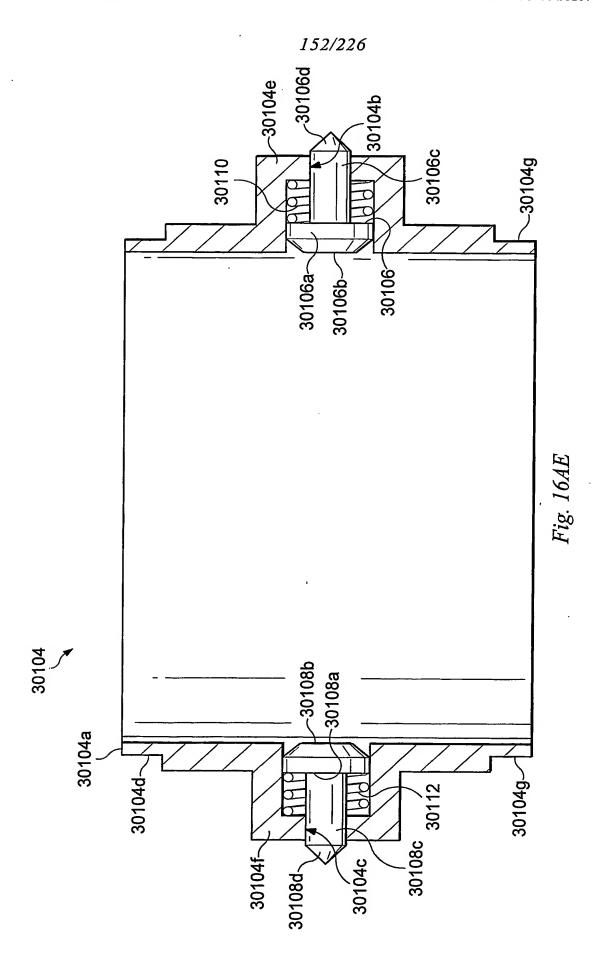


Fig. 16AD



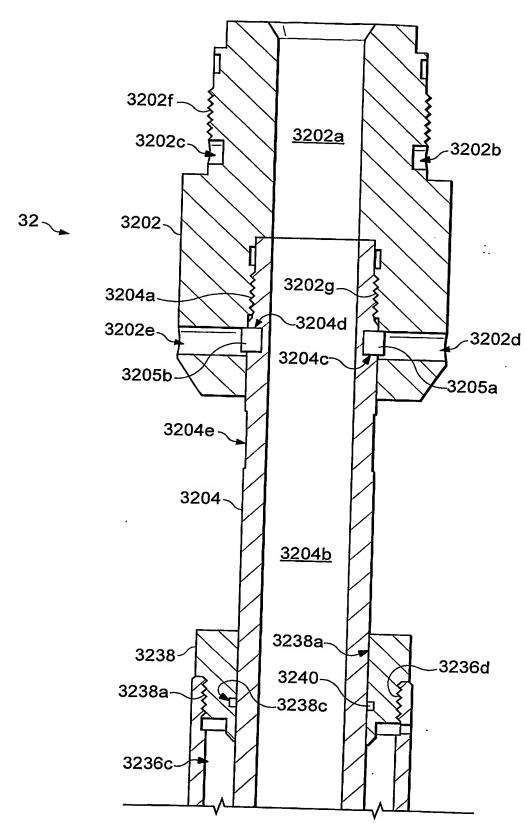


Fig. 17A

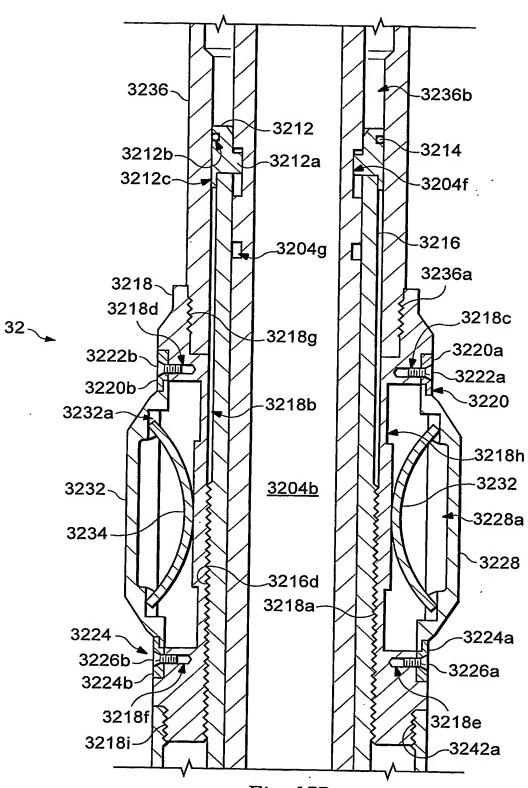
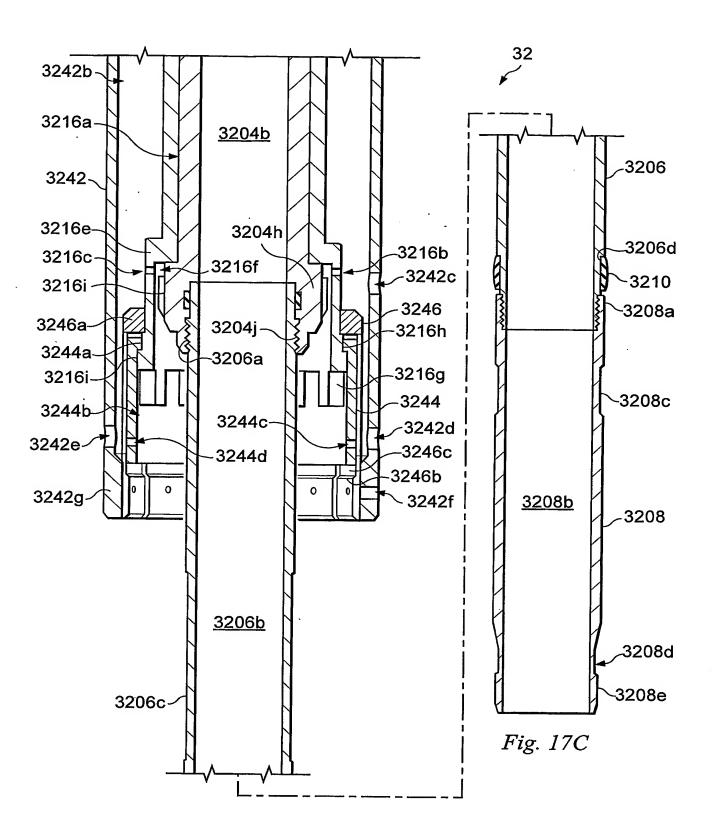


Fig. 17B



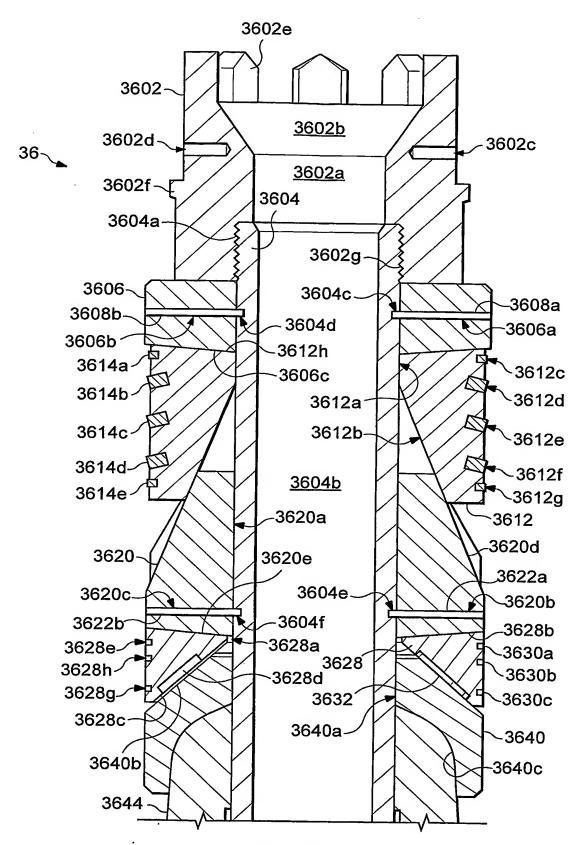


Fig. 18-1

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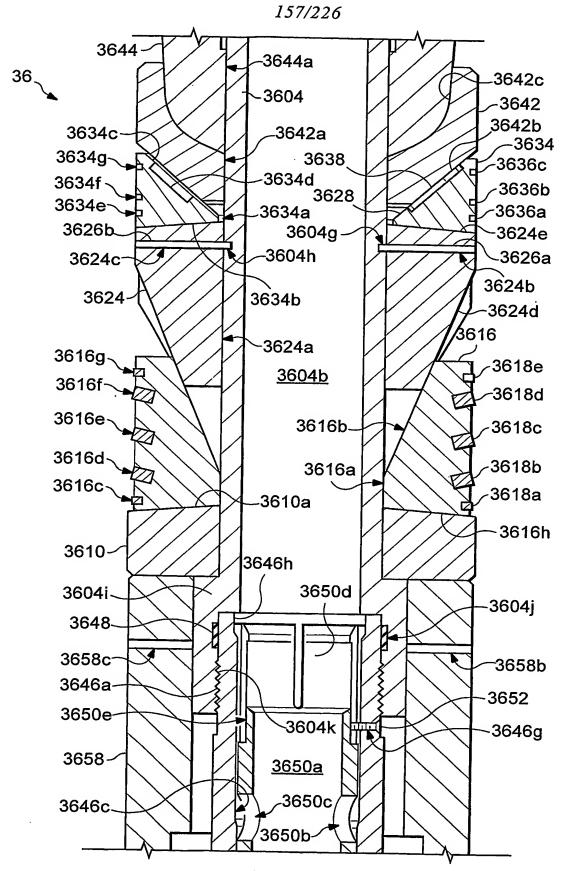


Fig. 18-2

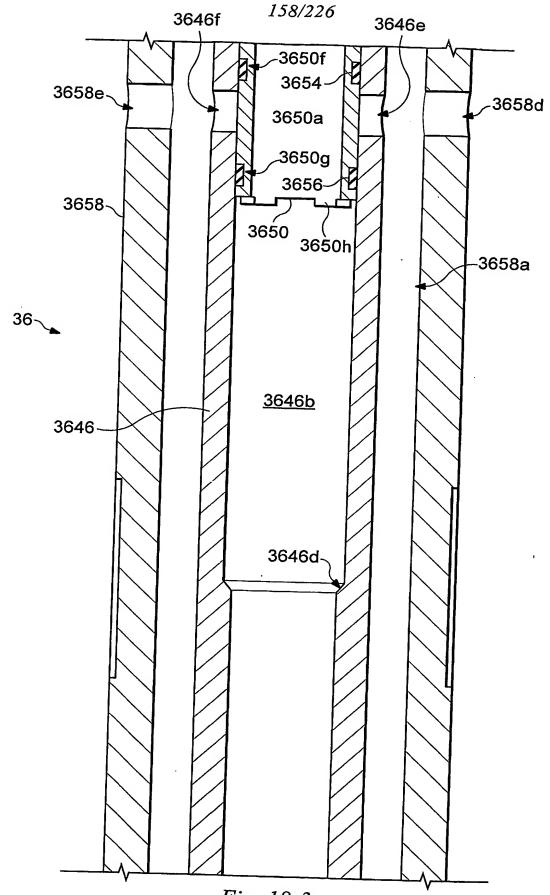
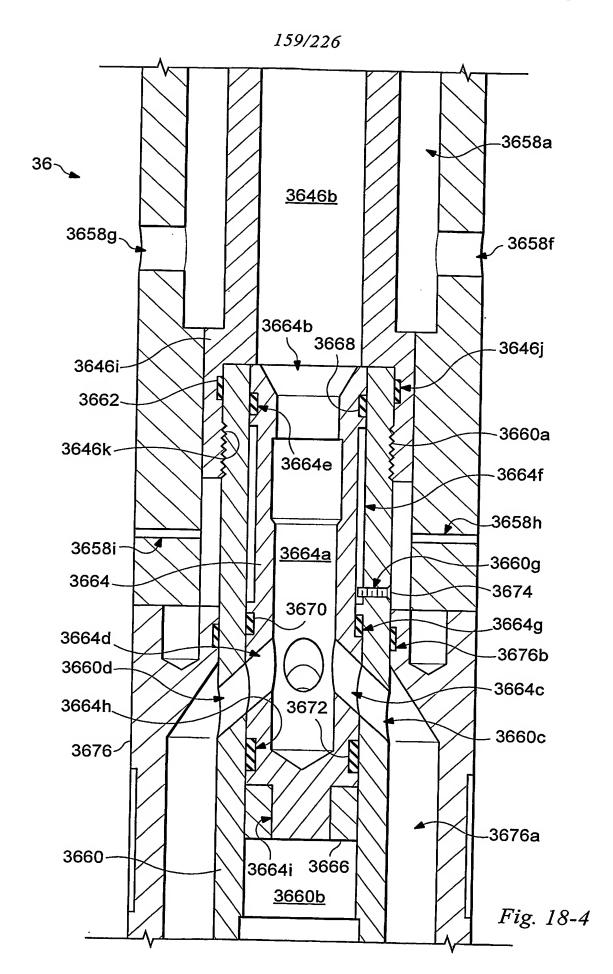
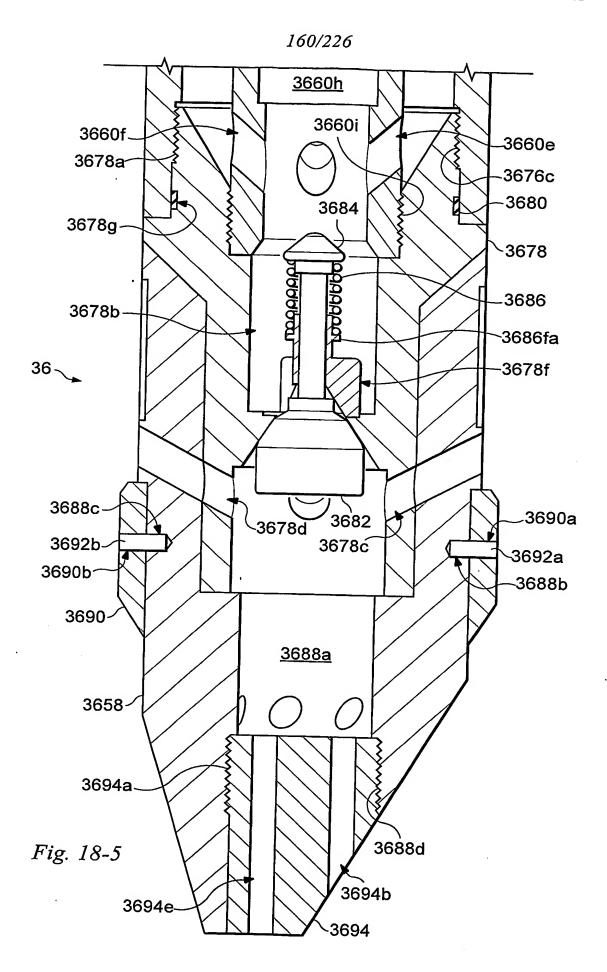


Fig. 18-3





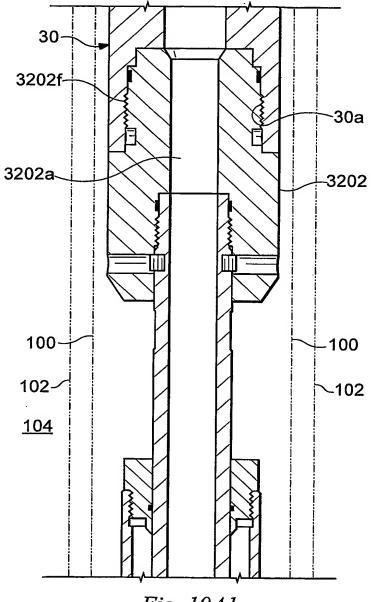


Fig. 19A1

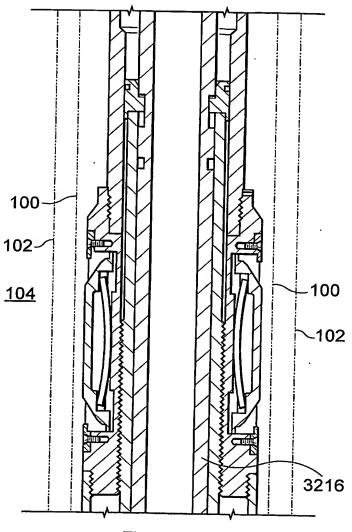


Fig. 19A2

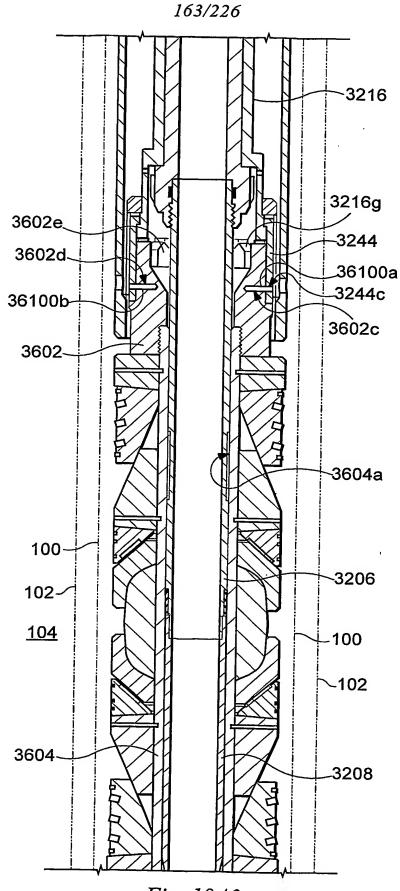


Fig. 19A3

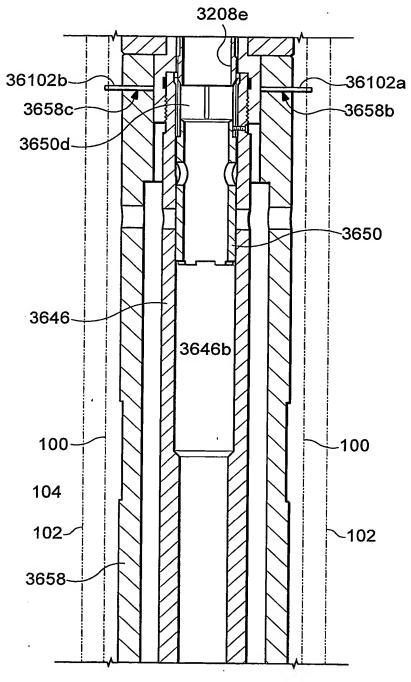
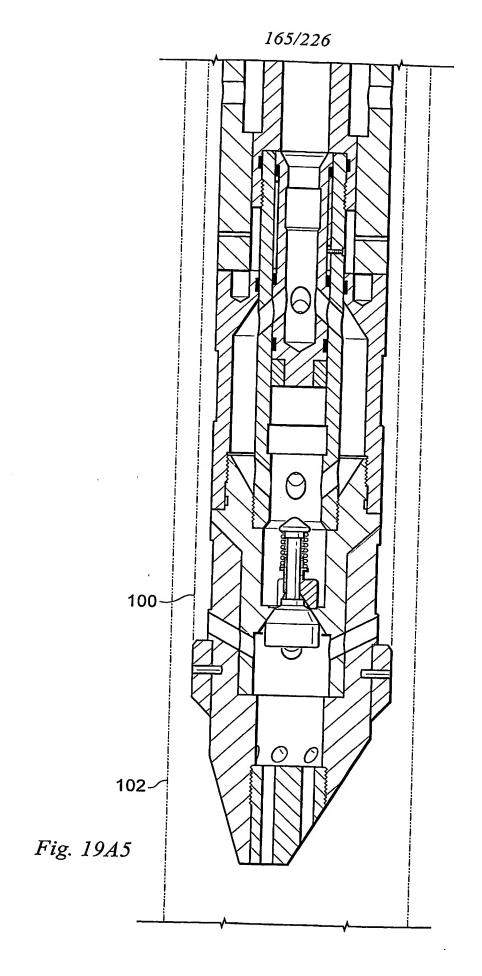


Fig. 19A4



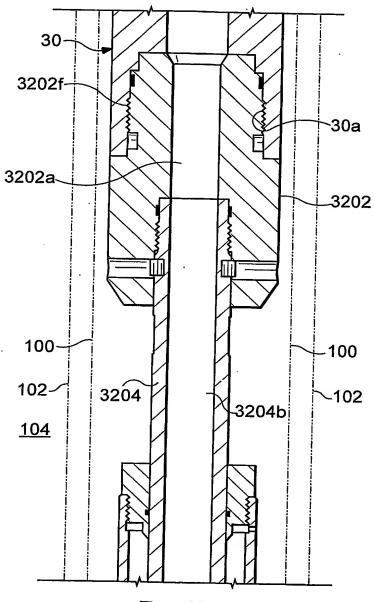


Fig. 19B1

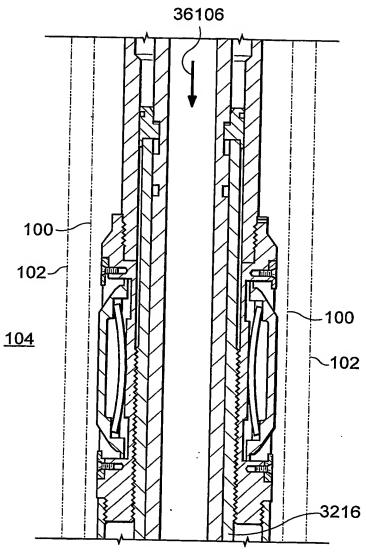


Fig. 19B2

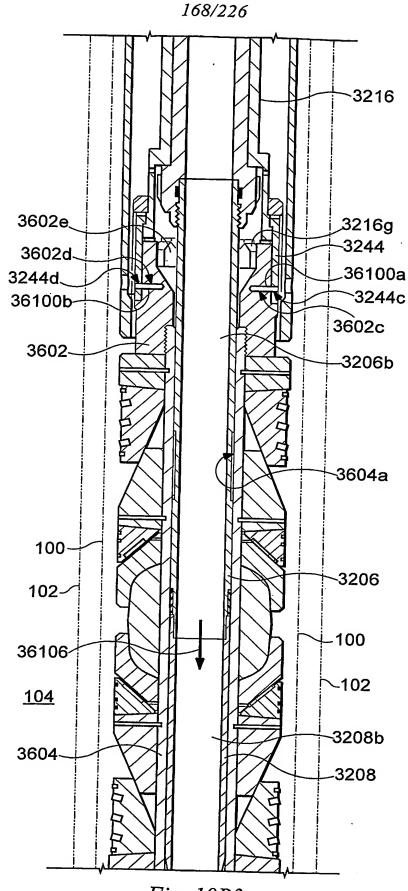


Fig. 19B3

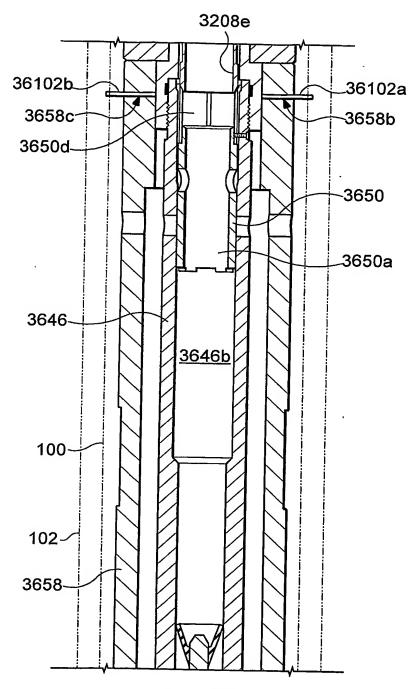
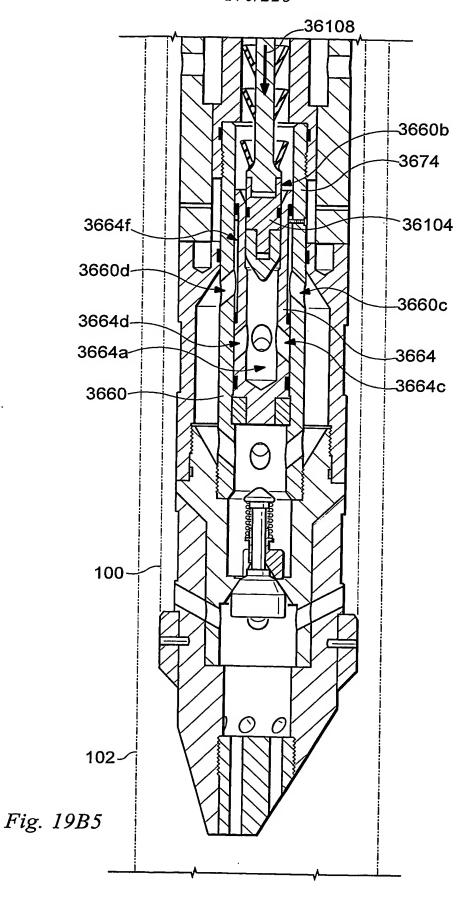


Fig. 19B4



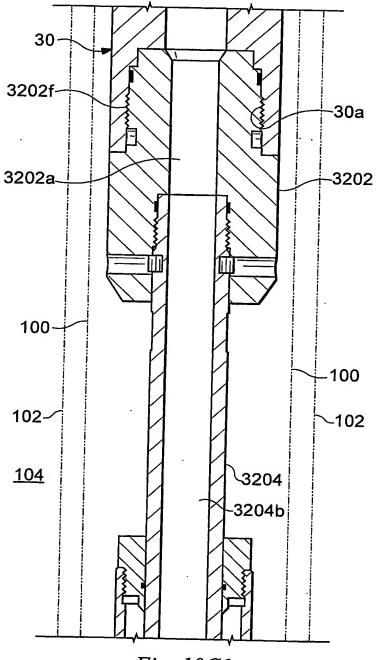
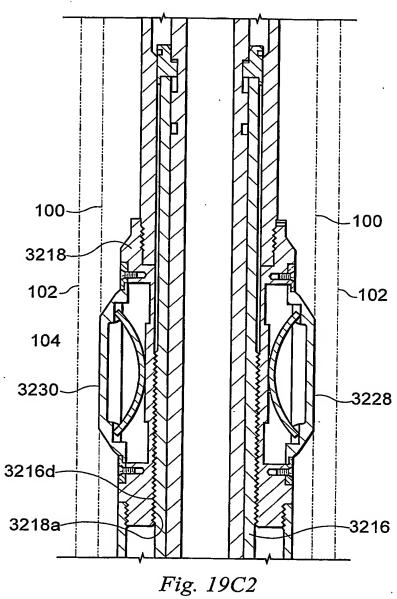


Fig. 19C1



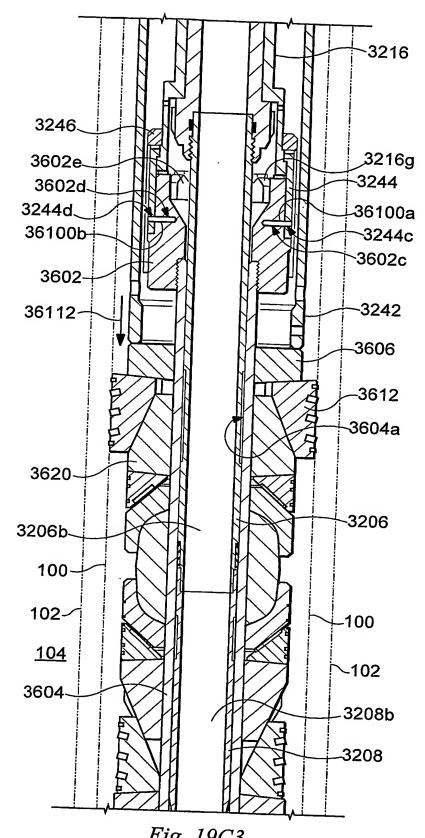


Fig. 19C3

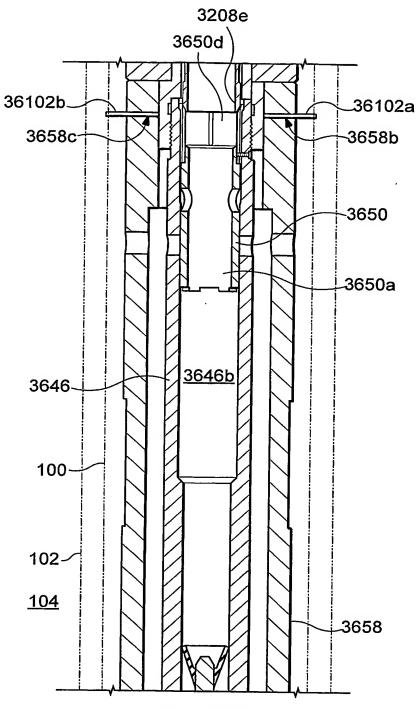
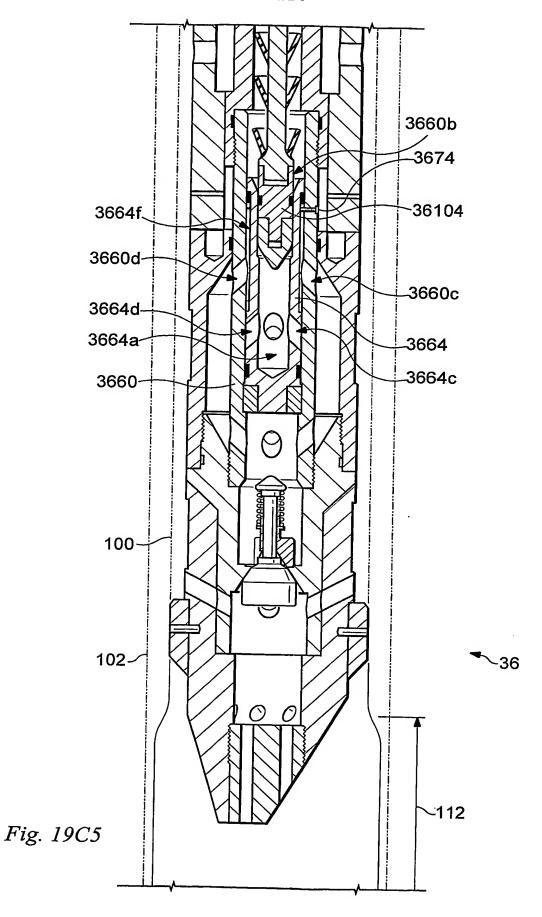
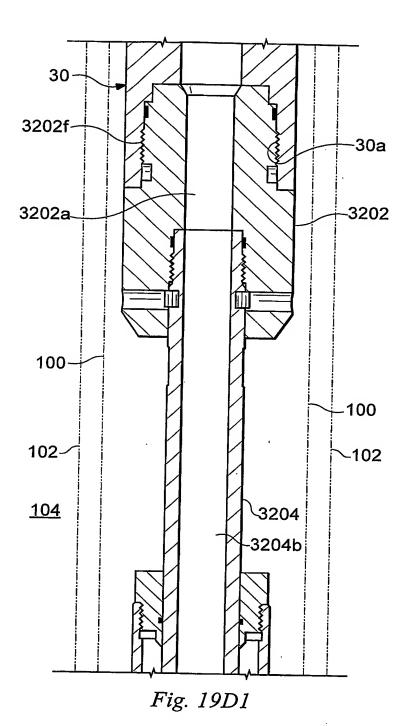
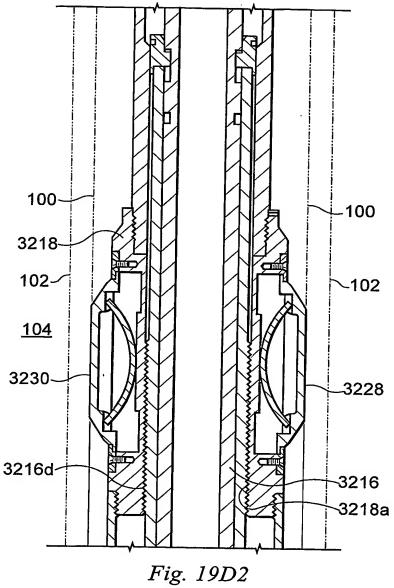


Fig. 19C4







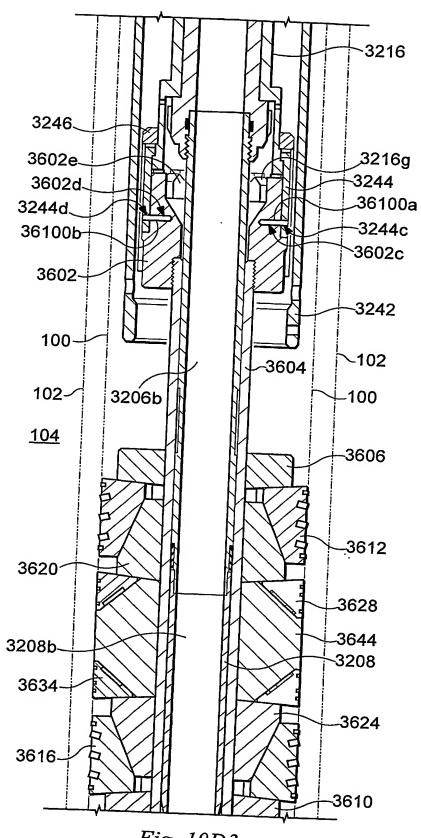


Fig. 19D3

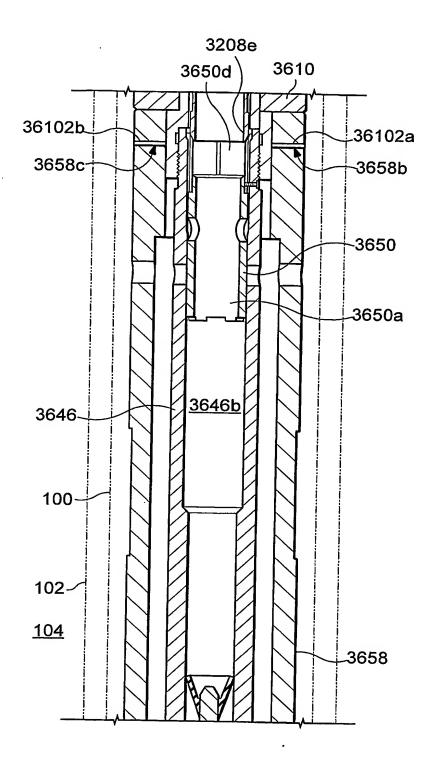
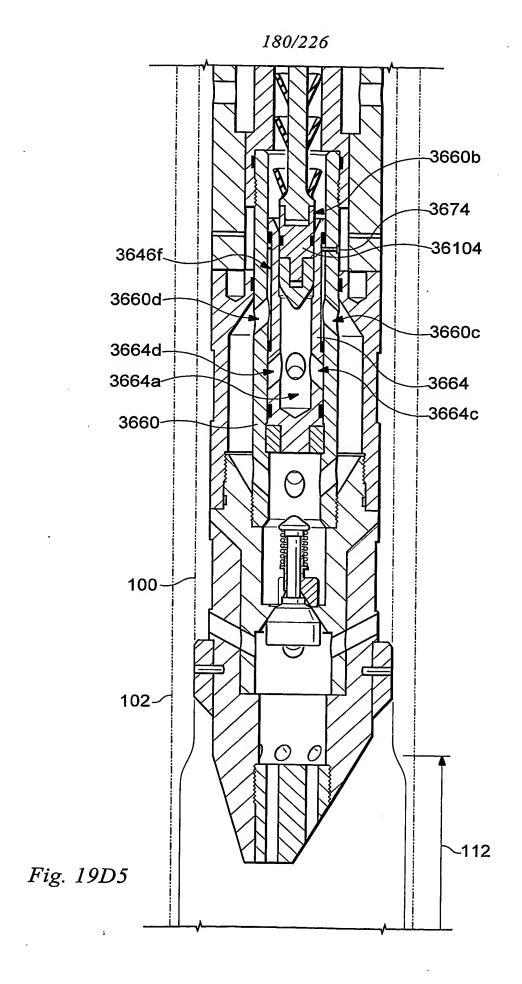


Fig. 19D4



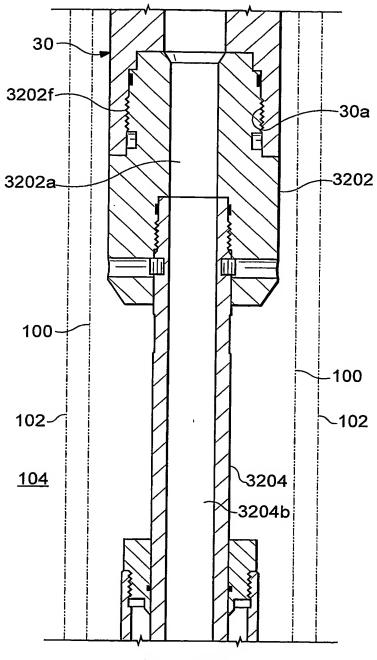
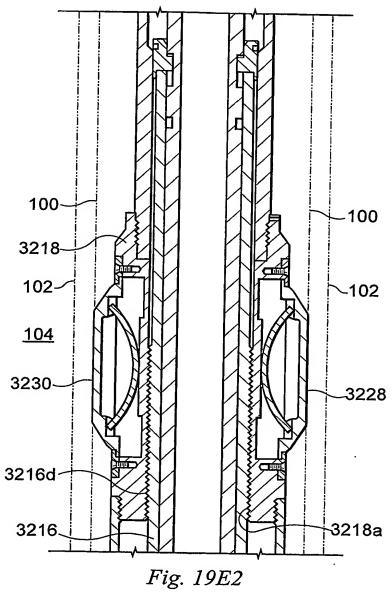


Fig. 19E1



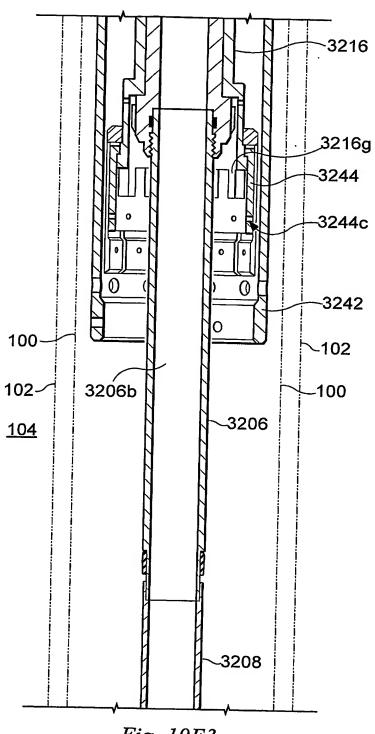


Fig. 19E3

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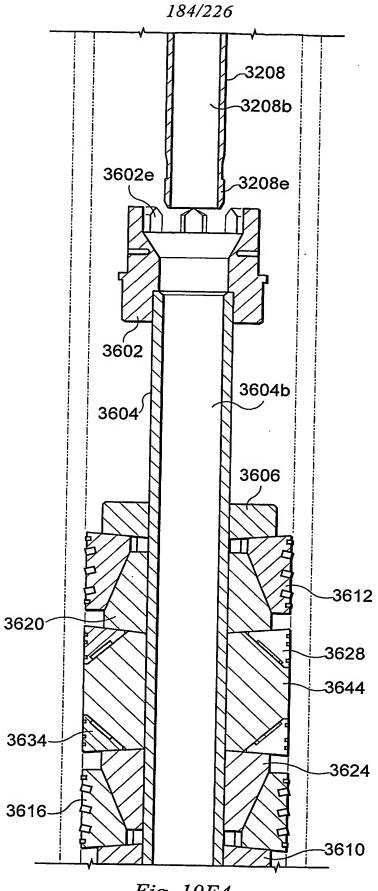


Fig. 19E4

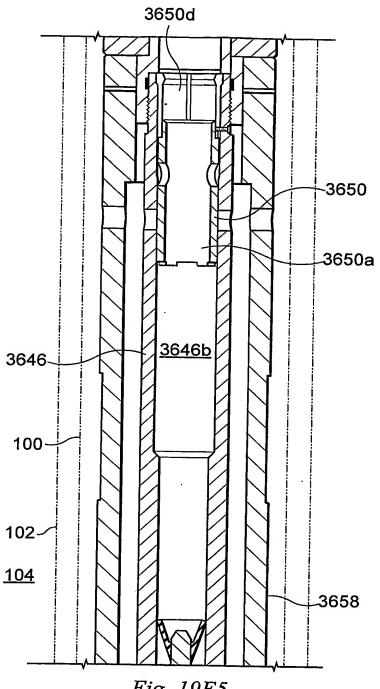
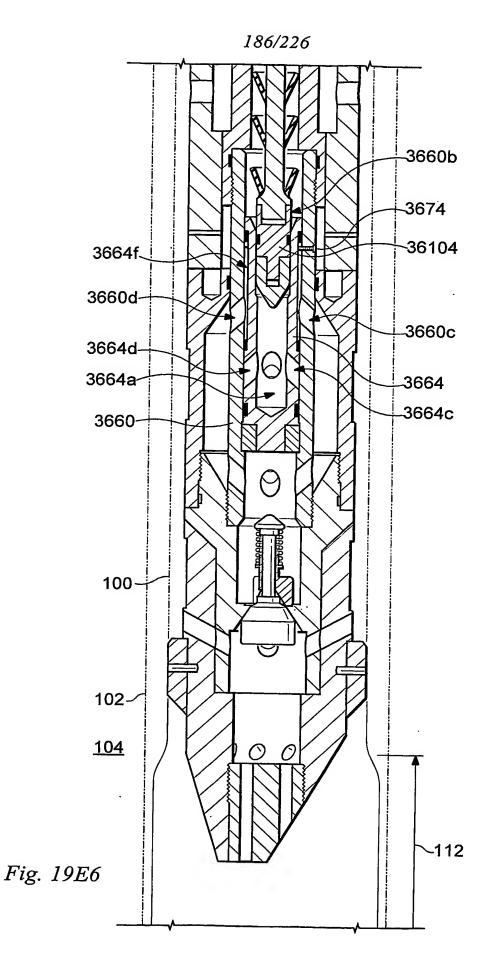


Fig. 19E5

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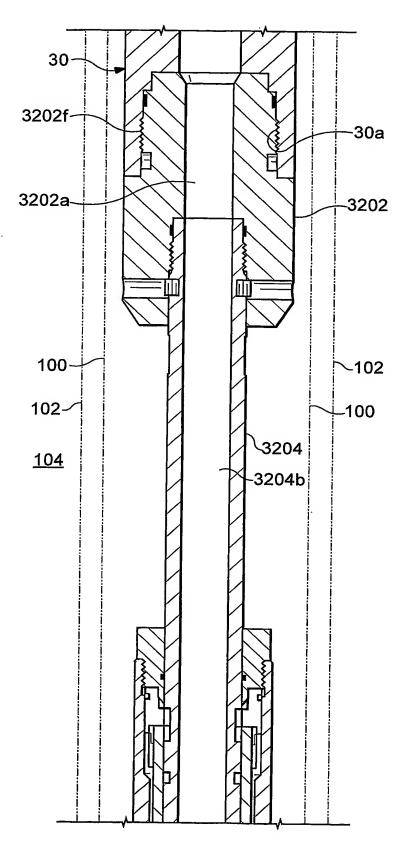


Fig. 19F1

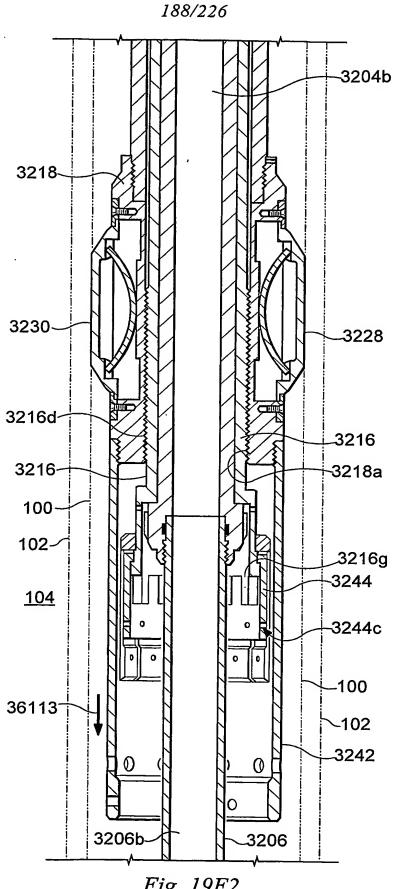
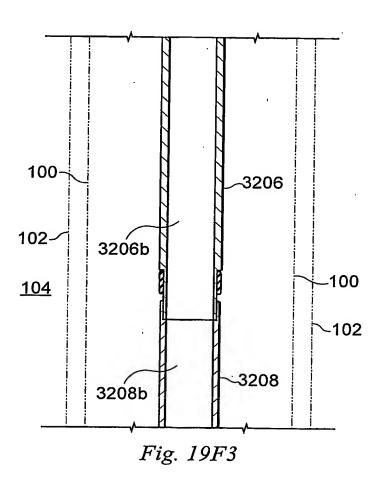


Fig. 19F2



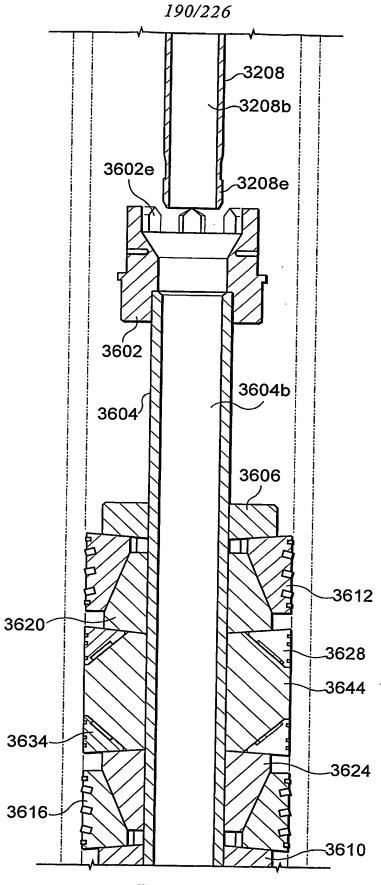


Fig. 19F4

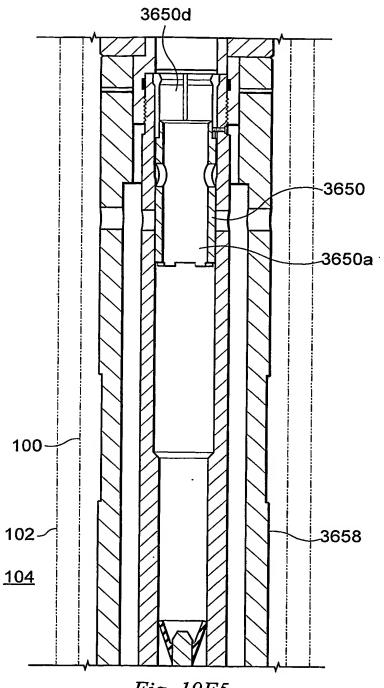
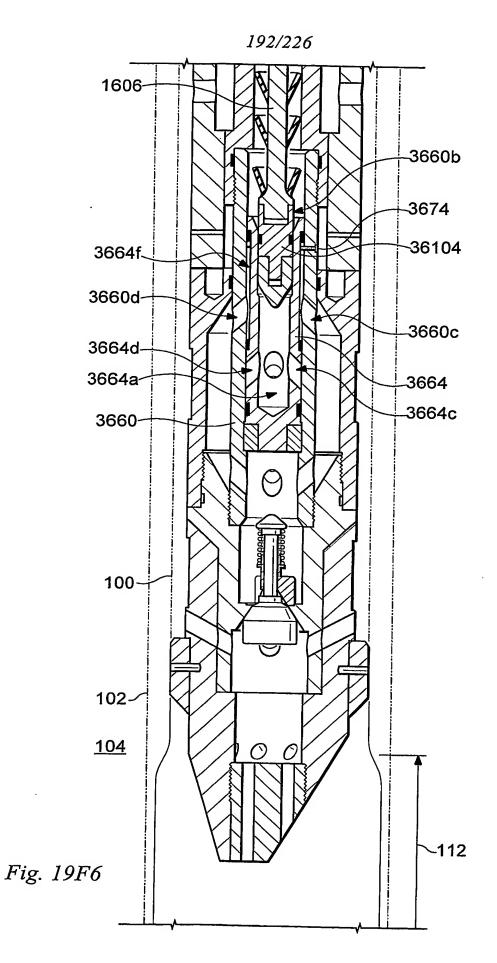


Fig. 19F5

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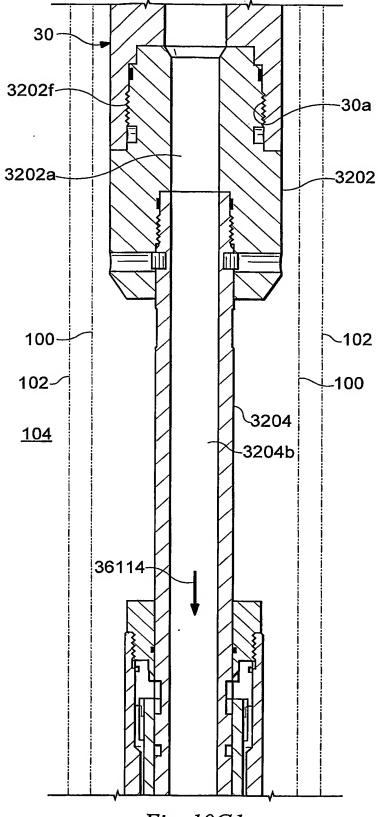


Fig. 19G1

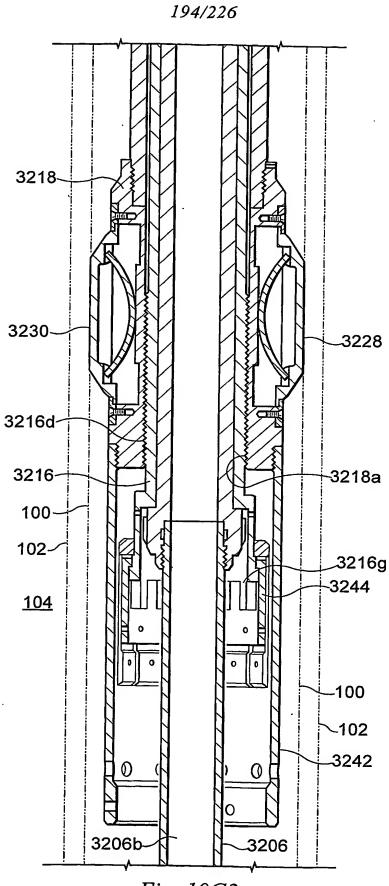
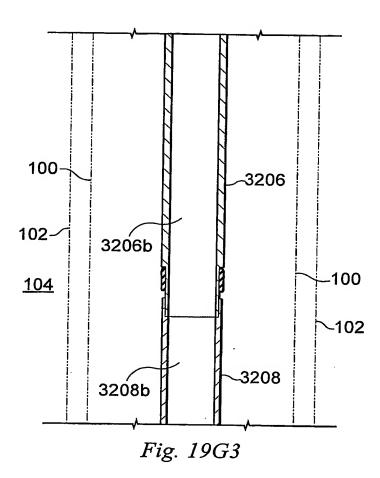
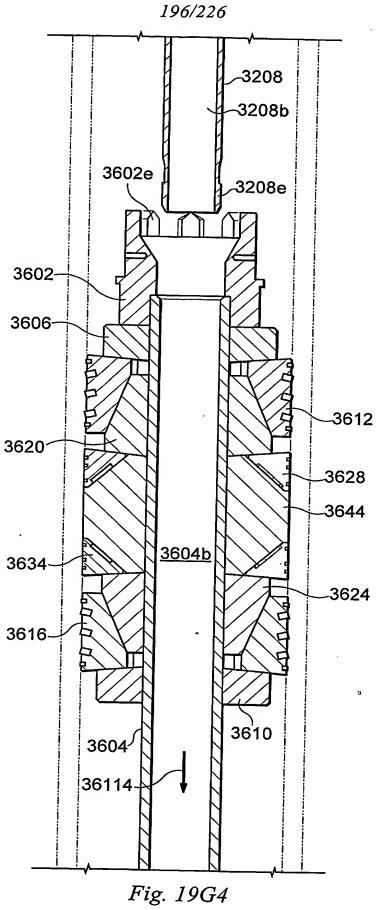


Fig. 19G2





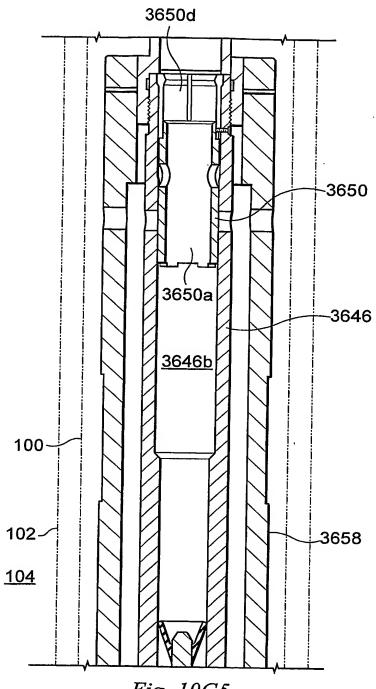
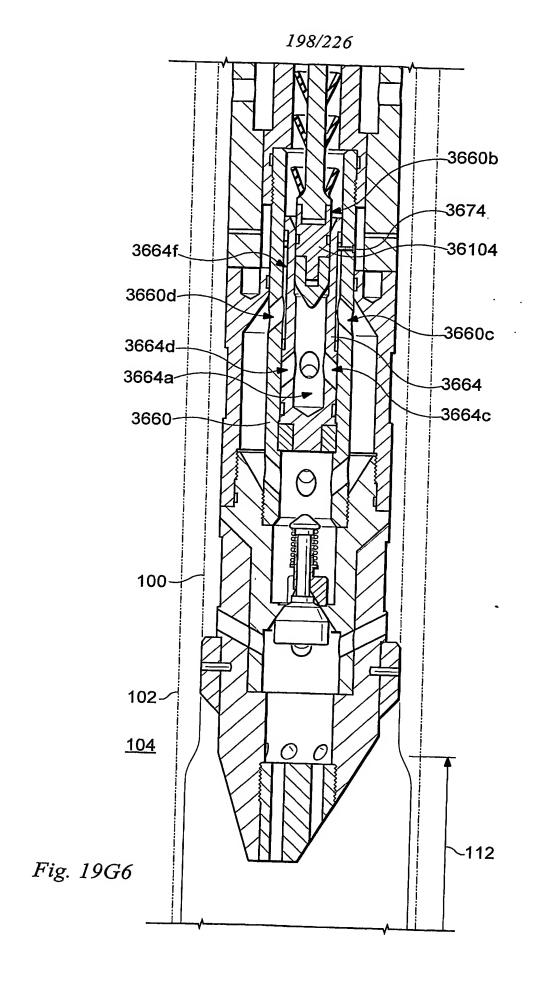


Fig. 19G5

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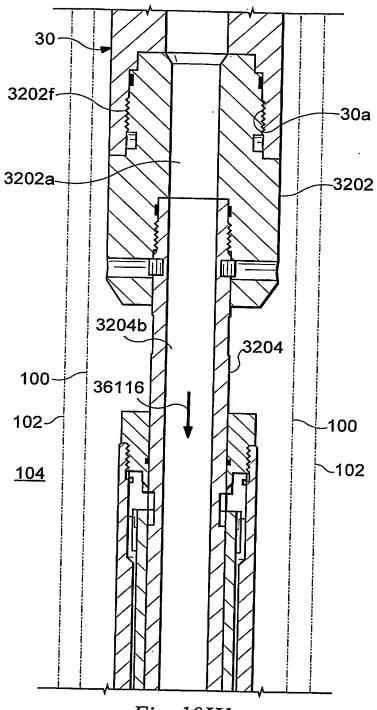
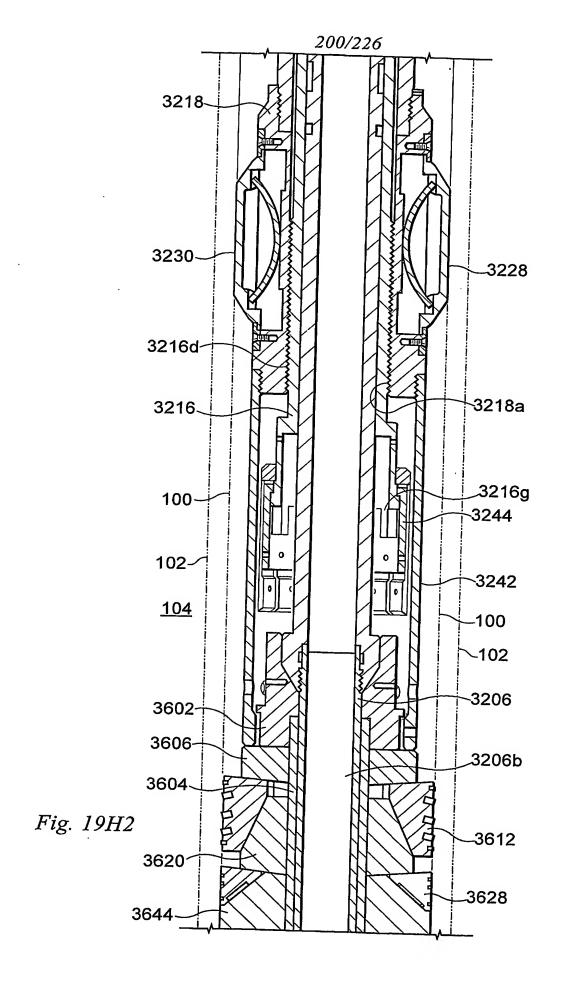
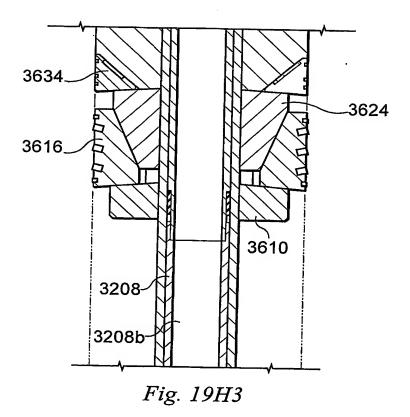


Fig. 19H1

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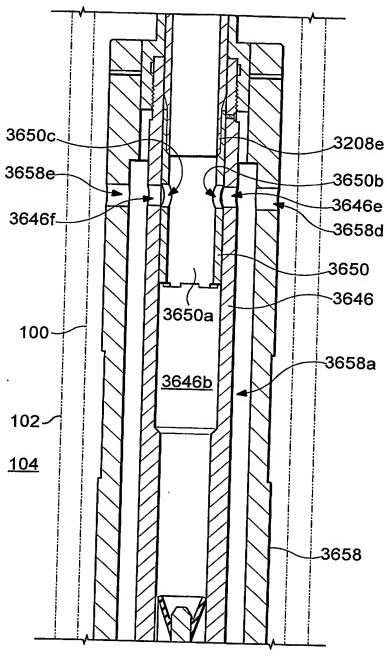
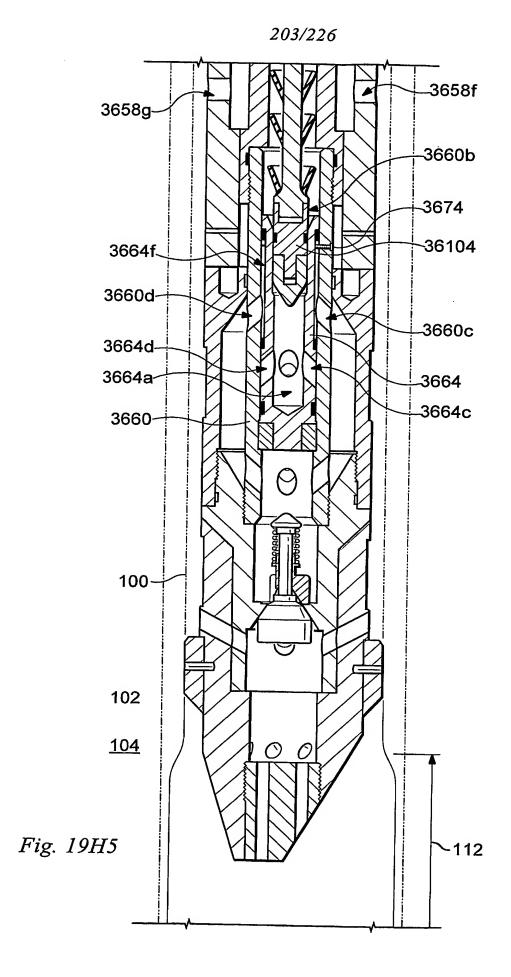
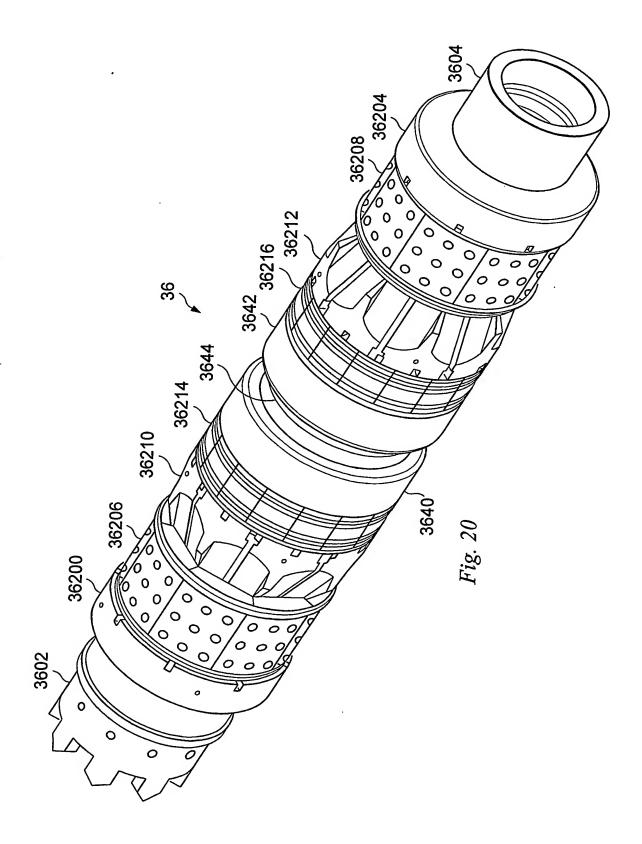


Fig. 19H4





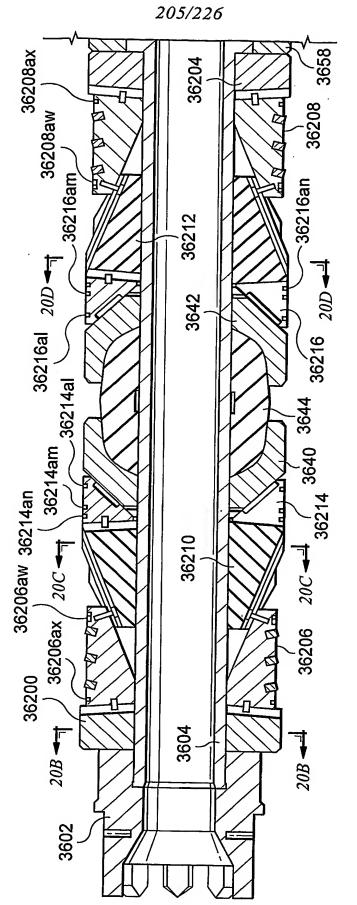
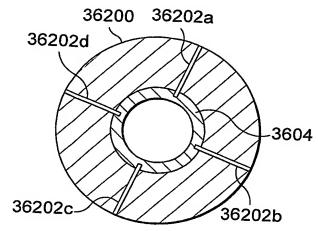


Fig. 204





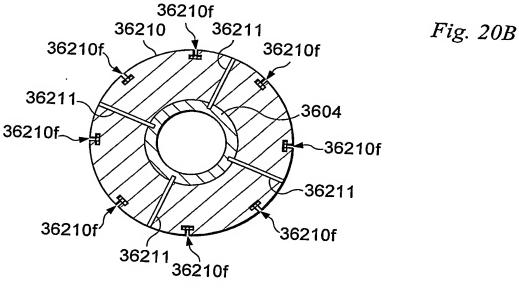
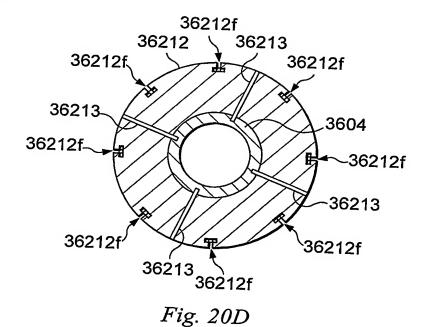
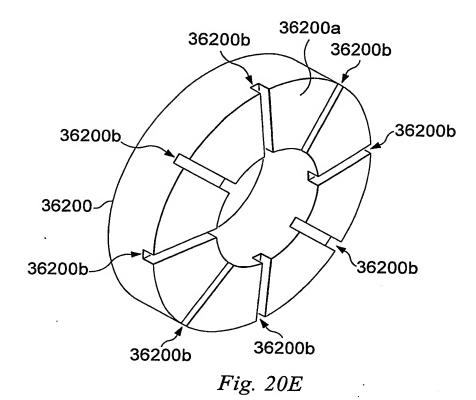


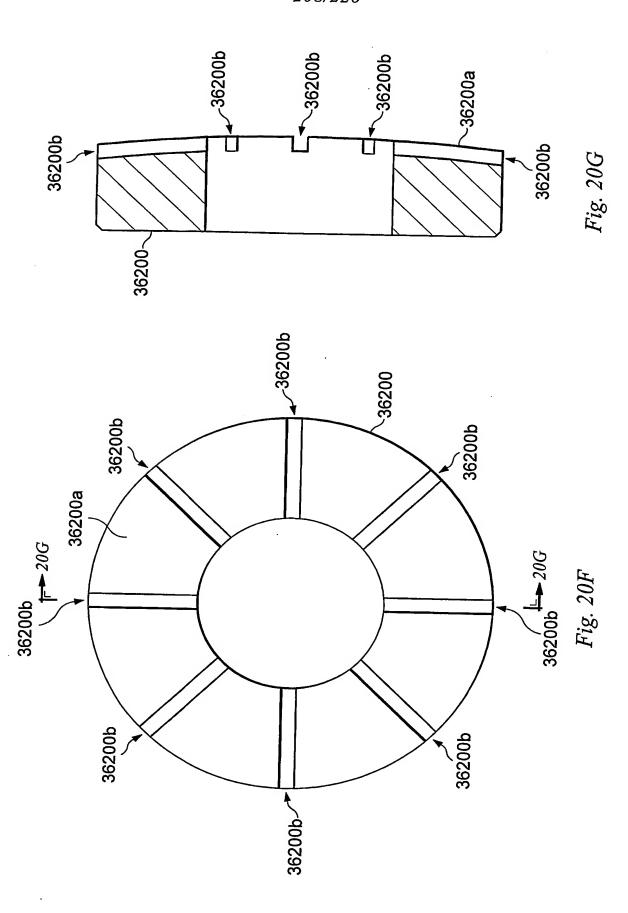
Fig. 20C

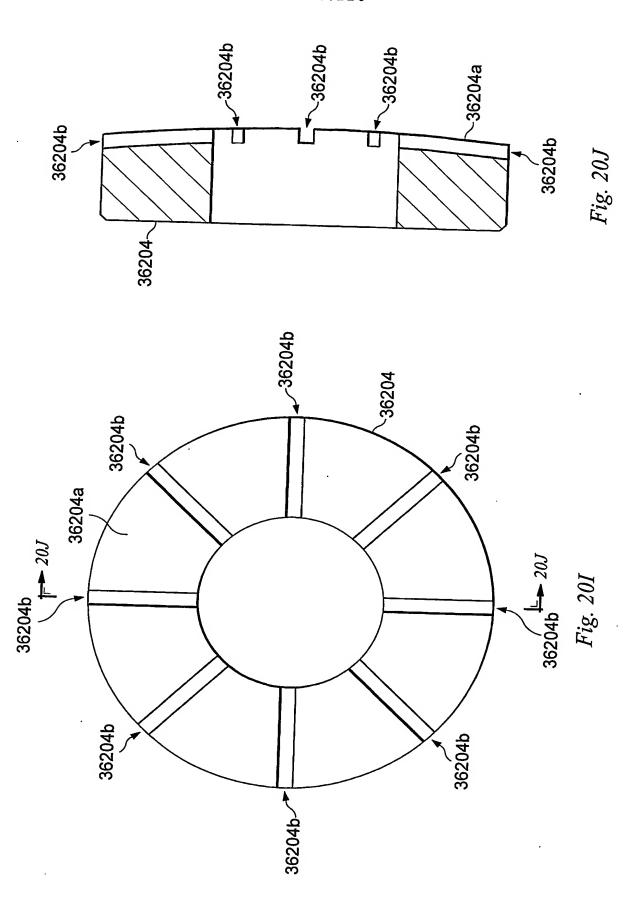




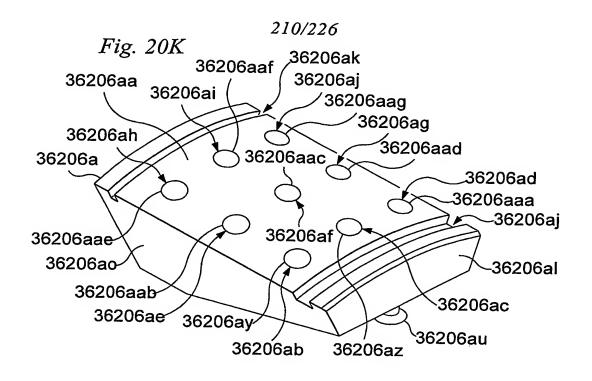
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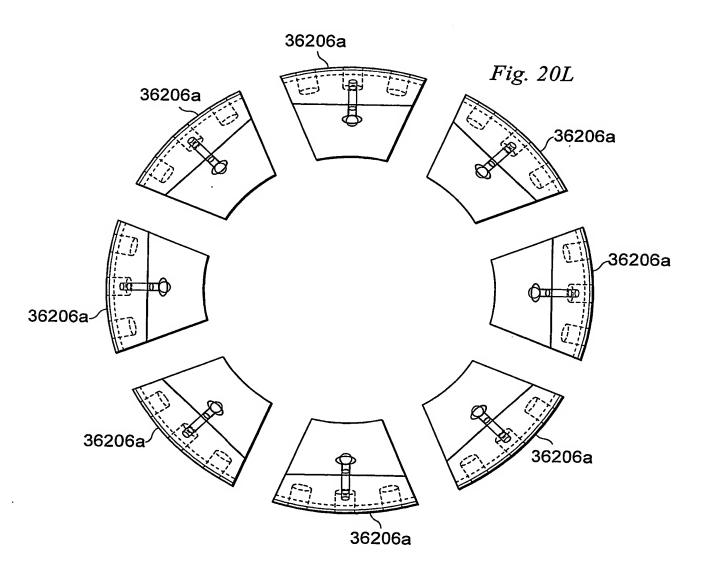
Fig. 20H



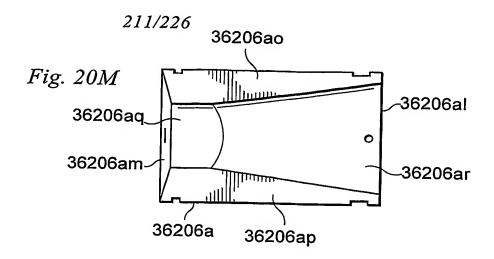


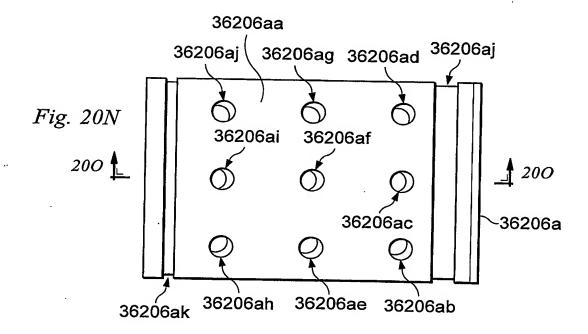
WO 2004/092528 PCT/US2004/010762

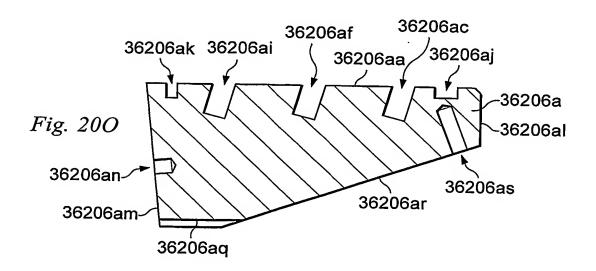




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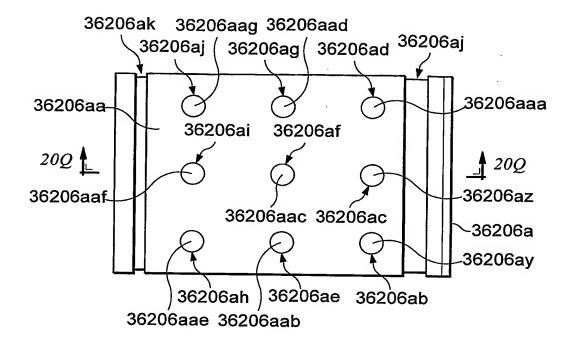
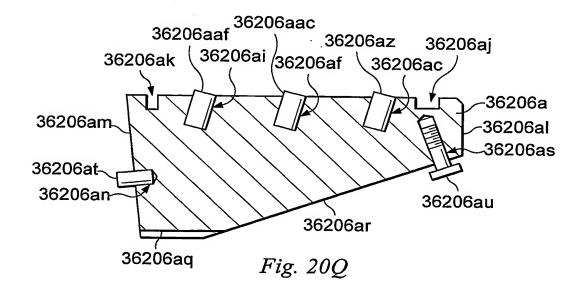
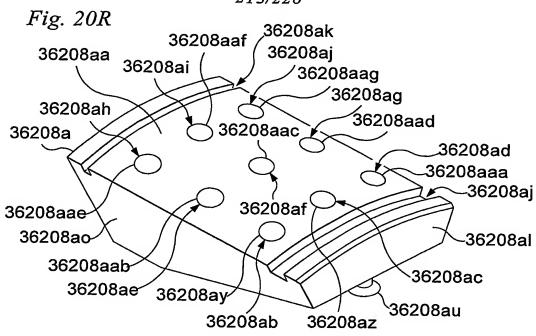
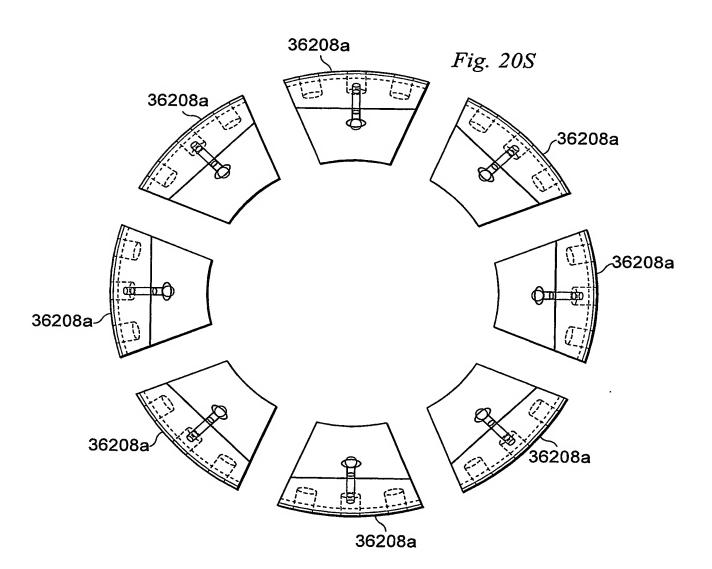


Fig. 20P

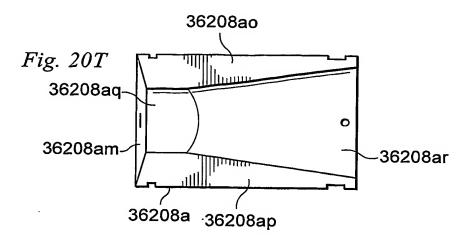


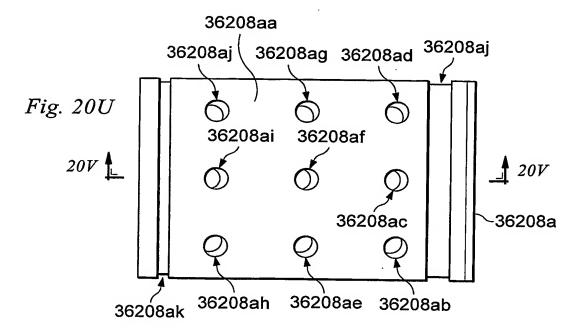


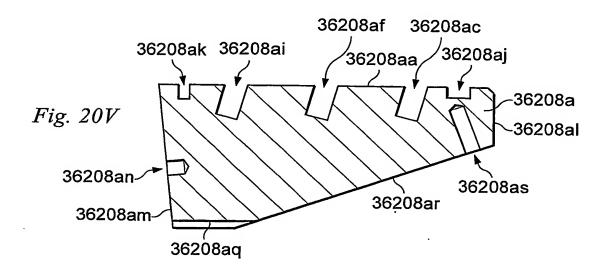




WO 2004/092528 PCT/US2004/010762







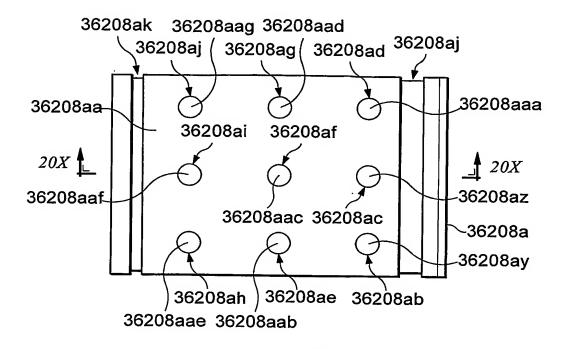
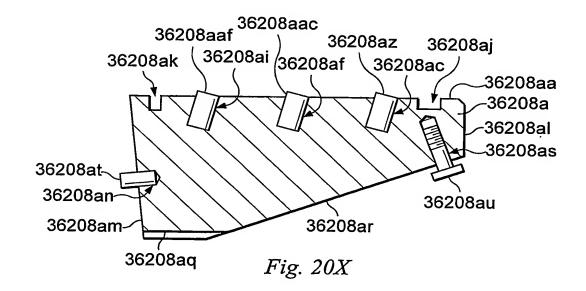


Fig. 20W



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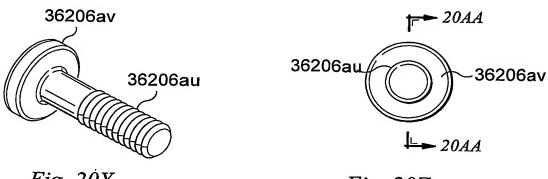
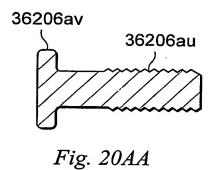


Fig. 20Y

Fig. 20Z



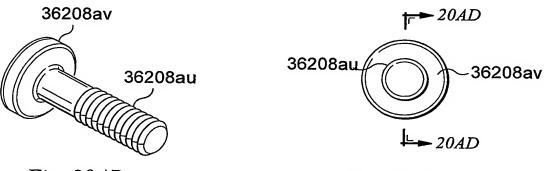


Fig. 20AB

Fig. 20AC

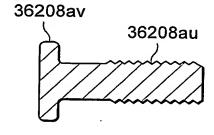


Fig. 20AD

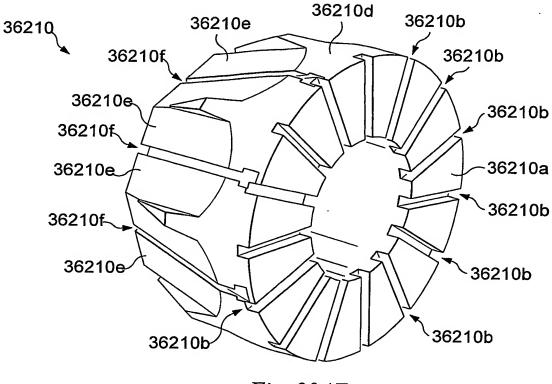
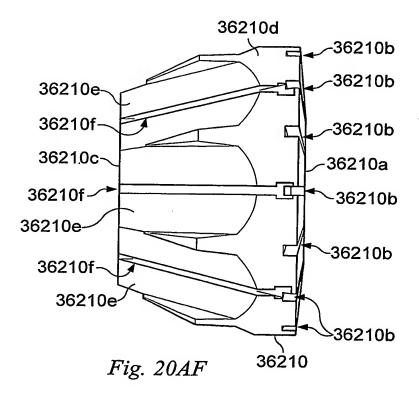
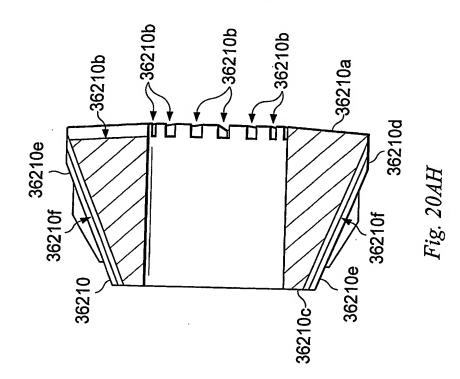
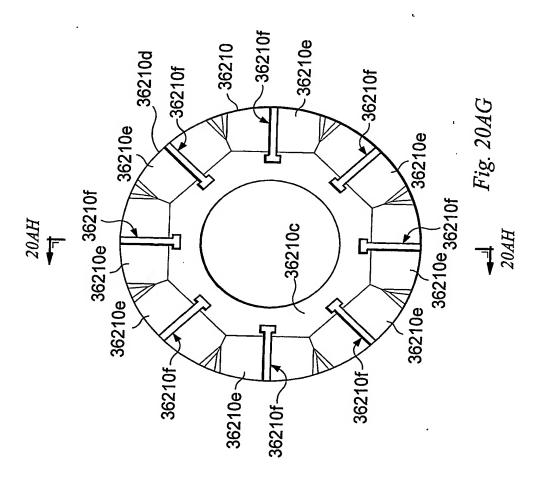
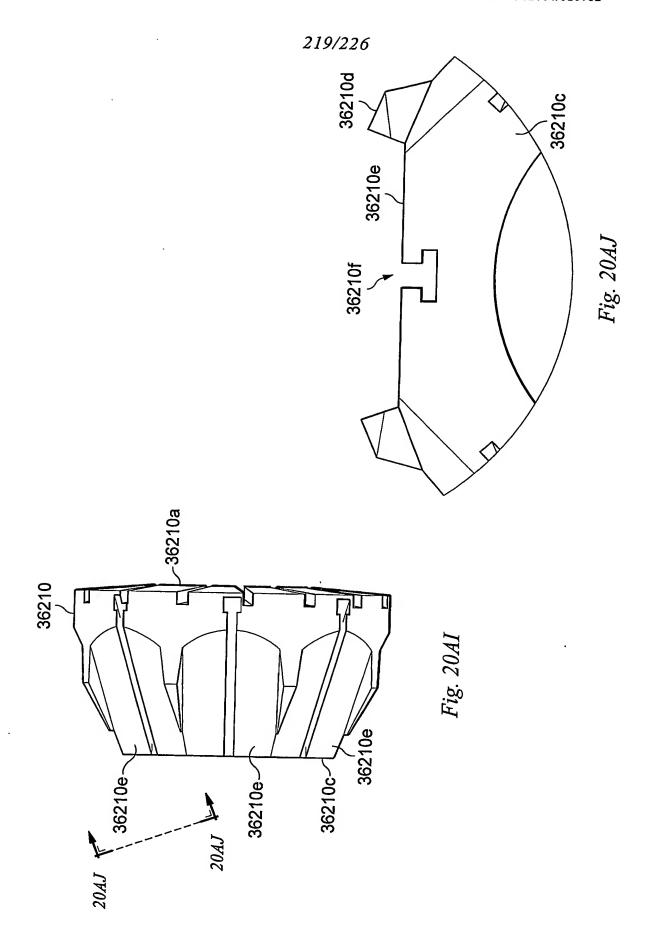


Fig. 20AE

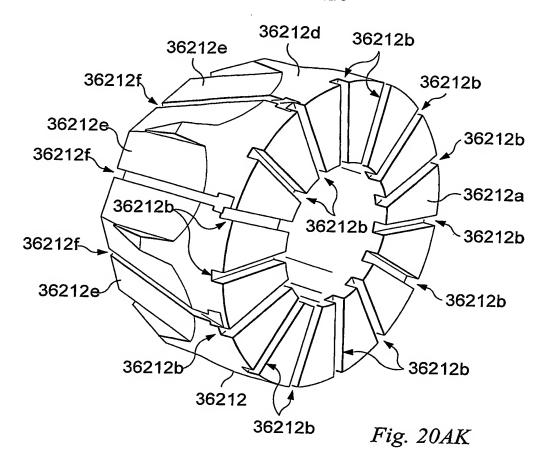


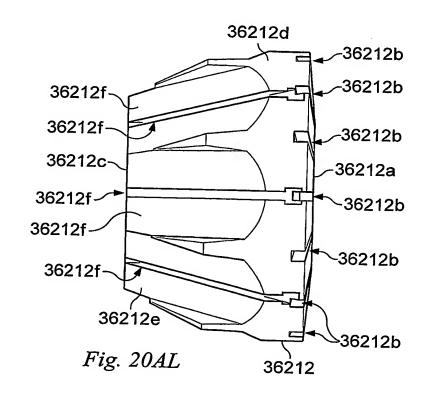




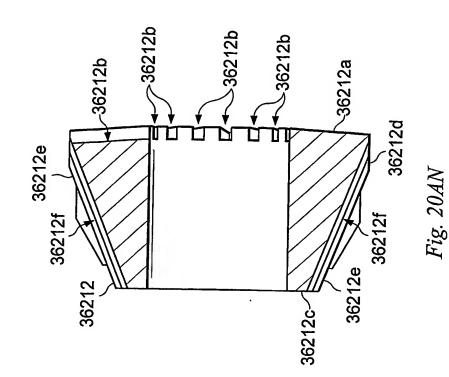


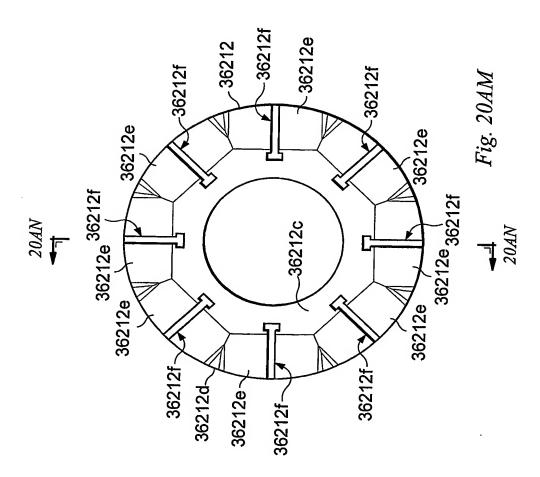
220/226

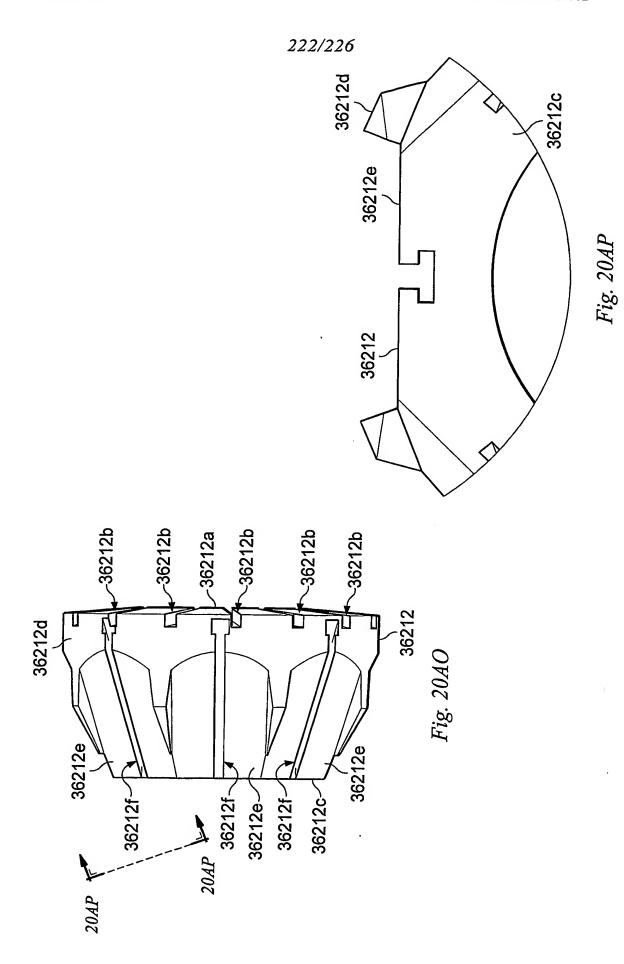




221/226







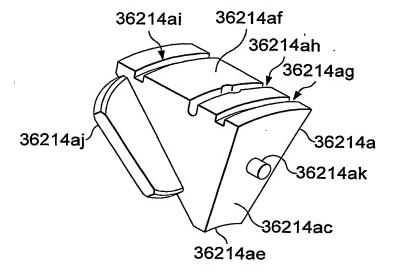


Fig. 20AQ

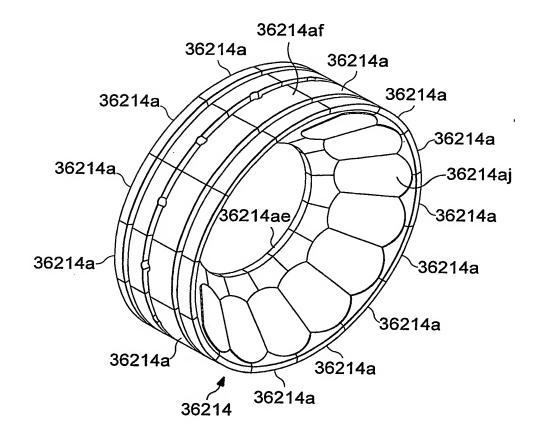
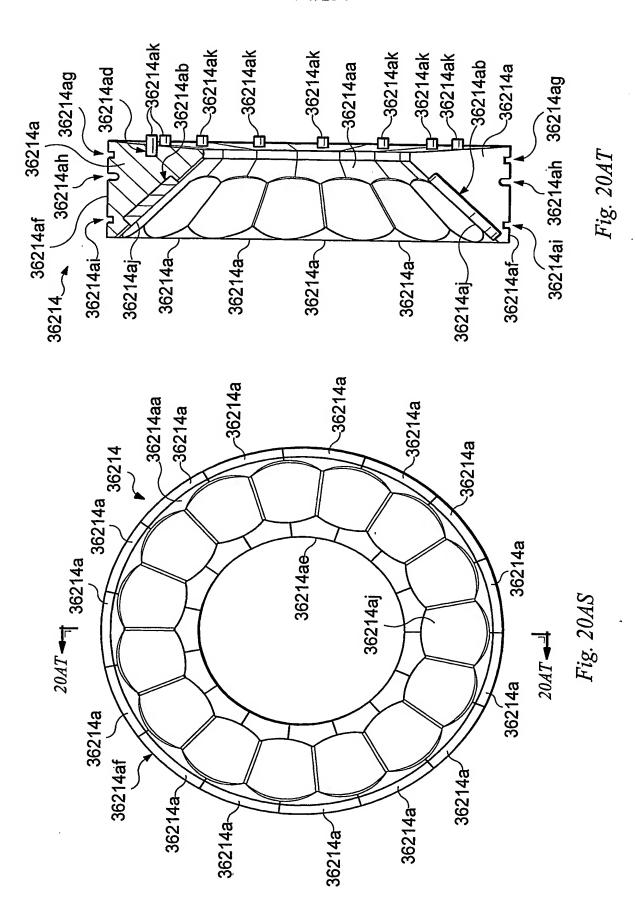
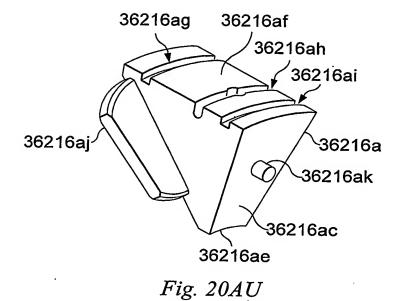


FIG. 20AR





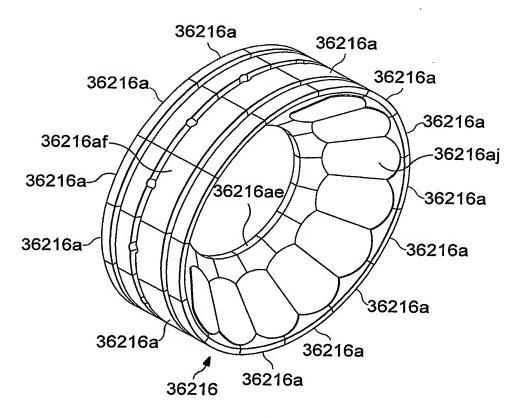


FIG. 20AV

